

- Low Supply-Voltage Range, 1.8 V to 3.6 V
- Ultra-Low Power Consumption:
  - Active Mode: 200  $\mu$ A at 1 MHz, 2.2 V
  - Standby Mode: 0.7  $\mu$ A
  - Off Mode (RAM Retention): 0.1  $\mu$ A
- Ultra-Fast Wake-Up From Standby Mode in Less Than 1  $\mu$ s
- 16-Bit RISC Architecture, 62.5-ns Instruction Cycle Time
- Basic Clock Module Configurations:
  - Internal Frequencies up to 16 MHz With Four Calibrated Frequencies to  $\pm$ 1%
  - Internal Very Low-Power Low-Frequency Oscillator
  - 32-kHz Crystal
  - High-Frequency Crystal up to 16 MHz
  - Resonator
  - External Digital Clock Source
  - External Resistor
- 16-Bit Timer0\_A3 With Three Capture/Compare Registers
- 16-Bit Timer1\_A2 With Two Capture/Compare Registers
- On-Chip Comparator for Analog Signal Compare Function or Slope Analog-to-Digital (A/D) Conversion
- 10-Bit, 200-kps A/D Converter With Internal Reference, Sample-and-Hold, Autoscan, and Data Transfer Controller
- Universal Serial Communication Interface
  - Enhanced UART Supporting Auto Baudrate Detection (LIN)
  - IrDA Encoder and Decoder
  - Synchronous SPI
  - I<sup>2</sup>C™
- Brownout Detector
- Serial Onboard Programming, No External Programming Voltage Needed, Programmable Code Protection by Security Fuse
- Bootstrap Loader in Flash Devices
- On-Chip Emulation Module
- Family Members Include:
  - MSP430F2132
    - 8KB + 256B Flash Memory
    - 512B RAM
  - MSP430F2122
    - 4KB + 256B Flash Memory
    - 512B RAM
  - MSP430F2112
    - 2kB + 256B Flash Memory
    - 256B RAM
- Available in 28-Pin TSSOP and 32-Pin QFN (See Available Options)
- For Complete Module Descriptions, See the *MSP430x2xx Family User's Guide*, Literature Number SLAU144

## description

The Texas Instruments MSP430 family of ultra-low-power microcontrollers consists of several devices featuring different sets of peripherals targeted for various applications. The architecture, combined with five low-power modes, is optimized to achieve extended battery life in portable measurement applications. The device features a powerful 16-bit RISC CPU, 16-bit registers, and constant generators that contribute to maximum code efficiency. The digitally controlled oscillator (DCO) allows wake-up from low-power modes to active mode in less than 1  $\mu$ s.

The MSP430F21x2 series is an ultra-low-power microcontroller with two built-in 16-bit timers, a fast 10-bit A/D converter with integrated reference and a data transfer controller (DTC), a comparator, built-in communication capability using the universal serial communication interface, and up to 24 I/O pins.



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# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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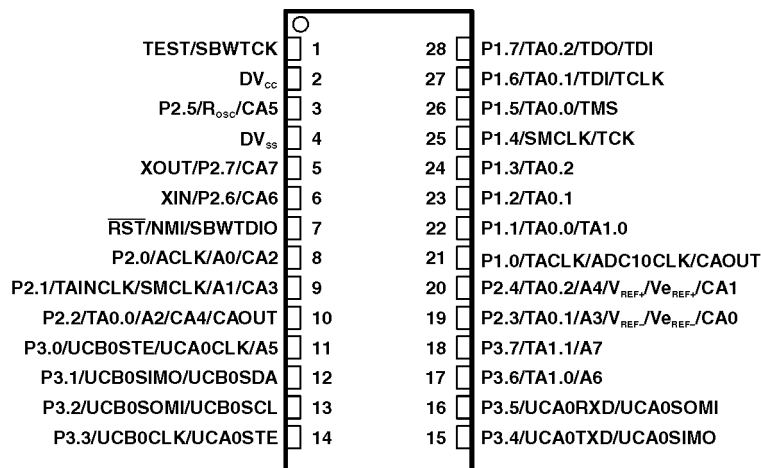
## AVAILABLE OPTIONS

| T <sub>A</sub> | PACKAGED DEVICES          |                          |
|----------------|---------------------------|--------------------------|
|                | PLASTIC 28-PIN TSSOP (PW) | PLASTIC 32-PIN QFN (RHB) |
| -40°C to 85°C  | MSP430F2112IPW            | MSP430F2112IRHB          |
|                | MSP430F2122IPW            | MSP430F2122IRHB          |
|                | MSP430F2132IPW            | MSP430F2132IRHB          |
| -40°C to 105°C | MSP430F2112TPW            | MSP430F2112TRHB          |
|                | MSP430F2122TPW            | MSP430F2122TRHB          |
|                | MSP430F2132TPW            | MSP430F2132TRHB          |

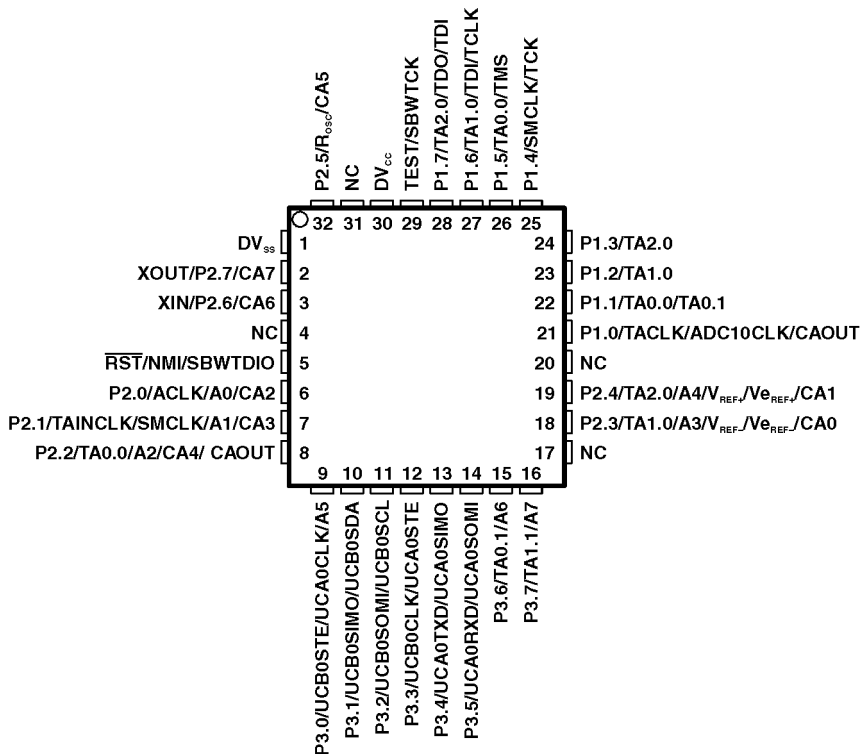


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## pin designation, PW package



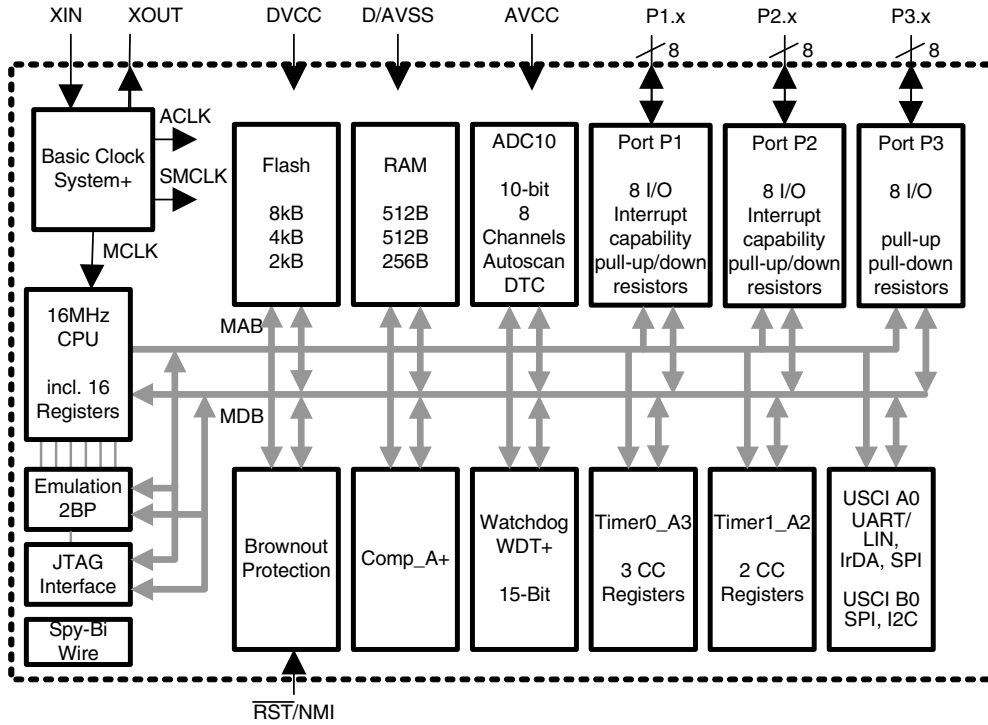
## pin designation, RHB package



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## functional block diagram



### Terminal Functions

| TERMINAL                                                    |              |               | I/O | DESCRIPTION                                                                                                                                                                          |
|-------------------------------------------------------------|--------------|---------------|-----|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                                        | 28-Pin<br>PW | 32-Pin<br>RHB |     |                                                                                                                                                                                      |
| P1.0/TACLK/<br>ADC10CLK/CAOUT                               | 21           | 21            | I/O | General-purpose digital I/O pin<br>Timer0_A3, clock signal TACLK input<br>Timer1_A2, clock signal TACLK input<br>ADC10, conversion clock<br>Comparator_A+ output                     |
| P1.1/TA0.0/TA1.0                                            | 22           | 22            | I/O | General-purpose digital I/O pin<br>Timer0_A3, capture: CCI0A input, compare: Out0 Output<br>Timer1_A2, capture: CCI0A input                                                          |
| P1.2/TA0.1                                                  | 23           | 23            | I/O | General-purpose digital I/O pin<br>Timer0_A3, capture: CCI1A input, compare: Out1 Output                                                                                             |
| P1.3/TA0.2                                                  | 24           | 24            | I/O | General-purpose digital I/O pin<br>Timer0_A3, capture: CCI2A input, compare: Out2 Output                                                                                             |
| P1.4/SMCLK/TCK                                              | 25           | 25            | I/O | General-purpose digital I/O pin<br>SMCLK signal output<br>Test Clock input for device programming and test                                                                           |
| P1.5/TA0.0/TMS                                              | 26           | 26            | I/O | General-purpose digital I/O pin<br>Timer0_A3, compare: Out0 Output<br>JTAG test mode select, input terminal for device programming and test                                          |
| P1.6/TA0.1/TDI/TCLK                                         | 27           | 27            | I/O | General-purpose digital I/O pin<br>Timer0_A3, compare: Out1 Output<br>JTAG test data input or test clock input in programming an test                                                |
| P1.7/TA0.2/TDO/TDI                                          | 28           | 28            | I/O | General-purpose digital I/O pin<br>Timer0_A3, compare: Out2 Output<br>JTAG test data output terminal or test data input in programming an test                                       |
| P2.0/ACLK/A0/CA2                                            | 8            | 6             | I/O | General-purpose digital I/O pin<br>ACLK signal output<br>ADC10 analog input A0<br>Comparator_A+ input                                                                                |
| P2.1/TAINCLK/<br>SMCLK/A1/CA3                               | 9            | 7             | I/O | General-purpose digital I/O pin<br>SMCLK signal output<br>Timer0_A3, clock signal TACLK input<br>Timer1_A2, clock signal TACLK input<br>ADC10 analog input A1<br>Comparator_A+ input |
| P2.2/TA0.0/A2/CA4/<br>CAOUT                                 | 10           | 8             | I/O | General-purpose digital I/O pin<br>Timer0_A3, capture: CCI0B input, compare: Out0 Output<br>ADC10 analog input A2<br>Comparator_A+ input<br>Comparator_A+ output                     |
| P2.3/TA0.1/A3/<br>V <sub>REF-</sub> /V <sub>REF-</sub> /CA0 | 19           | 18            | I/O | General-purpose digital I/O pin<br>Timer0_A3, compare: Out1 Output<br>ADC10 analog input A3 / negative reference<br>Comparator_A+ input                                              |
| P2.4/TA0.2/A4/<br>V <sub>REF+</sub> /V <sub>REF+</sub> /CA1 | 20           | 19            | I/O | General-purpose digital I/O pin<br>Timer0_A3, compare: Out2 Output<br>ADC10 analog input A4 / positive reference<br>Comparator_A+ input                                              |

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## Terminal Functions (continued)

| TERMINAL                    |              |                  | I/O | DESCRIPTION                                                                                                                     |
|-----------------------------|--------------|------------------|-----|---------------------------------------------------------------------------------------------------------------------------------|
| NAME                        | 28-Pin<br>PW | 32-Pin<br>RHB    |     |                                                                                                                                 |
| XIN/P2.6/CA6                | 6            | 3                | I/O | Input terminal of crystal oscillator<br>General-purpose digital I/O pin<br>Comparator_A+ input                                  |
| XOUT/P2.7/CA7               | 5            | 2                | I/O | Output terminal of crystal oscillator<br>General-purpose digital I/O pin<br>Comparator_A+ input                                 |
| P3.0/UCB0STE/<br>UCA0CLK/A5 | 11           | 9                | I/O | General-purpose digital I/O pin<br>USCI_B0 slave transmit enable/USCI_A0 clock input/output<br>ADC10 analog input A5            |
| P3.1/UCB0SIMO/<br>UCB0SDA   | 12           | 10               | I/O | General-purpose digital I/O pin<br>USCI_B0 slave in/master out in SPI mode, SDA I <sup>2</sup> C data in I <sup>2</sup> C mode  |
| P3.2/UCB0SOMI/<br>UCB0SCL   | 13           | 11               | I/O | General-purpose digital I/O pin<br>USCI_B0 slave out/master in in SPI mode, SCL I <sup>2</sup> C clock in I <sup>2</sup> C mode |
| P3.3/UCB0CLK/<br>UCA0STE    | 14           | 12               | I/O | General-purpose digital I/O<br>USCI_B0 clock input/output, USCI_A0 slave transmit enable                                        |
| P3.4/UCA0TXD/<br>UCA0SIMO   | 15           | 13               | I/O | General-purpose digital I/O pin<br>USCI_A0 transmit data output in UART mode, slave data in/master out in SPI mode              |
| P3.5/UCA0RXD/<br>UCA0SOMI   | 16           | 14               | I/O | General-purpose digital I/O pin<br>USCI_A0 receive data input in UART mode, slave data out/master in in SPI mode                |
| P3.6/TA1.0/A6               | 17           | 15               | I/O | General-purpose digital I/O pin<br>Timer1_A2, capture: CCI0B input, compare: Out0 Output<br>ADC10 analog input A6               |
| P3.7/TA1.1/A7               | 18           | 16               | I/O | General-purpose digital I/O pin<br>Timer1_A2, capture: CCI1A input, compare: Out1 Output<br>ADC10 analog input A7               |
| RST/NMI/SBWDIO              | 7            | 5                | I   | Reset or nonmaskable interrupt input<br>Spy-Bi-Wire test data input/output during programming and test                          |
| TEST/SBWTCK                 | 1            | 29               | I   | Selects test mode for JTAG pins on Port1. The device protection fuse is connected to TEST.                                      |
| P2.5/R <sub>OSC</sub> /CA5  | 3            | 32               | I/O | General-purpose digital I/O pin<br>Input for external resistor defining the DCO nominal frequency<br>Comparator_A+ input        |
| DV <sub>CC</sub>            | 2            | 30               |     | Digital supply voltage                                                                                                          |
| DV <sub>SS</sub>            | 4            | 1                |     | Digital supply voltage                                                                                                          |
| NC                          | NA           | 4, 17,<br>20, 31 |     | Not connected internally. Connection to V <sub>SS</sub> is recommended.                                                         |
| QFN Pad                     | NA           | NA               | NA  | QFN package pad (RHB package only). Connection to DV <sub>SS</sub> is recommended.                                              |



## short-form description

### CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time. The register-to-register operation execution time is one cycle of the CPU clock.

Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers.

Peripherals are connected to the CPU using data, address, and control buses, and can be handled with all instructions.

|                          |           |
|--------------------------|-----------|
| Program Counter          | PC/R0     |
| Stack Pointer            | SP/R1     |
| Status Register          | SR/CG1/R2 |
| Constant Generator       | CG2/R3    |
| General-Purpose Register | R4        |
| General-Purpose Register | R5        |
| General-Purpose Register | R6        |
| General-Purpose Register | R7        |
| General-Purpose Register | R8        |
| General-Purpose Register | R9        |
| General-Purpose Register | R10       |
| General-Purpose Register | R11       |
| General-Purpose Register | R12       |
| General-Purpose Register | R13       |
| General-Purpose Register | R14       |
| General-Purpose Register | R15       |

### instruction set

The instruction set consists of 51 instructions with three formats and seven address modes. Each instruction can operate on word and byte data. Table 1 shows examples of the three types of instruction formats; the address modes are listed in Table 2.

**Table 1. Instruction Word Formats**

|                                   |                 |                       |
|-----------------------------------|-----------------|-----------------------|
| Dual operands, source-destination | e.g., ADD R4,R5 | R4 + R5 ---> R5       |
| Single operands, destination only | e.g., CALL R8   | PC -->(TOS), R8--> PC |
| Relative jump, un/conditional     | e.g., JNE       | Jump-on-equal bit = 0 |

**Table 2. Address Mode Descriptions**

| ADDRESS MODE           | S | D | SYNTAX          | EXAMPLE          | OPERATION                        |
|------------------------|---|---|-----------------|------------------|----------------------------------|
| Register               | ● | ● | MOV Rs,Rd       | MOV R10,R11      | R10 --> R11                      |
| Indexed                | ● | ● | MOV X(Rn),Y(Rm) | MOV 2(R5),6(R6)  | M(2+R5)--> M(6+R6)               |
| Symbolic (PC relative) | ● | ● | MOV EDE,TONI    |                  | M(EDE) --> M(TONI)               |
| Absolute               | ● | ● | MOV &MEM,&TCDAT |                  | M(MEM) --> M(TCDAT)              |
| Indirect               | ● |   | MOV @Rn,Y(Rm)   | MOV @R10,Tab(R6) | M(R10) --> M(Tab+R6)             |
| Indirect autoincrement | ● |   | MOV @Rn+,Rm     | MOV @R10+,R11    | M(R10) --> R11<br>R10 + 2--> R10 |
| Immediate              | ● |   | MOV #X,TONI     | MOV #45,TONI     | #45 --> M(TONI)                  |

NOTE: S = source      D = destination

# MSP430F21x2

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### operating modes

The MSP430 has one active mode and five software-selectable low-power modes of operation. An interrupt event can wake up the device from any of the five low-power modes, service the request, and restore back to the low-power mode on return from the interrupt program.

The following six operating modes can be configured by software:

- Active mode (AM)
  - All clocks are active.
- Low-power mode 0 (LPM0)
  - CPU is disabled.
  - ACLK and SMCLK remain active, MCLK is disabled.
- Low-power mode 1 (LPM1)
  - CPU is disabled.
  - ACLK and SMCLK remain active, MCLK is disabled.
  - DCO's dc generator is disabled if DCO not used in active mode.
- Low-power mode 2 (LPM2)
  - CPU is disabled.
  - MCLK and SMCLK are disabled.
  - DCO's dc generator remains enabled.
  - ACLK remains active.
- Low-power mode 3 (LPM3)
  - CPU is disabled.
  - MCLK and SMCLK are disabled.
  - DCO's dc-generator is disabled.
  - ACLK remains active.
- Low-power mode 4 (LPM4)
  - CPU is disabled.
  - ACLK is disabled.
  - MCLK and SMCLK are disabled.
  - DCO's dc generator is disabled.
  - Crystal oscillator is stopped.





**interrupt vector addresses**

The interrupt vectors and the power-up starting address are located in the address range 0xFFFF to 0xFFC0. The vector contains the 16-bit address of the appropriate interrupt-handler instruction sequence. If the reset vector (0xFFFFE) contains 0xFFFF (e.g., flash is not programmed) the CPU enters LPM4 after power-up.

| INTERRUPT SOURCE                                                                              | INTERRUPT FLAG                                                          | SYSTEM INTERRUPT                                | WORD ADDRESS     | PRIORITY        |
|-----------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|-------------------------------------------------|------------------|-----------------|
| Power-up<br>External reset<br>Watchdog<br>Flash key violation<br>PC out of range (see Note 1) | PORIFG<br>RSTIFG<br>WDTIFG<br>KEYV<br>(see Note 2)                      | Reset                                           | 0xFFFFE          | 31, highest     |
| NMI<br>Oscillator fault<br>Flash memory access violation                                      | NMIIFG<br>OFIFG<br>ACCVIFG<br>(see Notes 2 and 6)                       | (Non)maskable<br>(Non)maskable<br>(Non)maskable | 0xFFFFC          | 30              |
| Timer1_A2                                                                                     | TA1CCR0 CCIFG<br>(see Note 3)                                           | Maskable                                        | 0xFFFFA          | 29              |
| Timer1_A2                                                                                     | TA1CCR1 CCIFG,<br>TA1CTL TAIFG<br>(see Notes 2 and 3)                   | Maskable                                        | 0xFFFF8          | 28              |
| Comparator_A+                                                                                 | CAIFG                                                                   | Maskable                                        | 0xFFFF6          | 27              |
| Watchdog timer                                                                                | WDTIFG                                                                  | Maskable                                        | 0xFFFF4          | 26              |
| Timer0_A3                                                                                     | TA0CCR0 CCIFG<br>(see Note 3)                                           | Maskable                                        | 0xFFFF2          | 25              |
| Timer0_A3                                                                                     | TA0CCR1 CCIFG,<br>TA0CCR2 CCIFG,<br>TA0CTL TAIFG<br>(see Notes 2 and 3) | Maskable                                        | 0xFFFF0          | 24              |
| USCI_A0/USCI_B0 receive<br>USCI_B0 I2C status                                                 | UCA0RXIFG, UCB0RXIFG<br>(see Note 2 and 4)                              | Maskable                                        | 0xFFEE           | 23              |
| USCI_A0/USCI_B0 transmit<br>USCI_B0 I2C receive/transmit                                      | UCA0TXIFG, UCB0TXIFG<br>(see Note 2 and 5)                              | Maskable                                        | 0xFFEC           | 22              |
| ADC10                                                                                         | ADC10IFG (see Note 3)                                                   | Maskable                                        | 0xFFEA           | 21              |
|                                                                                               |                                                                         |                                                 | 0xFFE8           | 20              |
| I/O port P2 (eight flags)                                                                     | P2IFG.0 to P2IFG.7<br>(see Notes 2 and 3)                               | Maskable                                        | 0xFFE6           | 19              |
| I/O port P1 (eight flags)                                                                     | P1IFG.0 to P1IFG.7<br>(see Notes 2 and 3)                               | Maskable                                        | 0xFFE4           | 18              |
|                                                                                               |                                                                         |                                                 | 0xFFE2           | 17              |
|                                                                                               |                                                                         |                                                 | 0xFFE0           | 16              |
| (See Note 7)                                                                                  |                                                                         |                                                 | 0xFFDE           | 15              |
| (See Note 8)                                                                                  |                                                                         |                                                 | 0xFFDC to 0xFFC0 | 14 to 0, lowest |

- NOTES:
1. A reset is executed if the CPU tries to fetch instructions from within the module register memory address range (0x0000 to 0x01FF).
  2. Multiple source flags.
  3. Interrupt flags are located in the module.
  4. In SPI mode: UCB0RXIFG. In I2C mode: UCALIFG, UCNACKIFG, ICSTTIFG, UCSTPIFG.
  5. In UART/SPI mode: UCB0TXIFG. In I2C mode: UCB0RXIFG, UCB0TXIFG.
  6. (Non)maskable: the individual interrupt-enable bit can disable an interrupt event, but the general interrupt enable cannot.
  7. This location is used as bootstrap loader security key (BSLSKEY).  
A 0xAA55 at this location disables the BSL completely.  
A zero (0h) disables the erasure of the flash if an invalid password is supplied.
  8. The interrupt vectors at addresses 0xFFDC to 0xFFC0 are not used in this device and can be used for regular program code if necessary.

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## special function registers

Most interrupt and module-enable bits are collected in the lowest address space. Special-function register bits not allocated to a functional purpose are not physically present in the device. This arrangement provides simple software access.

### interrupt enable 1 and 2

| Address | 7 | 6 | 5      | 4     | 3 | 2 | 1    | 0     |
|---------|---|---|--------|-------|---|---|------|-------|
| 00h     |   |   | ACCVIE | NMIIE |   |   | OFIE | WDTIE |
|         |   |   | rw-0   | rw-0  |   |   | rw-0 | rw-0  |

WDTIE Watchdog timer interrupt enable. Inactive if watchdog mode is selected. Active if watchdog timer is configured in interval timer mode.

OFIE Oscillator fault enable

NMIIE (Non)maskable interrupt enable

ACCVIE Flash access violation interrupt enable

| Address | 7 | 6 | 5 | 4 | 3        | 2        | 1        | 0        |
|---------|---|---|---|---|----------|----------|----------|----------|
| 01h     |   |   |   |   | UCB0TXIE | UCB0RXIE | UCA0TXIE | UCA0RXIE |
|         |   |   |   |   | rw-0     | rw-0     | rw-0     | rw-0     |

UCA0RXIE USCI\_A0 receive interrupt enable

UCA0TXIE USCI\_A0 transmit interrupt enable

UCB0RXIE USCI\_B0 receive interrupt enable

UCB0TXIE USCI\_B0 transmit interrupt enable



**interrupt flag register 1 and 2**

| Address | 7 | 6 | 5 | 4      | 3      | 2      | 1     | 0      |
|---------|---|---|---|--------|--------|--------|-------|--------|
| 02h     |   |   |   | NMIIFG | RSTIFG | PORIFG | OFIFG | WDTIFG |
|         |   |   |   | rw-0   | rw-(0) | rw-(1) | rw-1  | rw-(0) |

- WDTIFG     Set on watchdog timer overflow or security key violation.  
Reset on V<sub>CC</sub> power-up or a reset condition at  $\overline{\text{RST}}$ /NMI pin in reset mode.
- OFIFG       Flag set on oscillator fault
- RSTIFG     External reset interrupt flag. Set on a reset condition at  $\overline{\text{RST}}$ /NMI pin in reset mode. Reset on V<sub>CC</sub> power up
- PORIFG     Power-on interrupt flag. Set on V<sub>CC</sub> power-up.
- NMIIFG     Set via  $\overline{\text{RST}}$ /NMI pin

| Address | 7 | 6 | 5 | 4 | 3          | 2          | 1          | 0          |
|---------|---|---|---|---|------------|------------|------------|------------|
| 03h     |   |   |   |   | UCB0TX IFG | UCB0RX IFG | UCA0TX IFG | UCA0RX IFG |
|         |   |   |   |   | rw-1       | rw-0       | rw-1       | rw-0       |

- UCA0RXIFG    USCI\_A0 receive interrupt flag
- UCA0TXIFG    USCI\_A0 transmit interrupt flag
- UCB0RXIFG    USCI\_B0 receive interrupt flag
- UCB0TXIFG    USCI\_B0 transmit interrupt flag

- Legend**
- rw:                    Bit can be read and written.
  - rw-0,1:              Bit can be read and written. It is reset or set by PUC.
  - rw-(0,1):            Bit can be read and written. It is reset or set by POR.
  - SFR bit is not present in device

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## memory organization

|                        |           | MSP430F2112       | MSP430F2122       | MSP430F2132       |
|------------------------|-----------|-------------------|-------------------|-------------------|
| Memory                 | Size      | 2 KB              | 4 KB              | 8 KB              |
| Main: interrupt vector | Flash     | 0xFFFF to 0xFFC0  | 0xFFFF to 0xFFC0  | 0xFFFF to 0xFFC0  |
| Main: code memory      | Flash     | 0xFFFF to 0xF800  | 0xFFFF to 0xF000  | 0xFFFF to 0xE000  |
| Information memory     | Size      | 256 Byte          | 256 Byte          | 256 Byte          |
|                        | Flash     | 0x10FFh to 0x1000 | 0x10FFh to 0x1000 | 0x10FFh to 0x1000 |
| Boot memory            | Size      | 1 KB              | 1 KB              | 1 KB              |
|                        | ROM       | 0x0FFF to 0x0C00  | 0x0FFF to 0x0C00  | 0x0FFF to 0x0C00  |
| RAM                    | Size      | 256 B             | 512 Byte          | 512 Byte          |
|                        |           | 0x02FF to 0x0200  | 0x03FF to 0x0200  | 0x03FF to 0x0200  |
| Peripherals            | 16-bit    | 0x01FF to 0x0100  | 0x01FF to 0x0100  | 0x01FF to 0x0100  |
|                        | 8-bit     | 0x00FF to 0x0010  | 0x00FF to 0x0010  | 0x00FF to 0x0010  |
|                        | 8-bit SFR | 0x000F to 0x0000  | 0x000F to 0x0000  | 0x000F to 0x0000  |

## bootstrap loader (BSL)

The MSP430 BSL enables users to program the flash memory or RAM using a UART serial interface. Access to the MSP430 memory via the BSL is protected by user-defined password. For complete description of the features of the BSL and its implementation, see the application report *Features of the MSP430 Bootstrap Loader*, literature number SLAA089.

| BSL FUNCTION  | 28-PIN PW PACKAGE PINS | 32-PIN RHB PACKAGE PINS |
|---------------|------------------------|-------------------------|
| Data transmit | 22 - P1.1              | 22 - P1.1               |
| Data receive  | 10 - P2.2              | 8 - P2.2                |

## flash memory

The flash memory can be programmed via the JTAG port, the bootstrap loader, or in-system by the CPU. The CPU can perform single-byte and single-word writes to the flash memory. Features of the flash memory include:

- Flash memory has n segments of main memory and four segments of information memory (A to D) of 64bytes each. Each segment in main memory is 512 bytes in size.
- Segments 0 to n may be erased in one step, or each segment may be individually erased.
- Segments A to D can be erased individually, or as a group with segments 0 to n. Segments A to D are also called *information memory*.
- Segment A contains calibration data. After reset segment A is protected against programming or erasing. It can be unlocked but care should be taken not to erase this segment if the calibration data is required.



## peripherals

Peripherals are connected to the CPU through data, address, and control buses and can be handled using all instructions. For complete module descriptions, see the *MSP430x2xx Family User's Guide*.

## oscillator and system clock

The clock system is supported by the basic clock module that includes support for a 32768-Hz watch crystal oscillator, an internal very low power, low-frequency oscillator, an internal digitally controlled oscillator (DCO), and a high-frequency crystal oscillator. The basic clock module is designed to meet the requirements of both low system cost and low power consumption. The internal DCO provides a fast turn-on clock source and stabilizes in less than 1  $\mu$ s. The basic clock module provides the following clock signals:

- Auxiliary clock (ACLK), sourced from a 32768-Hz watch crystal, a high-frequency crystal or the internal very low power LF oscillator.
- Main clock (MCLK), the system clock used by the CPU.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules.

The DCO settings to calibrate the DCO output frequency are stored in the information memory segment A.

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## calibration data stored in information memory segment A

Calibration data is stored for both the DCO and for ADC10 organized in a tag-length-value structure.

| TAGS USED BY THE ADC CALIBRATION TAGS |         |       |                                                                                                |
|---------------------------------------|---------|-------|------------------------------------------------------------------------------------------------|
| NAME                                  | ADDRESS | VALUE | DESCRIPTION                                                                                    |
| TAG_DCO_30                            | 0x10F6  | 0x01  | DCO frequency calibration at $V_{CC} = 3\text{ V}$ and $T_A = 30^\circ\text{C}$ at calibration |
| TAG_ADC10_1                           | 0x10DA  | 0x10  | ADC10_1 calibration tag                                                                        |
| TAG_EMPTY                             | -       | 0xFE  | Identifier for empty memory areas                                                              |

| LABELS USED BY THE ADC CALIBRATION TAGS |                                                                    |      |                |
|-----------------------------------------|--------------------------------------------------------------------|------|----------------|
| LABEL                                   | CONDITION AT CALIBRATION / DESCRIPTION                             | SIZE | ADDRESS OFFSET |
| CAL_ADC_25T85                           | INCHx = 0x1010, REF2_5 = 1, $T_A = 85^\circ\text{C}$               | word | 0x000E         |
| CAL_ADC_25T30                           | INCHx = 0x1010, REF2_5 = 1, $T_A = 30^\circ\text{C}$               | word | 0x000C         |
| CAL_ADC_25VREF_FACTOR                   | REF2_5 = 1, $T_A = 30^\circ\text{C}$ , $I_{VREF+} = 1\text{ mA}$   | word | 0x000A         |
| CAL_ADC_15T85                           | INCHx = 0x1010, REF2_5 = 0, $T_A = 85^\circ\text{C}$               | word | 0x0008         |
| CAL_ADC_15T30                           | INCHx = 0x1010, REF2_5 = 0, $T_A = 30^\circ\text{C}$               | word | 0x0006         |
| CAL_ADC_15VREF_FACTOR                   | REF2_5 = 0, $T_A = 30^\circ\text{C}$ , $I_{VREF+} = 0.5\text{ mA}$ | word | 0x0004         |
| CAL_ADC_OFFSET                          | External $V_{REF} = 1.5\text{ V}$ , $f_{ADC10CLK} = 5\text{ MHz}$  | word | 0x0002         |
| CAL_ADC_GAIN_FACTOR                     | External $V_{REF} = 1.5\text{ V}$ , $f_{ADC10CLK} = 5\text{ MHz}$  | word | 0x0000         |
| CAL_BC1_1MHz                            | -                                                                  | byte | 0x0007         |
| CAL_DCO_1MHz                            | -                                                                  | byte | 0x0006         |
| CAL_BC1_8MHz                            | -                                                                  | byte | 0x0005         |
| CAL_DCO_8MHz                            | -                                                                  | byte | 0x0004         |
| CAL_BC1_12MHz                           | -                                                                  | byte | 0x0003         |
| CAL_DCO_12MHz                           | -                                                                  | byte | 0x0002         |
| CAL_BC1_16MHz                           | -                                                                  | byte | 0x0001         |
| CAL_DCO_16MHz                           | -                                                                  | byte | 0x0000         |

## brownout

The brownout circuit is implemented to provide the proper internal reset signal to the device during power on and power off.

## digital I/O

There are three 8-bit I/O ports implemented—ports P1 through P3:

- All individual I/O bits are independently programmable.
- Any combination of input, output, and interrupt conditions is possible.
- Edge-selectable interrupt input capability for all eight bits of ports P1 and P2.
- Read/write access to port-control registers is supported by all instructions.
- Each I/O has an individually programmable pullup/pulldown resistor.

The MSP430F21x2 devices provides up to 24 total port I/O pins available externally. See the device pinout for more information.



### watchdog timer + (WDT+)

The primary function of the WDT+ module is to perform a controlled system restart after a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the module can be configured as an interval timer and can generate interrupts at selected time intervals.

### ADC10

The ADC10 module supports fast, 10-bit analog-to-digital conversions. The module implements a 10-bit SAR core, sample select control, reference generator, and data transfer controller (DTC), for automatic conversion result handling, allowing ADC samples to be converted and stored without any CPU intervention.

### Comparator\_A+

The primary function of the comparator\_A+ module is to support precision slope analog-to-digital conversions, battery-voltage supervision, and monitoring of external analog signals.

### Timer0\_A3

Timer0\_A3 is a 16-bit timer/counter with three capture/compare registers. Timer0\_A3 can support multiple capture/compares, PWM outputs, and interval timing. Timer0\_A3 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

| TIMER0_A3 SIGNAL CONNECTIONS |            |                     |                   |              |                      |                   |                  |
|------------------------------|------------|---------------------|-------------------|--------------|----------------------|-------------------|------------------|
| INPUT PIN NUMBER             |            | DEVICE INPUT SIGNAL | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | OUTPUT PIN NUMBER |                  |
| 28-PIN PW                    | 32-PIN RHB |                     |                   |              |                      | 28-PIN PW         | 32-PIN RHB       |
| 21 - P1.0                    | 21 - P1.0  | TACLK               | TACLK             | Timer        | NA                   |                   |                  |
|                              |            | ACLK                | ACLK              |              |                      |                   |                  |
|                              |            | SMCLK               | SMCLK             |              |                      |                   |                  |
| 9 - P2.1                     | 7 - P2.1   | TAINCLK             | INCLK             |              |                      |                   |                  |
| 22 - P1.1                    | 22 - P1.1  | TA0                 | CCI0A             | CCR0         | TA0                  | 22 - P1.1         | 22 - P1.1        |
| 10 - P2.2                    | 8 - P2.2   | TA0                 | CCI0B             |              |                      | 26 - P1.5         | 26 - P1.5        |
|                              |            | DV <sub>SS</sub>    | GND               |              |                      | 10 - P2.2         | 8 - P2.2         |
|                              |            | DV <sub>CC</sub>    | V <sub>CC</sub>   |              |                      | ADC10 (internal)  | ADC10 (internal) |
| 23 - P1.2                    | 23 - P1.2  | TA1                 | CCI1A             | CCR1         | TA1                  | 23 - P1.2         | 23 - P1.2        |
|                              |            | CAOUT (internal)    | CCI1B             |              |                      | 27 - P1.6         | 27 - P1.6        |
|                              |            | DV <sub>SS</sub>    | GND               |              |                      | 19 - P2.3         | 18 - P2.3        |
|                              |            | DV <sub>CC</sub>    | V <sub>CC</sub>   |              |                      | ADC10 (internal)  | ADC10 (internal) |
| 24 - P1.3                    | 24 - P1.3  | TA2                 | CCI2A             | CCR2         | TA2                  | 24 - P1.3         | 24 - P1.3        |
|                              |            | ACLK (internal)     | CCI2B             |              |                      | 28 - P1.7         | 28 - P1.7        |
|                              |            | DV <sub>SS</sub>    | GND               |              |                      | 20 - P2.4         | 19 - P2.4        |
|                              |            | DV <sub>CC</sub>    | V <sub>CC</sub>   |              |                      | ADC10 (internal)  | ADC10 (internal) |

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## Timer1\_A2

Timer1\_A2 is a 16-bit timer/counter with two capture/compare registers. Timer1\_A2 can support multiple capture/compares, PWM outputs, and interval timing. Timer1\_A2 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

| TIMER1_A2 SIGNAL CONNECTIONS |            |                     |                   |              |                      |                   |            |
|------------------------------|------------|---------------------|-------------------|--------------|----------------------|-------------------|------------|
| INPUT PIN NUMBER             |            | DEVICE INPUT SIGNAL | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | OUTPUT PIN NUMBER |            |
| 28-PIN PW                    | 32-PIN RHB |                     |                   |              |                      | 28-PIN PW         | 32-PIN RHB |
| 21 - P1.0                    | 21 - P1.0  | TACLK               | TACLK             | Timer        | NA                   |                   |            |
|                              |            | ACLK                | ACLK              |              |                      |                   |            |
|                              |            | SMCLK               | SMCLK             |              |                      |                   |            |
| 9 - P2.1                     | 7 - P2.1   | TAINCLK             | INCLK             |              |                      |                   |            |
| 22 - P1.1                    | 22 - P1.1  | TA0                 | CCI0A             | CCR0         | TA0                  | 17 - P3.6         | 15 - P3.6  |
| 17 - P3.6                    | 15 - P3.6  | TA0                 | CCI0B             |              |                      |                   |            |
|                              |            | DV <sub>SS</sub>    | GND               |              |                      |                   |            |
|                              |            | DV <sub>CC</sub>    | V <sub>CC</sub>   |              |                      |                   |            |
| 18 - P3.7                    | 16 - P3.7  | TA1                 | CCI1A             | CCR1         | TA1                  | 18 - P3.7         | 16 - P3.7  |
|                              |            | CAOUT (internal)    | CCI1B             |              |                      |                   |            |
|                              |            | DV <sub>SS</sub>    | GND               |              |                      |                   |            |
|                              |            | DV <sub>CC</sub>    | V <sub>CC</sub>   |              |                      |                   |            |

## universal serial communications interface (USCI)

The USCI module is used for serial data communication. The USCI module supports synchronous communication protocols such as SPI (3 or 4 pin) and I2C, and asynchronous communication protocols such as UART, enhanced UART with automatic baudrate detection (LIN), and IrDA. Not all packages support the USCI functionality.

USCI\_A0 provides support for SPI (3 or 4 pin), UART, enhanced UART, and IrDA.

USCI\_B0 provides support for SPI (3 or 4 pin) and I2C.





**peripheral file map**

| <b>PERIPHERALS WITH WORD ACCESS</b> |                                                     |                         |           |
|-------------------------------------|-----------------------------------------------------|-------------------------|-----------|
| <b>ADC10</b>                        | ADC data transfer start address                     | ADC10SA                 | 0x01BC    |
|                                     | ADC memory                                          | ADC10MEM                | 0x01B4    |
|                                     | ADC control register 1                              | ADC10CTL1               | 0x01B2    |
|                                     | ADC control register 0                              | ADC10CTL0               | 0x01B0    |
|                                     | ADC analog enable 0                                 | ADC10AE0                | 0x004A    |
|                                     | ADC analog enable 1                                 | ADC10AE1                | 0x004B    |
|                                     | ADC data transfer control register 1                | ADC10DTC1               | 0x0049    |
|                                     | ADC data transfer control register 0                | ADC10DTC0               | 0x0048    |
| <b>Timer0_A3</b>                    | Capture/compare register                            | TA0CCR2                 | 0x0176    |
|                                     | Capture/compare register                            | TA0CCR1                 | 0x0174    |
|                                     | Capture/compare register                            | TA0CCR0                 | 0x0172    |
|                                     | Timer0_A3 register                                  | TA0R                    | 0x0170    |
|                                     | Capture/compare control                             | TA0CCTL2                | 0x0166    |
|                                     | Capture/compare control                             | TA0CCTL1                | 0x0164    |
|                                     | Capture/compare control                             | TA0CCTL0                | 0x0162    |
|                                     | Timer0_A3 control                                   | TA0CTL                  | 0x0160    |
| Timer0_A3 interrupt vector          | TA0IV                                               | 0x012E                  |           |
| <b>Timer1_A2</b>                    | Capture/compare register                            | TA1CCR1                 | 0x0194    |
|                                     | Capture/compare register                            | TA1CCR0                 | 0x0192    |
|                                     | Timer1_A2 register                                  | TA1R                    | 0x0190    |
|                                     | Capture/compare control                             | TA1CCTL1                | 0x0184    |
|                                     | Capture/compare control                             | TA1CCTL0                | 0x0182    |
|                                     | Timer1_A2 control                                   | TA1CTL                  | 0x0180    |
|                                     | Timer1_A2 interrupt vector                          | TA1IV                   | 0x011E    |
| <b>Flash Memory</b>                 | Flash control 3                                     | FCTL3                   | 0x012C    |
|                                     | Flash control 2                                     | FCTL2                   | 0x012A    |
|                                     | Flash control 1                                     | FCTL1                   | 0x0128    |
| <b>Watchdog Timer+</b>              | Watchdog/timer control                              | WDTCTL                  | 0x0120    |
| <b>PERIPHERALS WITH BYTE ACCESS</b> |                                                     |                         |           |
| <b>USCI_B0</b>                      | USCI_B0 transmit buffer                             | UCB0TXBUF               | 0x06F     |
|                                     | USCI_B0 receive buffer                              | UCB0RXBUF               | 0x06E     |
|                                     | USCI_B0 status                                      | UCB0STAT                | 0x06D     |
|                                     | USCI_B0 I2C Interrupt enable                        | UCB0CIE                 | 0x06C     |
|                                     | USCI_B0 bit rate control 1                          | UCB0BR1                 | 0x06B     |
|                                     | USCI_B0 bit rate control 0                          | UCB0BR0                 | 0x06A     |
|                                     | USCI_B0 control 1                                   | UCB0CTL1                | 0x069     |
|                                     | USCI_B0 control 0                                   | UCB0CTL0                | 0x068     |
|                                     | USCI_B0 I2C slave address                           | UCB0SA                  | 0x011A    |
|                                     | USCI_B0 I2C own address                             | UCB0OA                  | 0x0118    |
|                                     | <b>USCI_A0<br/>(28-pin and 32-pin version only)</b> | USCI_A0 transmit buffer | UCA0TXBUF |
| USCI_A0 receive buffer              |                                                     | UCA0RXBUF               | 0x0066    |
| USCI_A0 status                      |                                                     | UCA0STAT                | 0x0065    |
| USCI_A0 modulation control          |                                                     | UCA0MCTL                | 0x0064    |
| USCI_A0 baud rate control 1         |                                                     | UCA0BR1                 | 0x0063    |
| USCI_A0 baud rate control 0         |                                                     | UCA0BR0                 | 0x0062    |
| USCI_A0 control 1                   |                                                     | UCA0CTL1                | 0x0061    |
| USCI_A0 control 0                   |                                                     | UCA0CTL0                | 0x0060    |
| USCI_A0 IrDA receive control        |                                                     | UCA0IRRCTL              | 0x005F    |
| USCI_A0 IrDA transmit control       |                                                     | UCA0IRTCTL              | 0x005E    |
| USCI_A0 auto baud rate control      |                                                     | UCA0ABCTL               | 0x005D    |
| <b>Comparator_A+</b>                | Comparator_A port disable                           | CAPD                    | 0x005B    |
|                                     | Comparator_A control2                               | CACTL2                  | 0x005A    |
|                                     | Comparator_A control1                               | CACTL1                  | 0x0059    |

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| PERIPHERALS WITH BYTE ACCESS (continued) |                                                                                                                                                                                                                             |                                                                              |                                                                                        |
|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|
| <b>Basic Clock System+</b>               | Basic clock system control 3<br>Basic clock system control 2<br>Basic clock system control 1<br>DCO clock frequency control                                                                                                 | BCSCTL3<br>BCSCTL2<br>BCSCTL1<br>DCOCTL                                      | 0x0053<br>0x0058<br>0x0057<br>0x0056                                                   |
| <b>Port P3</b>                           | Port P3 resistor enable<br>Port P3 selection<br>Port P3 direction<br>Port P3 output<br>Port P3 input                                                                                                                        | P3REN<br>P3SEL<br>P3DIR<br>P3OUT<br>P3IN                                     | 0x0010<br>0x001B<br>0x001A<br>0x0019<br>0x0018                                         |
| <b>Port P2</b>                           | Port P2 selection 2<br>Port P2 resistor enable<br>Port P2 selection<br>Port P2 interrupt enable<br>Port P2 interrupt edge select<br>Port P2 interrupt flag<br>Port P2 direction<br>Port P2 output<br>Port P2 input          | P2SEL2<br>P2REN<br>P2SEL<br>P2IE<br>P2IES<br>P2IFG<br>P2DIR<br>P2OUT<br>P2IN | 0x0042<br>0x002F<br>0x002E<br>0x002D<br>0x002C<br>0x002B<br>0x002A<br>0x0029<br>0x0028 |
| <b>Port P1</b>                           | Port P1 selection 2 register<br>Port P1 resistor enable<br>Port P1 selection<br>Port P1 interrupt enable<br>Port P1 interrupt edge select<br>Port P1 interrupt flag<br>Port P1 direction<br>Port P1 output<br>Port P1 input | P1SEL2<br>P1REN<br>P1SEL<br>P1IE<br>P1IES<br>P1IFG<br>P1DIR<br>P1OUT<br>P1IN | 0x0041<br>0x0027<br>0x0026<br>0x0025<br>0x0024<br>0x0023<br>0x0022<br>0x0021<br>0x0020 |
| <b>Special Function</b>                  | SFR interrupt flag 2<br>SFR interrupt flag 1<br>SFR interrupt enable 2<br>SFR interrupt enable 1                                                                                                                            | IFG2<br>IFG1<br>IE2<br>IE1                                                   | 0x0003<br>0x0002<br>0x0001<br>0x0000                                                   |



**absolute maximum ratings (see Note 1)**

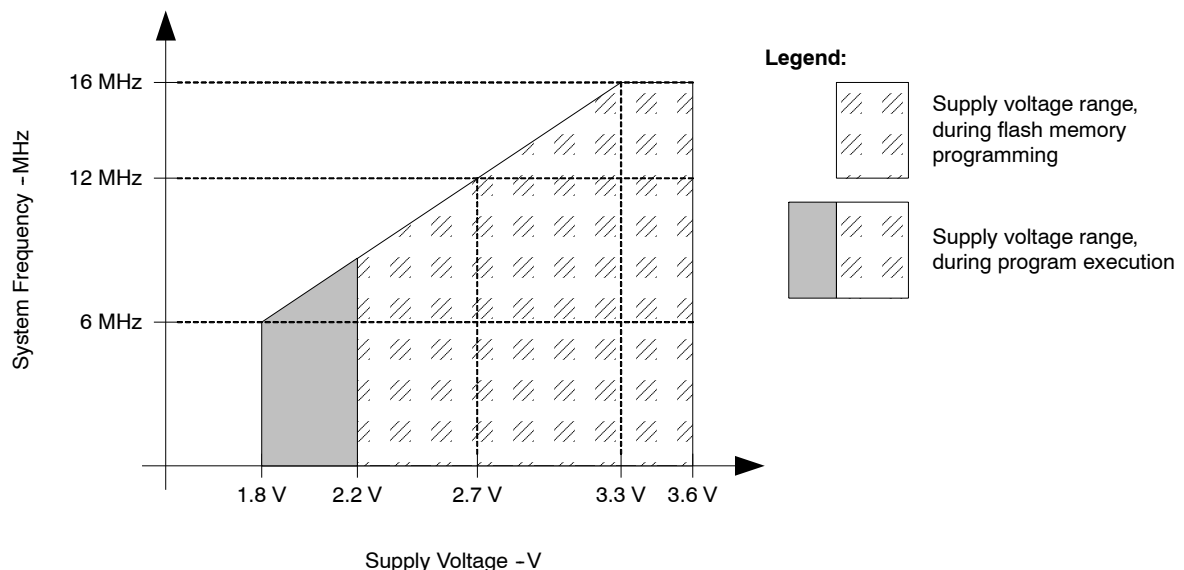
|                                                             |                          |
|-------------------------------------------------------------|--------------------------|
| Voltage applied at $V_{CC}$ to $V_{SS}$ .....               | -0.3 V to + 4.1 V        |
| Voltage applied to any pin (see Note 2) .....               | -0.3 V to $V_{CC}+0.3$ V |
| Diode current at any device terminal .....                  | $\pm 2$ mA               |
| Storage temperature (unprogrammed device, see Note 3) ..... | -55°C to 150°C           |
| Storage temperature (programmed device, see Note 3) .....   | -40°C to 105°C           |

- NOTES: 1. Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. All voltages referenced to  $V_{SS}$ . The JTAG fuse-blow voltage,  $V_{FB}$ , is allowed to exceed the absolute maximum rating. The voltage is applied to the TDI/TCLK pin when blowing the JTAG fuse.
3. Higher temperature may be applied during board soldering process according to the current JEDEC J-STD-020 specification with peak reflow temperatures not higher than classified on the device label on the shipping boxes or reels.

**recommended operating conditions**

| PARAMETER                                                                                  |                                                     | MIN | NOM | MAX | UNITS |
|--------------------------------------------------------------------------------------------|-----------------------------------------------------|-----|-----|-----|-------|
| Supply voltage during program execution, $V_{CC}$                                          | $AV_{CC} = DV_{CC} = V_{CC}$ (see Note 1)           | 1.8 |     | 3.6 | V     |
| Supply voltage during flash memory programming, $V_{CC}$                                   | $AV_{CC} = DV_{CC} = V_{CC}$ (see Note 1)           | 2.2 |     | 3.6 | V     |
| Supply voltage, $V_{SS}$                                                                   | $AV_{SS} = DV_{SS} = V_{SS}$                        | 0.0 |     | 0.0 | V     |
| Operating free-air temperature range, $T_A$                                                | I version                                           | -40 |     | 85  | °C    |
|                                                                                            | T version                                           | -40 |     | 105 |       |
| Processor frequency $f_{SYSTEM}$ (Maximum MCLK frequency)<br>(see Notes 1, 2 and Figure 1) | $V_{CC} = 1.8$ V,<br>Duty cycle = 50% $\pm 10\%$    | dc  |     | 6   | MHz   |
|                                                                                            | $V_{CC} = 2.7$ V,<br>Duty cycle = 50% $\pm 10\%$    | dc  |     | 12  |       |
|                                                                                            | $V_{CC} \geq 3.3$ V,<br>Duty cycle = 50% $\pm 10\%$ | dc  |     | 16  |       |

- NOTES: 1. The MSP430 CPU is clocked directly with MCLK.  
Both the high and low phase of MCLK must not exceed the pulse width of the specified maximum frequency.
2. Modules might have a different maximum input clock specification. See the specification of the respective module in this data sheet.



NOTE: Minimum processor frequency is defined by system clock. Flash program or erase operations require a minimum  $V_{CC}$  of 2.2 V.

**Figure 1. Operating Area**

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**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

**active mode supply current (into  $V_{CC}$ ) excluding external current (see Notes 1 and 2)**

| PARAMETER                                          | TEST CONDITIONS                                                                                                                                                                                                             | $T_A$         | $V_{CC}$ | MIN | TYP | MAX | UNIT    |
|----------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|----------|-----|-----|-----|---------|
| $I_{AM, 1MHz}$ Active mode (AM) current (1MHz)     | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 1MHz$ ,<br>$f_{ACLK} = 32,768Hz$ ,<br>Program executes from flash,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 0, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 0                    |               | 2.2 V    |     | 200 | 250 | $\mu A$ |
|                                                    |                                                                                                                                                                                                                             |               | 3 V      |     | 300 | 350 |         |
| $I_{AM, 1MHz}$ Active mode (AM) current (1MHz)     | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 1MHz$ ,<br>$f_{ACLK} = 32,768Hz$ ,<br>Program executes in RAM,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 0, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 0                        |               | 2.2 V    |     | 160 |     | $\mu A$ |
|                                                    |                                                                                                                                                                                                                             |               | 3 V      |     | 260 |     |         |
| $I_{AM, 4kHz}$ Active mode (AM) current (4kHz)     | $f_{MCLK} = f_{SMCLK} =$<br>$f_{ACLK} = 32,768Hz/8 = 4,096Hz$ ,<br>$f_{DCO} = 0Hz$ ,<br>Program executes in flash,<br>SELMx = 11, SELS = 1,<br>DIVMx = DIVSx = DIVAx = 11,<br>CPUOFF = 0, SCG0 = 1, SCG1 = 0,<br>OSCOFF = 0 | -40°C to 85°C | 2.2 V    |     | 2   | 5   | $\mu A$ |
|                                                    |                                                                                                                                                                                                                             | 105°C         |          |     |     | 6   |         |
|                                                    |                                                                                                                                                                                                                             | -40°C to 85°C | 3 V      |     | 3   | 7   |         |
|                                                    |                                                                                                                                                                                                                             | 105°C         |          |     |     | 9   |         |
| $I_{AM, 100kHz}$ Active mode (AM) current (100kHz) | $f_{MCLK} = f_{SMCLK} = f_{DCO(0, 0)} \approx 100kHz$ ,<br>$f_{ACLK} = 0Hz$ ,<br>Program executes in flash,<br>RSELx = 0, DCOx = 0,<br>CPUOFF = 0, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 1                                        | -40°C to 85°C | 2.2 V    |     | 60  | 85  | $\mu A$ |
|                                                    |                                                                                                                                                                                                                             | 105°C         |          |     |     | 90  |         |
|                                                    |                                                                                                                                                                                                                             | -40°C to 85°C | 3 V      |     | 72  | 95  |         |
|                                                    |                                                                                                                                                                                                                             | 105°C         |          |     |     | 100 |         |

- NOTES: 1. All inputs are tied to 0 V or  $V_{CC}$ . Outputs do not source or sink any current.  
2. The currents are characterized with a Micro Crystal CC4V-T1A SMD crystal with a load capacitance of 9 pF. The internal and external load capacitance is chosen to closely match the required 9 pF.

typical characteristics - active mode supply current (into  $DV_{CC}$  +  $AV_{CC}$ )

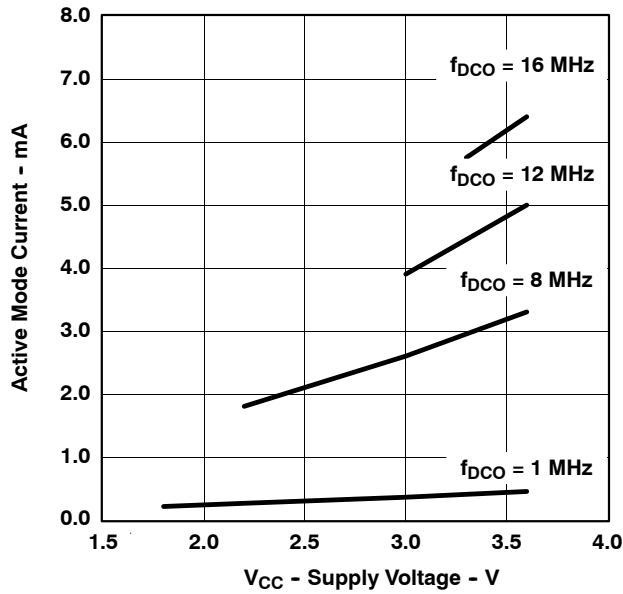


Figure 2. Active Mode Current vs  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$

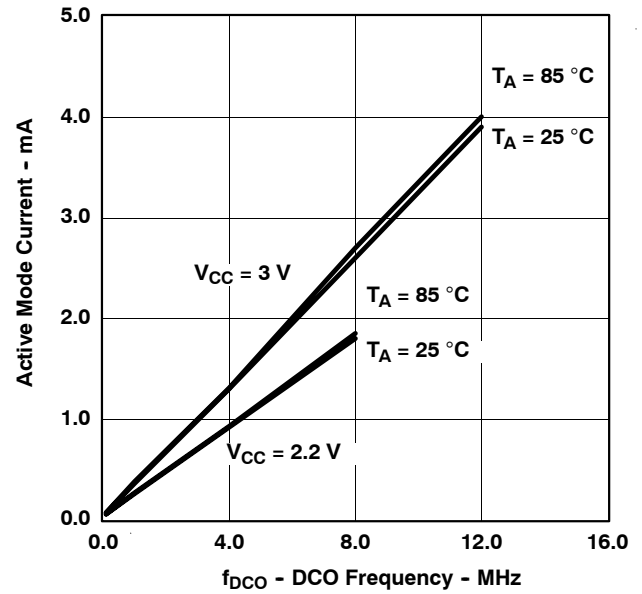


Figure 3. Active Mode Current vs DCO Frequency

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**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

**low-power mode supply currents (into  $V_{CC}$ ) excluding external current (see Notes 1 and 2)**

| PARAMETER                                                         | TEST CONDITIONS                                                                                                                                                                      | $T_A$         | $V_{CC}$      | MIN  | TYP | MAX     | UNIT |
|-------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|---------------|------|-----|---------|------|
| $I_{LPM0, 1MHz}$<br>Low-power mode 0 (LPM0) current, see Note 3   | $f_{MCLK} = 0$ MHz,<br>$f_{SMCLK} = f_{DCO} = 1$ MHz,<br>$f_{ACLK} = 32,768$ Hz,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 1, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 0 | -40°C to 85°C | 2.2 V         | 32   | 45  | $\mu$ A |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 49   |     |         |      |
|                                                                   |                                                                                                                                                                                      | -40°C to 85°C | 3 V           | 55   | 70  |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 74   |     |         |      |
| $I_{LPM0, 100kHz}$<br>Low-power mode 0 (LPM0) current, see Note 3 | $f_{MCLK} = 0$ MHz,<br>$f_{SMCLK} = f_{DCO(0,0)} \approx 100$ kHz,<br>$f_{ACLK} = 0$ Hz,<br>RSELX = 0, DCOx = 0,<br>CPUOFF = 1, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 1                    | -40°C to 85°C | 2.2 V         | 20   | 27  | $\mu$ A |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 31   |     |         |      |
|                                                                   |                                                                                                                                                                                      | -40°C to 85°C | 3 V           | 31   | 42  |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 46   |     |         |      |
| $I_{LPM2}$<br>Low-power mode 2 (LPM2) current, see Note 4         | $f_{MCLK} = f_{SMCLK} = 0$ MHz, $f_{DCO} = 1$ MHz,<br>$f_{ACLK} = 32,768$ Hz,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 1, SCG0 = 0, SCG1 = 1,<br>OSCOFF = 0    | -40°C to 85°C | 2.2 V         | 13   | 16  | $\mu$ A |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 20   |     |         |      |
|                                                                   |                                                                                                                                                                                      | -40°C to 85°C | 3 V           | 20   | 25  |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 31   |     |         |      |
| $I_{LPM3, LFX1}$<br>Low-power mode 3 (LPM3) current, see Note 4   | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{ACLK} = 32,768$ Hz,<br>CPUOFF = 1, SCG0 = 1, SCG1 = 1,<br>OSCOFF = 0                                                                | -40°C to 85°C | 2.2 V         | 0.7  | 1.2 | $\mu$ A |      |
|                                                                   |                                                                                                                                                                                      | 85°C          |               | 1.6  | 2.3 |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 3    | 6   |         |      |
|                                                                   |                                                                                                                                                                                      | -40°C to 85°C | 3 V           | 0.9  | 1.2 |         |      |
|                                                                   |                                                                                                                                                                                      | 85°C          |               | 1.6  | 2.8 |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 3    | 7   |         |      |
| $I_{LPM3, VLO}$<br>Low-power mode 3 current, (LPM3) see Note 4    | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{ACLK}$ from internal LF oscillator (VLO),<br>CPUOFF = 1, SCG0 = 1, SCG1 = 1,<br>OSCOFF = 0                                          | -40°C         | 2.2 V         | 0.25 | 0.7 | $\mu$ A |      |
|                                                                   |                                                                                                                                                                                      | 25°C          |               | 0.3  | 0.7 |         |      |
|                                                                   |                                                                                                                                                                                      | 85°C          |               | 1.2  | 1.9 |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         | 3 V           | 2    | 5   |         |      |
|                                                                   |                                                                                                                                                                                      | -40°C to 85°C |               | 0.7  | 0.8 |         |      |
|                                                                   |                                                                                                                                                                                      | 85°C          |               | 1.4  | 2.1 |         |      |
| $I_{LPM4}$<br>Low-power mode 4 (LPM4) current, see Note 5         | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{ACLK} = 0$ Hz,<br>CPUOFF = 1, SCG0 = 1, SCG1 = 1,<br>OSCOFF = 1                                                                     | -40°C         | 2.2 V/<br>3 V | 0.1  | 0.5 | $\mu$ A |      |
|                                                                   |                                                                                                                                                                                      | 25°C          |               | 0.1  | 0.5 |         |      |
|                                                                   |                                                                                                                                                                                      | 85°C          | 3 V           | 0.8  | 1.5 |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 2    | 4   |         |      |
|                                                                   |                                                                                                                                                                                      | 105°C         |               | 2    | 4   |         |      |

- NOTES: 1. All inputs are tied to 0 V or  $V_{CC}$ . Outputs do not source or sink any current.  
 2. The currents are characterized with a Micro Crystal CC4V-T1A SMD crystal with a load capacitance of 9 pF. The internal and external load capacitance is chosen to closely match the required 9 pF.  
 3. Current for brownout and WDT clocked by SMCLK included.  
 4. Current for brownout and WDT clocked by ACLK included.  
 5. Current for brownout included.



electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

typical characteristics - LPM4 current

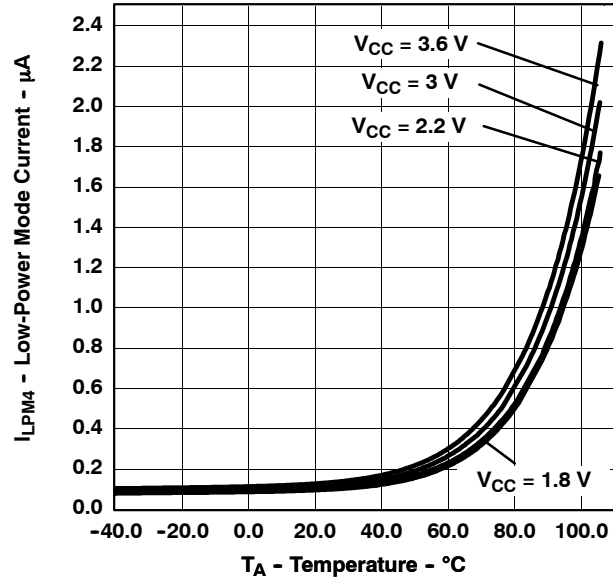


Figure 4.  $I_{LPM4}$  - LPM4 Current vs Temperature

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

## Schmitt-trigger inputs - Ports P1, P2, P3, JTAG, $\overline{\text{RST/NMI}}$ , and XIN (see Note 1)

| PARAMETER         | TEST CONDITIONS                                                 | V <sub>CC</sub>                                                                                    | MIN  | TYP | MAX  | UNIT            |
|-------------------|-----------------------------------------------------------------|----------------------------------------------------------------------------------------------------|------|-----|------|-----------------|
| V <sub>IT+</sub>  | Positive-going input threshold voltage                          |                                                                                                    | 0.45 |     | 0.75 | V <sub>CC</sub> |
|                   |                                                                 | 2.2 V                                                                                              | 1.00 |     | 1.65 | V               |
|                   |                                                                 | 3 V                                                                                                | 1.35 |     | 2.25 | V               |
| V <sub>IT-</sub>  | Negative-going input threshold voltage                          |                                                                                                    | 0.25 |     | 0.55 | V <sub>CC</sub> |
|                   |                                                                 | 2.2 V                                                                                              | 0.55 |     | 1.20 | V               |
|                   |                                                                 | 3 V                                                                                                | 0.75 |     | 1.65 | V               |
| V <sub>hys</sub>  | Input voltage hysteresis (V <sub>IT+</sub> - V <sub>IT-</sub> ) | 2.2 V                                                                                              | 0.2  |     | 1.0  | V               |
|                   |                                                                 | 3 V                                                                                                | 0.3  |     | 1.0  | V               |
| R <sub>Pull</sub> | Pullup/pulldown resistor                                        | For pullup: V <sub>IN</sub> = V <sub>SS</sub> ;<br>For pulldown: V <sub>IN</sub> = V <sub>CC</sub> | 20   | 35  | 50   | kΩ              |
| C <sub>I</sub>    | Input capacitance                                               | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                               |      | 5   |      | pF              |

NOTE 1: XIN only in bypass mode

## inputs - Ports P1, P2

| PARAMETER          | TEST CONDITIONS                                                                            | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------|--------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| t <sub>(int)</sub> | Port P1, P2: P1.x to P2.x, External trigger pulse width to set interrupt flag (see Note 2) | 2.2 V/3 V       | 20  |     |     | ns   |

NOTE 2: An external signal sets the interrupt flag every time the minimum interrupt pulse width t<sub>(int)</sub> is met. It may be set with trigger signals shorter than t<sub>(int)</sub>.

## leakage current - Ports P1, P2 and P3

| PARAMETER              | TEST CONDITIONS                | V <sub>CC</sub>   | MIN | TYP | MAX | UNIT |
|------------------------|--------------------------------|-------------------|-----|-----|-----|------|
| I <sub>lkg(Px.x)</sub> | High-impedance leakage current | See Notes 1 and 2 |     |     | ±50 | nA   |

NOTES: 1. The leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pin(s), unless otherwise noted.  
2. The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup/pulldown resistor is disabled.



**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**outputs - Ports P1, P2 and P3**

| PARAMETER       |                           | TEST CONDITIONS                              | V <sub>CC</sub> | MIN                   | TYP | MAX                   | UNIT |
|-----------------|---------------------------|----------------------------------------------|-----------------|-----------------------|-----|-----------------------|------|
| V <sub>OH</sub> | High-level output voltage | I <sub>(OHmax)</sub> = -1.5 mA (see Notes 1) | 2.2 V           | V <sub>CC</sub> -0.25 |     | V <sub>CC</sub>       | V    |
|                 |                           | I <sub>(OHmax)</sub> = -6 mA (see Notes 2)   | 2.2 V           | V <sub>CC</sub> -0.6  |     | V <sub>CC</sub>       |      |
|                 |                           | I <sub>(OHmax)</sub> = -1.5 mA (see Notes 1) | 3 V             | V <sub>CC</sub> -0.25 |     | V <sub>CC</sub>       |      |
|                 |                           | I <sub>(OHmax)</sub> = -6 mA (see Notes 2)   | 3 V             | V <sub>CC</sub> -0.6  |     | V <sub>CC</sub>       |      |
| V <sub>OL</sub> | Low-level output voltage  | I <sub>(OLmax)</sub> = 1.5 mA (see Notes 1)  | 2.2 V           | V <sub>SS</sub>       |     | V <sub>SS</sub> +0.25 | V    |
|                 |                           | I <sub>(OLmax)</sub> = 6 mA (see Notes 2)    | 2.2 V           | V <sub>SS</sub>       |     | V <sub>SS</sub> +0.6  |      |
|                 |                           | I <sub>(OLmax)</sub> = 1.5 mA (see Notes 1)  | 3 V             | V <sub>SS</sub>       |     | V <sub>SS</sub> +0.25 |      |
|                 |                           | I <sub>(OLmax)</sub> = 6 mA (see Notes 2)    | 3 V             | V <sub>SS</sub>       |     | V <sub>SS</sub> +0.6  |      |

- NOTES: 1. The maximum total current, I<sub>OHmax</sub> and I<sub>OLmax</sub>, for all outputs combined, should not exceed ±12 mA to hold the maximum voltage drop specified.  
 2. The maximum total current, I<sub>OHmax</sub> and I<sub>OLmax</sub>, for all outputs combined, should not exceed ±48 mA to hold the maximum voltage drop specified.

**output frequency - Ports P1, P2 and P3**

| PARAMETER             |                                   | TEST CONDITIONS                                                              | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------|-----------------------------------|------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>Px.y</sub>     | Port output frequency (with load) | P1.4/SMCLK, C <sub>L</sub> = 20 pF, R <sub>L</sub> = 1 kΩ (see Note 1 and 2) | 2.2 V           |     |     | 7.5 | MHz  |
|                       |                                   |                                                                              | 3 V             |     |     | 12  | MHz  |
| f <sub>Port_CLK</sub> | Clock output frequency            | P2.0/ACLK, P1.4/SMCLK, C <sub>L</sub> = 20 pF (see Note 2)                   | 2.2 V           |     |     | 7.5 | MHz  |
|                       |                                   |                                                                              | 3 V             |     |     | 16  | MHz  |

- NOTES: 1. A resistive divider with 2 × 0.5 kΩ between V<sub>CC</sub> and V<sub>SS</sub> is used as load. The output is connected to the center tap of the divider.  
 2. The output voltage reaches at least 10% and 90% V<sub>CC</sub> at the specified toggle frequency.

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

typical characteristics - outputs

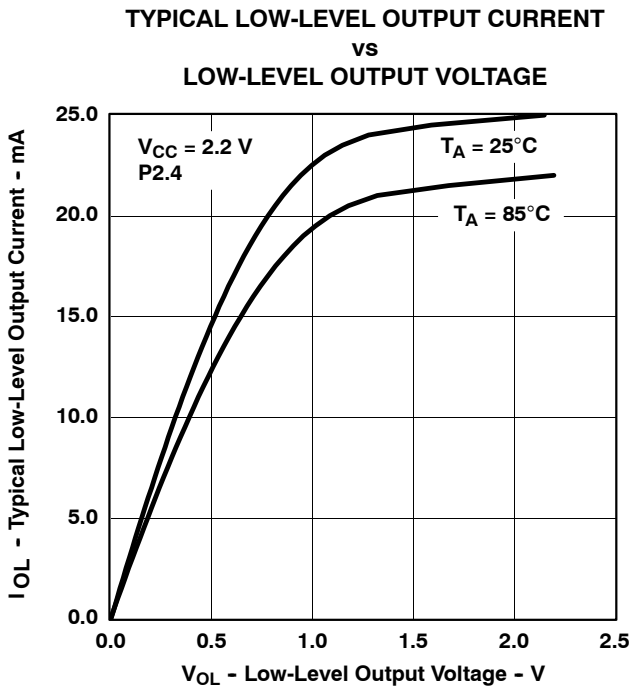


Figure 5

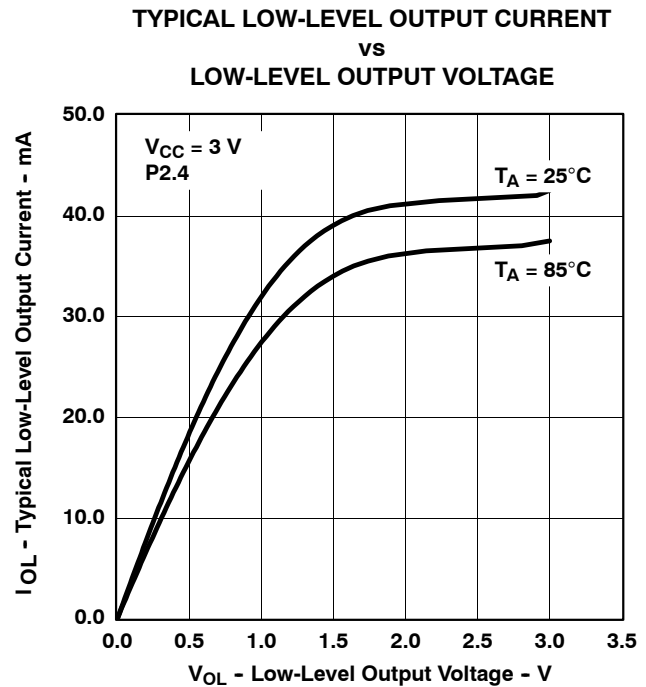


Figure 6

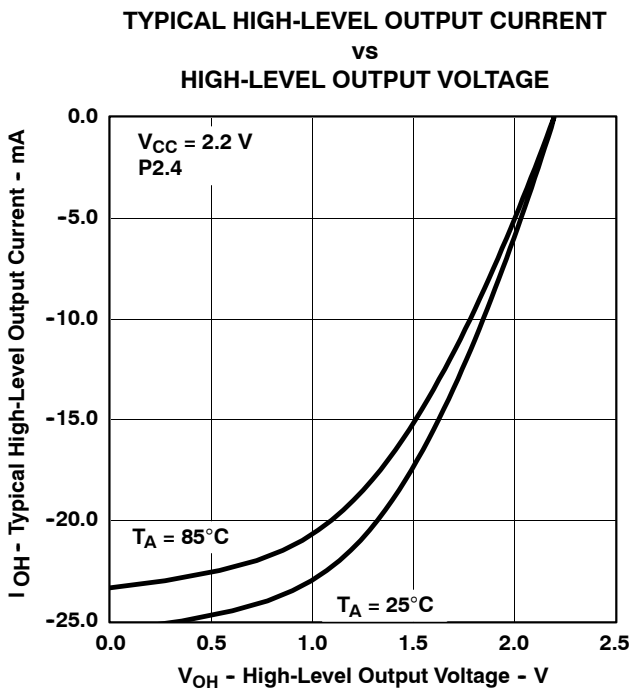


Figure 7

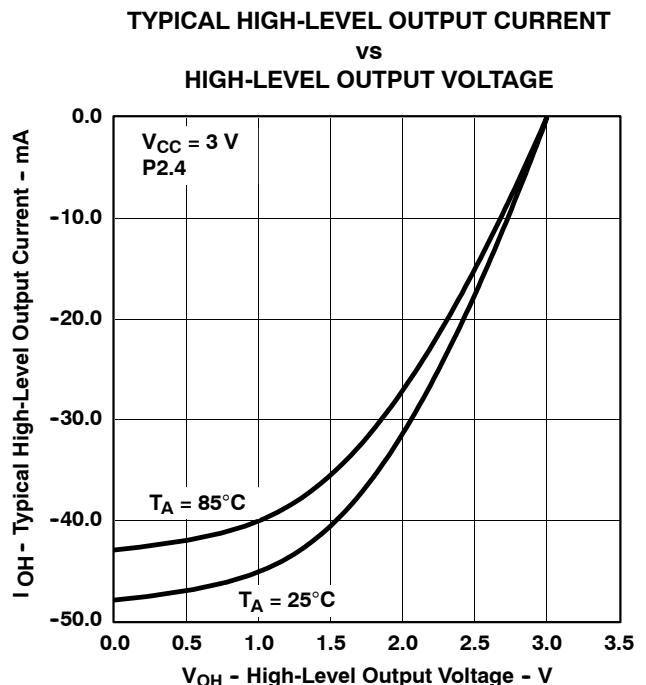


Figure 8

NOTE: One output loaded at a time.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

**POR/brownout reset (BOR) (see Notes 1 and 2)**

| PARAMETER               |                                                                                            | TEST CONDITIONS              | V <sub>CC</sub> | MIN                        | TYP | MAX  | UNIT |
|-------------------------|--------------------------------------------------------------------------------------------|------------------------------|-----------------|----------------------------|-----|------|------|
| V <sub>CC(start)</sub>  | See Figure 9                                                                               | dV <sub>CC</sub> /dt ≤ 3 V/s |                 | 0.7 × V <sub>(B_IT-)</sub> |     |      | V    |
| V <sub>(B_IT-)</sub>    | See Figure 9 through Figure 11                                                             | dV <sub>CC</sub> /dt ≤ 3 V/s |                 |                            |     | 1.71 | V    |
| V <sub>hys(B_IT-)</sub> | See Figure 9                                                                               | dV <sub>CC</sub> /dt ≤ 3 V/s |                 | 70                         | 130 | 210  | mV   |
| t <sub>d(BOR)</sub>     | See Figure 9                                                                               |                              |                 |                            |     | 2000 | μs   |
| t <sub>(reset)</sub>    | Pulse length needed at $\overline{\text{RST}}/\text{NMI}$ pin to accepted reset internally |                              | 2.2 V/3 V       | 2                          |     |      | μs   |

- NOTES: 1. The current consumption of the brownout module is already included in the I<sub>CC</sub> current consumption data. The voltage level V<sub>(B\_IT-)</sub> + V<sub>hys(B\_IT-)</sub> is ≤ 1.8V.
2. During power up, the CPU begins code execution following a period of t<sub>d(BOR)</sub> after V<sub>CC</sub> = V<sub>(B\_IT-)</sub> + V<sub>hys(B\_IT-)</sub>. The default DCO settings must not be changed until V<sub>CC</sub> ≥ V<sub>CC(min)</sub>, where V<sub>CC(min)</sub> is the minimum supply voltage for the desired operating frequency.

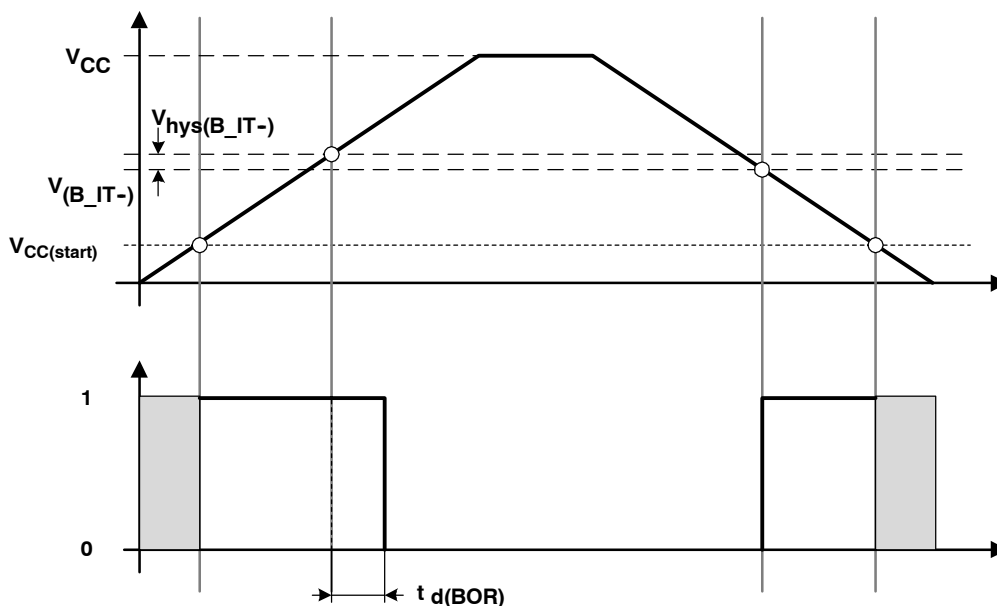


Figure 9. POR/Brownout Reset (BOR) vs Supply Voltage

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

typical characteristics - POR/brownout reset (BOR)

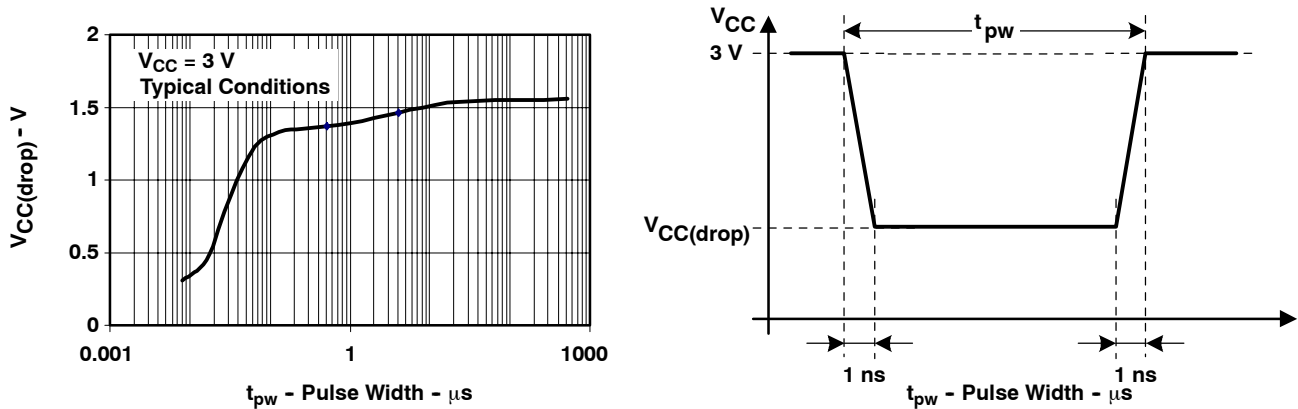


Figure 10.  $V_{CC(drop)}$  Level With a Square Voltage Drop to Generate a POR/Brownout Signal

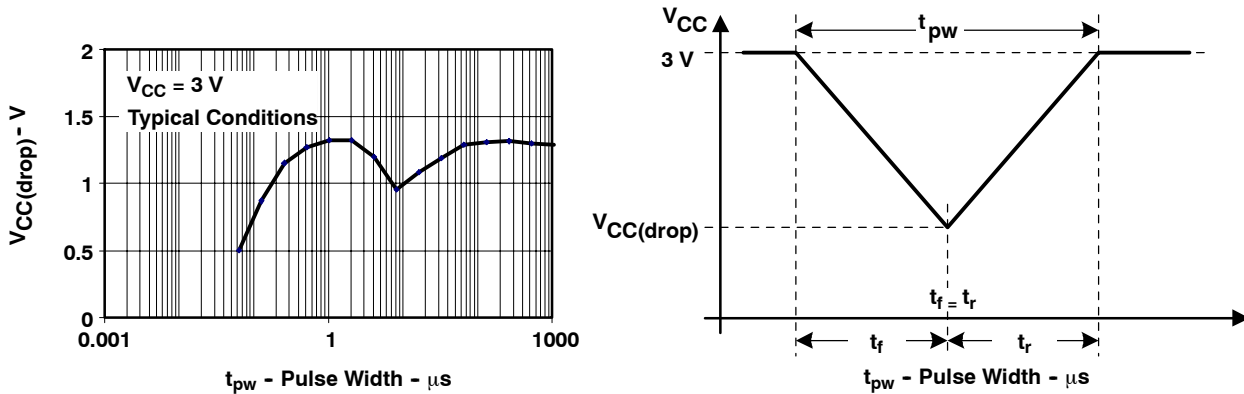


Figure 11.  $V_{CC(drop)}$  Level With a Triangle Voltage Drop to Generate a POR/Brownout Signal

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**main DCO characteristics**

- All ranges selected by RSELx overlap with RSELx + 1; e.g., RSELx = 0 overlaps RSELx = 1, and RSELx = 14 overlaps RSELx = 15.
- DCO control bits DCOx have a step size as defined by parameter S<sub>DCO</sub>.
- Modulation control bits MODx select how often f<sub>DCO(RSEL,DCO+1)</sub> is used within the period of 32 DCOCLK cycles. The frequency f<sub>DCO(RSEL,DCO)</sub> is used for the remaining cycles. The frequency is an average equal to:

$$f_{average} = \frac{32 \times f_{DCO(RSEL,DCO)} \times f_{DCO(RSEL,DCO+1)}}{MOD \times f_{DCO(RSEL,DCO)} + (32 - MOD) \times f_{DCO(RSEL,DCO+1)}}$$

**DCO frequency**

| PARAMETER              | TEST CONDITIONS                              | V <sub>CC</sub>                                                              | MIN       | TYP  | MAX  | UNIT  |      |
|------------------------|----------------------------------------------|------------------------------------------------------------------------------|-----------|------|------|-------|------|
| V <sub>CC</sub>        | Supply voltage range                         |                                                                              | 1.8       |      | 3.6  | V     |      |
|                        |                                              |                                                                              | 2.2       |      | 3.6  | V     |      |
|                        |                                              |                                                                              | 3.0       |      | 3.6  | V     |      |
| f <sub>DCO(0,0)</sub>  | DCO frequency (0, 0)                         | RSELx = 0, DCOx = 0, MODx = 0                                                | 2.2 V/3 V | 0.06 | 0.14 | MHz   |      |
| f <sub>DCO(0,3)</sub>  | DCO frequency (0, 3)                         | RSELx = 0, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.07 | 0.17 | MHz   |      |
| f <sub>DCO(1,3)</sub>  | DCO frequency (1, 3)                         | RSELx = 1, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.10 | 0.20 | MHz   |      |
| f <sub>DCO(2,3)</sub>  | DCO frequency (2, 3)                         | RSELx = 2, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.14 | 0.28 | MHz   |      |
| f <sub>DCO(3,3)</sub>  | DCO frequency (3, 3)                         | RSELx = 3, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.20 | 0.40 | MHz   |      |
| f <sub>DCO(4,3)</sub>  | DCO frequency (4, 3)                         | RSELx = 4, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.28 | 0.54 | MHz   |      |
| f <sub>DCO(5,3)</sub>  | DCO frequency (5, 3)                         | RSELx = 5, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.39 | 0.77 | MHz   |      |
| f <sub>DCO(6,3)</sub>  | DCO frequency (6, 3)                         | RSELx = 6, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.54 | 1.06 | MHz   |      |
| f <sub>DCO(7,3)</sub>  | DCO frequency (7, 3)                         | RSELx = 7, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 0.80 | 1.50 | MHz   |      |
| f <sub>DCO(8,3)</sub>  | DCO frequency (8, 3)                         | RSELx = 8, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 1.10 | 2.10 | MHz   |      |
| f <sub>DCO(9,3)</sub>  | DCO frequency (9, 3)                         | RSELx = 9, DCOx = 3, MODx = 0                                                | 2.2 V/3 V | 1.60 | 3.00 | MHz   |      |
| f <sub>DCO(10,3)</sub> | DCO frequency (10, 3)                        | RSELx = 10, DCOx = 3, MODx = 0                                               | 2.2 V/3 V | 2.50 | 4.30 | MHz   |      |
| f <sub>DCO(11,3)</sub> | DCO frequency (11, 3)                        | RSELx = 11, DCOx = 3, MODx = 0                                               | 2.2 V/3 V | 3.00 | 5.50 | MHz   |      |
| f <sub>DCO(12,3)</sub> | DCO frequency (12, 3)                        | RSELx = 12, DCOx = 3, MODx = 0                                               | 2.2 V/3 V | 4.30 | 7.30 | MHz   |      |
| f <sub>DCO(13,3)</sub> | DCO frequency (13, 3)                        | RSELx = 13, DCOx = 3, MODx = 0                                               | 2.2 V/3 V | 6.00 | 9.60 | MHz   |      |
| f <sub>DCO(14,3)</sub> | DCO frequency (14, 3)                        | RSELx = 14, DCOx = 3, MODx = 0                                               | 2.2 V/3 V | 8.60 | 13.9 | MHz   |      |
| f <sub>DCO(15,3)</sub> | DCO frequency (15, 3)                        | RSELx = 15, DCOx = 3, MODx = 0                                               | 3 V       | 12.0 | 18.5 | MHz   |      |
| f <sub>DCO(15,7)</sub> | DCO frequency (15, 7)                        | RSELx = 15, DCOx = 7, MODx = 0                                               | 3 V       | 16.0 | 26.0 | MHz   |      |
| S <sub>RSEL</sub>      | Frequency step between range RSEL and RSEL+1 | S <sub>RSEL</sub> = f <sub>DCO(RSEL+1,DCO)</sub> /f <sub>DCO(RSEL,DCO)</sub> | 2.2 V/3 V |      | 1.55 | ratio |      |
| S <sub>DCO</sub>       | Frequency step between tap DCO and DCO+1     | S <sub>DCO</sub> = f <sub>DCO(RSEL,DCO+1)</sub> /f <sub>DCO(RSEL,DCO)</sub>  | 2.2 V/3 V | 1.05 | 1.08 |       | 1.12 |
| Duty Cycle             |                                              | Measured at P1.4/SMCLK                                                       | 2.2 V/3 V | 40   | 50   | 60    | %    |

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**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

## calibrated DCO frequencies - tolerance at calibration

| PARAMETER                                        | TEST CONDITIONS                                                         | T <sub>A</sub> | V <sub>CC</sub> | MIN   | TYP  | MAX   | UNIT |
|--------------------------------------------------|-------------------------------------------------------------------------|----------------|-----------------|-------|------|-------|------|
| Frequency tolerance at calibration               |                                                                         | 25°C           | 3 V             | -1    | ±0.2 | +1    | %    |
| f <sub>CAL(1MHz)</sub> 1-MHz calibration value   | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>Gating time = 5 ms   | 25°C           | 3 V             | 0.990 | 1    | 1.010 | MHz  |
| f <sub>CAL(8MHz)</sub> 8-MHz calibration value   | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>Gating time = 5 ms   | 25°C           | 3 V             | 7.920 | 8    | 8.080 | MHz  |
| f <sub>CAL(12MHz)</sub> 12-MHz calibration value | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>Gating time = 5 ms | 25°C           | 3 V             | 11.88 | 12   | 12.12 | MHz  |
| f <sub>CAL(16MHz)</sub> 16-MHz calibration value | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>Gating time = 2 ms | 25°C           | 3 V             | 15.84 | 16   | 16.16 | MHz  |

## calibrated DCO frequencies - tolerance over temperature 0°C - +85°C

| PARAMETER                                        | TEST CONDITIONS                                                         | T <sub>A</sub> | V <sub>CC</sub> | MIN   | TYP  | MAX   | UNIT |
|--------------------------------------------------|-------------------------------------------------------------------------|----------------|-----------------|-------|------|-------|------|
| 1-MHz tolerance over temperature                 |                                                                         | 0°C to 85°C    | 3 V             | -2.5  | ±0.5 | +2.5  | %    |
| 8-MHz tolerance over temperature                 |                                                                         | 0°C to 85°C    | 3 V             | -2.5  | ±1   | +2.5  | %    |
| 12-MHz tolerance over temperature                |                                                                         | 0°C to 85°C    | 3 V             | -2.5  | ±1   | +2.5  | %    |
| 16-MHz tolerance over temperature                |                                                                         | 0°C to 85°C    | 3 V             | -3    | ±2   | +3    | %    |
| f <sub>CAL(1MHz)</sub> 1-MHz calibration value   | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>Gating time: 5ms     | 0°C to 85°C    | 2.2 V           | 0.970 | 1    | 1.030 | MHz  |
|                                                  |                                                                         |                | 3 V             | 0.975 | 1    | 1.025 | MHz  |
|                                                  |                                                                         |                | 3.6 V           | 0.970 | 1    | 1.030 | MHz  |
| f <sub>CAL(8MHz)</sub> 8-MHz calibration value   | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>Gating time = 5 ms   | 0°C to 85°C    | 2.2 V           | 7.760 | 8    | 8.400 | MHz  |
|                                                  |                                                                         |                | 3 V             | 7.800 | 8    | 8.200 | MHz  |
|                                                  |                                                                         |                | 3.6 V           | 7.600 | 8    | 8.240 | MHz  |
| f <sub>CAL(12MHz)</sub> 12-MHz calibration value | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>Gating time = 5 ms | 0°C to 85°C    | 2.2 V           | 11.64 | 12   | 12.36 | MHz  |
|                                                  |                                                                         |                | 3 V             | 11.64 | 12   | 12.36 | MHz  |
|                                                  |                                                                         |                | 3.6 V           | 11.64 | 12   | 12.36 | MHz  |
| f <sub>CAL(16MHz)</sub> 16-MHz calibration value | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>Gating time = 2 ms | 0°C to 85°C    | 3 V             | 15.52 | 16   | 16.48 | MHz  |
|                                                  |                                                                         |                | 3.6 V           | 15.00 | 16   | 16.48 | MHz  |



**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**calibrated DCO frequencies - tolerance over supply voltage  $V_{CC}$**

| PARAMETER                                 | TEST CONDITIONS                                                         | $T_A$ | $V_{CC}$       | MIN   | TYP | MAX   | UNIT |
|-------------------------------------------|-------------------------------------------------------------------------|-------|----------------|-------|-----|-------|------|
| 1-MHz tolerance over $V_{CC}$             |                                                                         | 25°C  | 1.8 V to 3.6 V | -3    | ±2  | +3    | %    |
| 8-MHz tolerance over $V_{CC}$             |                                                                         | 25°C  | 1.8 V to 3.6 V | -3    | ±2  | +3    | %    |
| 12-MHz tolerance over $V_{CC}$            |                                                                         | 25°C  | 2.2 V to 3.6 V | -3    | ±2  | +3    | %    |
| 16-MHz tolerance over $V_{CC}$            |                                                                         | 25°C  | 3 V to 3.6 V   | -6    | ±2  | +3    | %    |
| $f_{CAL(1MHz)}$ 1-MHz calibration value   | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>Gating time = 5 ms   | 25°C  | 1.8 V to 3.6 V | 0.970 | 1   | 1.030 | MHz  |
| $f_{CAL(8MHz)}$ 8-MHz calibration value   | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>Gating time = 5 ms   | 25°C  | 1.8 V to 3.6 V | 7.760 | 8   | 8.240 | MHz  |
| $f_{CAL(12MHz)}$ 12-MHz calibration value | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>Gating time = 5 ms | 25°C  | 2.2 V to 3.6 V | 11.64 | 12  | 12.36 | MHz  |
| $f_{CAL(16MHz)}$ 16-MHz calibration value | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>Gating time = 2 ms | 25°C  | 3 V to 3.6 V   | 15.00 | 16  | 16.48 | MHz  |

**calibrated DCO frequencies - overall tolerance**

| PARAMETER                                 | TEST CONDITIONS                                                         | $T_A$          | $V_{CC}$       | MIN   | TYP | MAX   | UNIT |
|-------------------------------------------|-------------------------------------------------------------------------|----------------|----------------|-------|-----|-------|------|
| 1-MHz tolerance overall                   |                                                                         | -40°C to 105°C | 1.8 V to 3.6 V | -5    | ±2  | +5    | %    |
| 8-MHz tolerance overall                   |                                                                         | -40°C to 105°C | 1.8 V to 3.6 V | -5    | ±2  | +5    | %    |
| 12-MHz tolerance overall                  |                                                                         | -40°C to 105°C | 2.2 V to 3.6 V | -5    | ±2  | +5    | %    |
| 16-MHz tolerance overall                  |                                                                         | -40°C to 105°C | 3 V to 3.6 V   | -6    | ±3  | +6    | %    |
| $f_{CAL(1MHz)}$ 1-MHz calibration value   | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>Gating time = 5 ms   | -40°C to 105°C | 1.8 V to 3.6 V | 0.950 | 1   | 1.050 | MHz  |
| $f_{CAL(8MHz)}$ 8-MHz calibration value   | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>Gating time = 5 ms   | -40°C to 105°C | 1.8 V to 3.6 V | 7.600 | 8   | 8.400 | MHz  |
| $f_{CAL(12MHz)}$ 12-MHz calibration value | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>Gating time = 5 ms | -40°C to 105°C | 2.2 V to 3.6 V | 11.40 | 12  | 12.60 | MHz  |
| $f_{CAL(16MHz)}$ 16-MHz calibration value | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>Gating time = 2 ms | -40°C to 105°C | 3 V to 3.6 V   | 15.00 | 16  | 17.00 | MHz  |

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

typical characteristics - calibrated DCO frequency

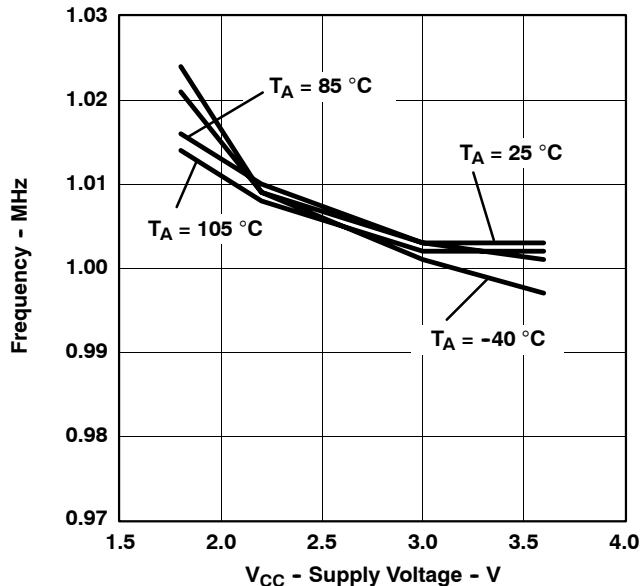


Figure 12. Calibrated 1 MHz Frequency vs V<sub>CC</sub>



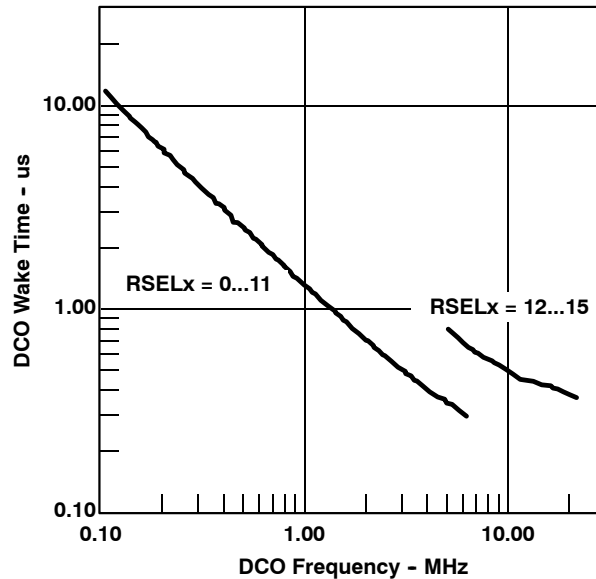
**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**wake-up from lower power modes (LPM3/4)**

| PARAMETER                                                                  | TEST CONDITIONS                                  | V <sub>CC</sub> | MIN | TYP                                                | MAX | UNIT |
|----------------------------------------------------------------------------|--------------------------------------------------|-----------------|-----|----------------------------------------------------|-----|------|
| t <sub>DCO,LPM3/4</sub><br>DCO clock wake-up time from LPM3/4 (see Note 1) | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ   | 2.2 V/3 V       |     |                                                    | 2   | μs   |
|                                                                            | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ   | 2.2 V/3 V       |     |                                                    | 1.5 |      |
|                                                                            | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ | 2.2 V/3 V       |     |                                                    | 1   |      |
|                                                                            | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ | 3 V             |     |                                                    | 1   |      |
| t <sub>CPU,LPM3/4</sub><br>CPU wake-up time from LPM3/4 (see Note 2)       |                                                  |                 |     | 1/f <sub>MCLK</sub> +<br>t <sub>Clock,LPM3/4</sub> |     |      |

- NOTES: 1. The DCO clock wake-up time is measured from the edge of an external wake-up signal (e.g., port interrupt) to the first clock edge observable externally on a clock pin (MCLK or SMCLK).  
2. Parameter applicable only if DCOCLK is used for MCLK.

**typical characteristics - DCO clock wake-up time from LPM3/4**



**Figure 13. Clock Wake-Up Time From LPM3 vs DCO Frequency**

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

## DCO with external resistor $R_{OSC}$ (see Note)

| PARAMETER      | TEST CONDITIONS                                                         | $V_{CC}$  | MIN | TYP       | MAX | UNIT                |
|----------------|-------------------------------------------------------------------------|-----------|-----|-----------|-----|---------------------|
| $f_{DCO,ROSC}$ | DCOR = 1,<br>RSELx = 4, DCOx = 3, MODx = 0,<br>$T_A = 25^\circ\text{C}$ | 2.2 V     |     | 1.8       |     | MHz                 |
|                |                                                                         | 3 V       |     | 1.95      |     |                     |
| $D_t$          | DCOR = 1,<br>RSELx = 4, DCOx = 3, MODx = 0                              | 2.2 V/3 V |     | $\pm 0.1$ |     | %/ $^\circ\text{C}$ |
| $D_V$          | DCOR = 1,<br>RSELx = 4, DCOx = 3, MODx = 0                              | 2.2 V/3 V |     | 10        |     | %/V                 |

NOTE:  $R_{OSC} = 100\text{ k}\Omega$ . Metal film resistor, type 0257. 0.6 W with 1% tolerance and  $T_K = \pm 50\text{ ppm}/^\circ\text{C}$ .

## typical characteristics - DCO with external resistor $R_{OSC}$

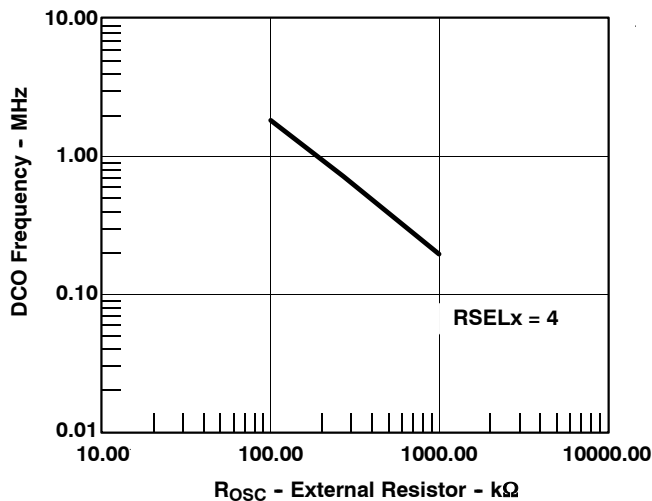


Figure 14. DCO Frequency vs  $R_{OSC}$ ,  
 $V_{CC} = 2.2\text{ V}$ ,  $T_A = 25^\circ\text{C}$

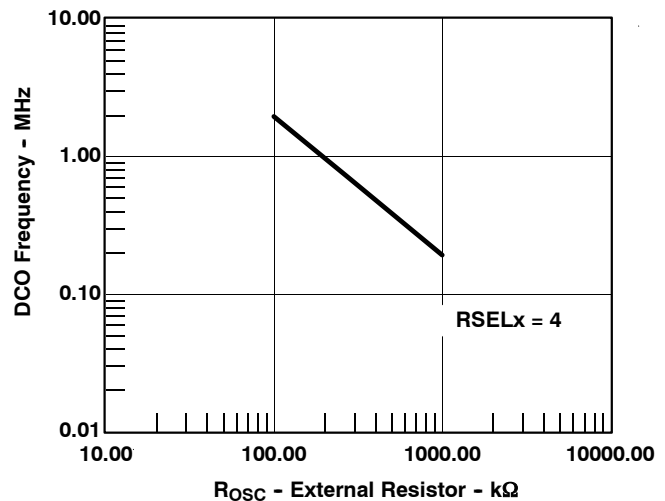


Figure 15. DCO Frequency vs  $R_{OSC}$ ,  
 $V_{CC} = 3\text{ V}$ ,  $T_A = 25^\circ\text{C}$

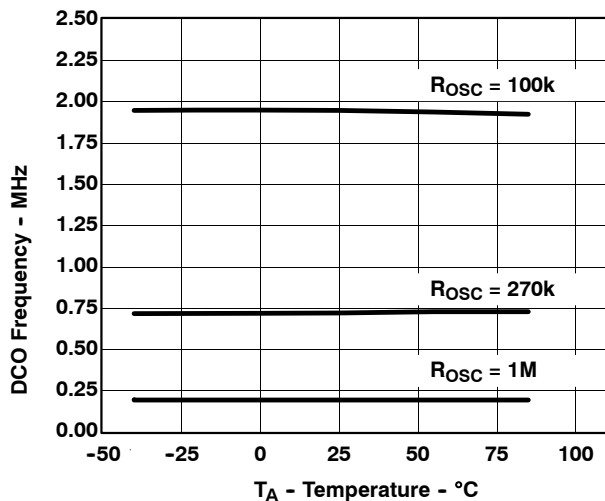


Figure 16. DCO Frequency vs Temperature,  
 $V_{CC} = 3\text{ V}$

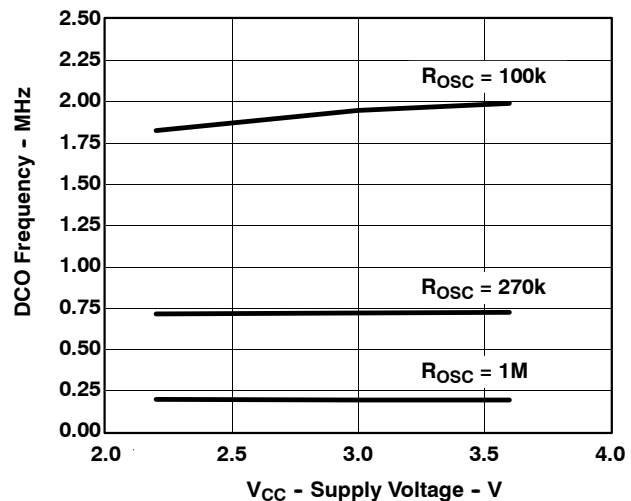


Figure 17. DCO Frequency vs  $V_{CC}$ ,  
 $T_A = 25^\circ\text{C}$

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**crystal oscillator, LFXT1, low frequency modes (see Note 4)**

| PARAMETER                   |                                                                   | TEST CONDITIONS                                                                      | V <sub>CC</sub> | MIN    | TYP    | MAX    | UNIT |
|-----------------------------|-------------------------------------------------------------------|--------------------------------------------------------------------------------------|-----------------|--------|--------|--------|------|
| f <sub>LFXT1,LF</sub>       | LFXT1 oscillator crystal frequency, LF mode 0, 1                  | XTS = 0, LFXT1Sx = 0 or 1                                                            | 1.8 V to 3.6 V  |        | 32,768 |        | Hz   |
| f <sub>LFXT1,LF,logic</sub> | LFXT1 oscillator logic level square wave input frequency, LF mode | XTS = 0, XCAPx = 0, LFXT1Sx = 3                                                      | 1.8 V to 3.6 V  | 10,000 | 32,768 | 50,000 | Hz   |
| OA <sub>LF</sub>            | Oscillation allowance for LF crystals                             | XTS = 0, LFXT1Sx = 0, f <sub>LFXT1,LF</sub> = 32,768 kHz, C <sub>L,eff</sub> = 6 pF  |                 |        | 500    |        | kΩ   |
|                             |                                                                   | XTS = 0, LFXT1Sx = 0, f <sub>LFXT1,LF</sub> = 32,768 kHz, C <sub>L,eff</sub> = 12 pF |                 |        | 200    |        |      |
| C <sub>L,eff</sub>          | Integrated effective load capacitance, LF mode (see Note 1)       | XTS = 0, XCAPx = 0                                                                   |                 |        | 1      |        | pF   |
|                             |                                                                   | XTS = 0, XCAPx = 1                                                                   |                 |        | 5.5    |        |      |
|                             |                                                                   | XTS = 0, XCAPx = 2                                                                   |                 |        | 8.5    |        |      |
|                             |                                                                   | XTS = 0, XCAPx = 3                                                                   |                 |        | 11     |        |      |
| Duty cycle                  | LF mode                                                           | XTS = 0, Measured at P2.0/ACLK, f <sub>LFXT1,LF</sub> = 32,768Hz                     | 2.2 V/3 V       | 30     | 50     | 70     | %    |
| f <sub>Fault,LF</sub>       | Oscillator fault frequency, LF mode (see Note 3)                  | XTS = 0, XCAPx = 0, LFXT1Sx = 3 (see Note 2)                                         | 2.2 V/3 V       | 10     |        | 10,000 | Hz   |

- NOTES: 1. Includes parasitic bond and package capacitance (approximately 2 pF per pin).  
 Since the PCB adds additional capacitance it is recommended to verify the correct load by measuring the ACLK frequency. For a correct setup the effective load capacitance should always match the specification of the used crystal.
2. Measured with logic level input frequency but also applies to operation with crystals.
3. Frequencies below the MIN specification set the fault flag, frequencies above the MAX specification do not set the fault flag, and frequencies in between might set the flag.
4. To improve EMI on the LFXT1 oscillator the following guidelines should be observed.
- Keep the trace between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins XIN and XOUT.
  - Avoid running PCB traces underneath or adjacent to the XIN and XOUT pins.
  - Use assembly materials and praxis to avoid any parasitic load on the oscillator XIN and XOUT pins.
  - If conformal coating is used, ensure that it does not induce capacitive/resistive leakage between the oscillator pins.
  - Do not route the XOUT line to the JTAG header to support the serial programming adapter as shown in other documentation. This signal is no longer required for the serial programming adapter.

**internal very low power, low frequency oscillator (VLO)**

| PARAMETER                           |                                    | TEST CONDITIONS                | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-------------------------------------|------------------------------------|--------------------------------|-----------------|-----|-----|-----|------|
| f <sub>VLO</sub>                    | VLO frequency                      | T <sub>A</sub> = -40°C to 85°C | 2.2 V/3 V       | 4   | 12  | 20  | kHz  |
|                                     |                                    | T <sub>A</sub> = 105°C         | 2.2 V/3 V       |     |     | 22  | kHz  |
| df <sub>VLO</sub> /dT               | VLO frequency temperature drift    | See Note 1                     | 2.2 V/3 V       |     | 0.5 |     | %/°C |
| df <sub>VLO</sub> /dV <sub>CC</sub> | VLO frequency supply voltage drift | See Note 2                     | 1.8V to 3.6V    |     | 4   |     | %/V  |

- NOTES: 1. Calculated using the box method:  
 I Version: (MAX(-40°C to 85°C) - MIN(-40°C to 85°C))/MIN(-40°C to 85°C)/(85°C - (-40°C))  
 T Version: (MAX(-40°C to 105\_C) - MIN(-40°C to 105\_C))/MIN(-40°C to 105\_C)/(105\_C - (-40\_C))
2. Calculated using the box method: (MAX(1.8 V to 3.6 V) - MIN(1.8 V to 3.6 V))/MIN(1.8 V to 3.6 V)/(3.6 V - 1.8 V)

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**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**crystal oscillator, LFXT1, high frequency modes (see Note 5)**

| PARAMETER                   |                                                                     | TEST CONDITIONS                                                                             | V <sub>CC</sub> | MIN | TYP  | MAX | UNIT |
|-----------------------------|---------------------------------------------------------------------|---------------------------------------------------------------------------------------------|-----------------|-----|------|-----|------|
| f <sub>LFXT1,HF0</sub>      | LFXT1 oscillator crystal frequency, HF mode 0                       | XTS = 1, XCAPx = 0, LFXT1Sx = 0                                                             | 1.8 V to 3.6 V  | 0.4 |      | 1   | MHz  |
| f <sub>LFXT1,HF1</sub>      | LFXT1 oscillator crystal frequency, HF mode 1                       | XTS = 1, XCAPx = 0, LFXT1Sx = 1                                                             | 1.8 V to 3.6 V  | 1   |      | 4   | MHz  |
| f <sub>LFXT1,HF2</sub>      | LFXT1 oscillator crystal frequency, HF mode 2                       | XTS = 1, XCAPx = 0, LFXT1Sx = 2                                                             | 1.8 V to 3.6 V  | 2   |      | 10  | MHz  |
|                             |                                                                     |                                                                                             | 2.2 V to 3.6 V  | 2   |      | 12  | MHz  |
|                             |                                                                     |                                                                                             | 3 V to 3.6 V    | 2   |      | 16  | MHz  |
| f <sub>LFXT1,HF,logic</sub> | LFXT1 oscillator logic level square wave input frequency, HF mode   | XTS = 1, XCAPx = 0, LFXT1Sx = 3                                                             | 1.8 V to 3.6 V  | 0.4 |      | 10  | MHz  |
|                             |                                                                     |                                                                                             | 2.2 V to 3.6 V  | 0.4 |      | 12  | MHz  |
|                             |                                                                     |                                                                                             | 3 V to 3.6 V    | 0.4 |      | 16  | MHz  |
| OA <sub>HF</sub>            | Oscillation allowance for HF crystals (see Figure 18 and Figure 19) | XTS = 1, XCAPx = 0, LFXT1Sx = 0, f <sub>LFXT1,HF</sub> = 1 MHz, C <sub>L,eff</sub> = 15 pF  |                 |     | 2700 |     | Ω    |
|                             |                                                                     | XTS = 1, XCAPx = 0, LFXT1Sx = 1, f <sub>LFXT1,HF</sub> = 4 MHz, C <sub>L,eff</sub> = 15 pF  |                 |     | 800  |     | Ω    |
|                             |                                                                     | XTS = 1, XCAPx = 0, LFXT1Sx = 2, f <sub>LFXT1,HF</sub> = 16 MHz, C <sub>L,eff</sub> = 15 pF |                 |     | 300  |     | Ω    |
| C <sub>L,eff</sub>          | Integrated effective load capacitance, HF mode (see Note 1)         | XTS = 1, XCAPx = 0 (see Note 2)                                                             |                 |     | 1    |     | pF   |
| Duty cycle                  | HF mode                                                             | XTS = 1, XCAPx = 0, Measured at P2.0/ACLK, f <sub>LFXT1,HF</sub> = 10 MHz                   | 2.2 V/3 V       | 40  | 50   | 60  | %    |
|                             |                                                                     | XTS = 1, XCAPx = 0, Measured at P2.0/ACLK, f <sub>LFXT1,HF</sub> = 16 MHz                   | 2.2 V/3 V       | 40  | 50   | 60  | %    |
| f <sub>Fault,HF</sub>       | Oscillator fault frequency, HF mode (see Note 4)                    | XTS = 1, XCAPx = 0, LFXT1Sx = 3 (see Notes 3)                                               | 2.2 V/3 V       | 30  |      | 300 | kHz  |

- NOTES: 1. Includes parasitic bond and package capacitance (approximately 2 pF per pin). Since the PCB adds additional capacitance it is recommended to verify the correct load by measuring the ACLK frequency. For a correct setup the effective load capacitance should always match the specification of the used crystal.
2. Requires external capacitors at both terminals. Values are specified by crystal manufacturers.
3. Measured with logic level input frequency but also applies to operation with crystals.
4. Frequencies below the MIN specification set the fault flag, frequencies above the MAX specification do not set the fault flag, and frequencies in between might set the flag.
5. To improve EMI on the LFXT1 oscillator the following guidelines should be observed.
- Keep the trace between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins XIN and XOUT.
  - Avoid running PCB traces underneath or adjacent to the XIN and XOUT pins.
  - Use assembly materials and praxis to avoid any parasitic load on the oscillator XIN and XOUT pins.
  - If conformal coating is used, ensure that it does not induce capacitive/resistive leakage between the oscillator pins.
  - Do not route the XOUT line to the JTAG header to support the serial programming adapter as shown in other documentation. This signal is no longer required for the serial programming adapter.



electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

typical characteristics - LFXT1 oscillator in HF mode (XTS = 1)

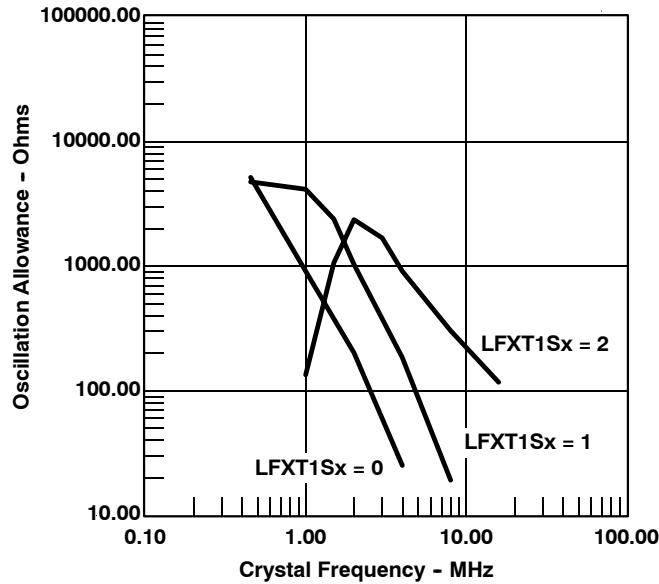


Figure 18. Oscillation Allowance vs Crystal Frequency,  $C_{L,eff} = 15 \text{ pF}$ ,  $T_A = 25^\circ\text{C}$

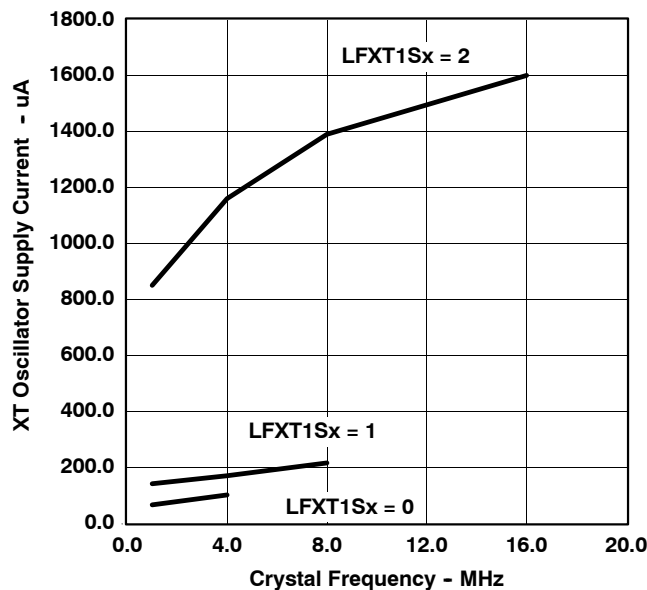


Figure 19. XT Oscillator Supply Current vs Crystal Frequency,  $C_{L,eff} = 15 \text{ pF}$ ,  $T_A = 25^\circ\text{C}$

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

## Timer0\_A3

| PARAMETER           |                           | TEST CONDITIONS                                                             | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|---------------------|---------------------------|-----------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>TA</sub>     | Timer0_A3 clock frequency | Internal: SMCLK, ACLK,<br>External: TACLK, INCLK,<br>Duty cycle = 50% ± 10% | 2.2 V           |     |     | 10  | MHz  |
|                     |                           |                                                                             | 3 V             |     |     | 16  |      |
| t <sub>TA,cap</sub> | Timer0_A3, capture timing | TA0.0, TA0.1, TA0.2                                                         | 2.2 V/3 V       | 20  |     |     | ns   |

## Timer1\_A2

| PARAMETER           |                           | TEST CONDITIONS                                                             | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|---------------------|---------------------------|-----------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>TB</sub>     | Timer1_A2 clock frequency | Internal: SMCLK, ACLK,<br>External: TACLK, INCLK,<br>Duty cycle = 50% ± 10% | 2.2 V           |     |     | 10  | MHz  |
|                     |                           |                                                                             | 3 V             |     |     | 16  |      |
| t <sub>TB,cap</sub> | Timer1_A2, capture timing | TA1.0, TA1.1                                                                | 2.2 V/3 V       | 20  |     |     | ns   |



**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**USCI (UART mode)**

| PARAMETER               |                                                                              | TEST CONDITIONS                                                     | V <sub>CC</sub> | MIN | TYP                 | MAX | UNIT |
|-------------------------|------------------------------------------------------------------------------|---------------------------------------------------------------------|-----------------|-----|---------------------|-----|------|
| f <sub>USCI</sub>       | USCI input clock frequency                                                   | Internal: SMCLK, ACLK,<br>External: UCLK,<br>Duty cycle = 50% ± 10% |                 |     | f <sub>SYSTEM</sub> |     | MHz  |
| f <sub>max,BITCLK</sub> | Maximum BITCLK clock frequency<br>(equals baudrate in MBaud) (see<br>Note 1) |                                                                     | 2.2V / 3 V      | 2   |                     |     | MHz  |
| t <sub>t</sub>          | UART receive deglitch time<br>(see Note 2)                                   |                                                                     | 2.2 V           | 50  | 150                 |     | ns   |
|                         |                                                                              |                                                                     | 3 V             | 50  | 100                 |     | ns   |

- NOTES: 1. The DCO wake-up time must be considered in LPM3/4 for baudrates above 1 MHz.  
2. Pulses on the UART receive input (UCxRX) shorter than the UART receive deglitch time are suppressed. To ensure that pulses are correctly recognized their width should exceed the maximum specification of the deglitch time.

**USCI (SPI master mode) (see Figure 20 and Figure 21)**

| PARAMETER             |                             | TEST CONDITIONS                                    | V <sub>CC</sub> | MIN | TYP                 | MAX | UNIT |
|-----------------------|-----------------------------|----------------------------------------------------|-----------------|-----|---------------------|-----|------|
| f <sub>USCI</sub>     | USCI input clock frequency  | SMCLK, ACLK,<br>Duty cycle = 50% ± 10%             |                 |     | f <sub>SYSTEM</sub> |     | MHz  |
| t <sub>SU,MI</sub>    | SOMI input data setup time  |                                                    | 2.2 V           | 110 |                     |     | ns   |
|                       |                             |                                                    | 3 V             | 75  |                     |     | ns   |
| t <sub>HD,MI</sub>    | SOMI input data hold time   |                                                    | 2.2 V           | 0   |                     |     | ns   |
|                       |                             |                                                    | 3 V             | 0   |                     |     | ns   |
| t <sub>VALID,MO</sub> | SIMO output data valid time | UCLK edge to SIMO valid,<br>C <sub>L</sub> = 20 pF | 2.2 V           |     |                     | 30  | ns   |
|                       |                             |                                                    | 3 V             |     |                     | 20  | ns   |

NOTE:  $f_{UCxCLK} = \frac{1}{2t_{LO/Hi}}$  with  $t_{LO/Hi} \geq \max(t_{VALID,MO(USCI)} + t_{SU,SI(Slave)}, t_{SU,MI(USCI)} + t_{VALID,SO(Slave)})$ .

For the slave parameters t<sub>SU,SI(Slave)</sub> and t<sub>VALID,SO(Slave)</sub>, see the SPI parameters of the attached slave.

**USCI (SPI slave mode) (see Figure 22 and Figure 23)**

| PARAMETER             |                                                      | TEST CONDITIONS                                    | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------|------------------------------------------------------|----------------------------------------------------|-----------------|-----|-----|-----|------|
| t <sub>STE,LEAD</sub> | STE lead time,<br>STE low to clock                   |                                                    | 2.2 V/3 V       |     | 50  |     | ns   |
| t <sub>STE,LAG</sub>  | STE lag time,<br>Last clock to STE high              |                                                    | 2.2 V/3 V       | 10  |     |     | ns   |
| t <sub>STE,ACC</sub>  | STE access time,<br>STE low to SOMI data out         |                                                    | 2.2 V/3 V       |     | 50  |     | ns   |
| t <sub>STE,DIS</sub>  | STE disable time,<br>STE high to SOMI high impedance |                                                    | 2.2 V/3 V       |     | 50  |     | ns   |
| t <sub>SU,SI</sub>    | SIMO input data setup time                           |                                                    | 2.2 V           | 20  |     |     | ns   |
|                       |                                                      |                                                    | 3 V             | 15  |     |     | ns   |
| t <sub>HD,SI</sub>    | SIMO input data hold time                            |                                                    | 2.2 V           | 10  |     |     | ns   |
|                       |                                                      |                                                    | 3 V             | 10  |     |     | ns   |
| t <sub>VALID,SO</sub> | SOMI output data valid time                          | UCLK edge to SOMI valid,<br>C <sub>L</sub> = 20 pF | 2.2 V           |     | 75  | 110 | ns   |
|                       |                                                      |                                                    | 3 V             |     | 50  | 75  | ns   |

NOTE:  $f_{UCxCLK} = \frac{1}{2t_{LO/Hi}}$  with  $t_{LO/Hi} \geq \max(t_{VALID,MO(Master)} + t_{SU,SI(USCI)}, t_{SU,MI(Master)} + t_{VALID,SO(USCI)})$ .

For the master's parameters t<sub>SU,MI(Master)</sub> and t<sub>VALID,MO(Master)</sub> refer to the SPI parameters of the attached master.

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

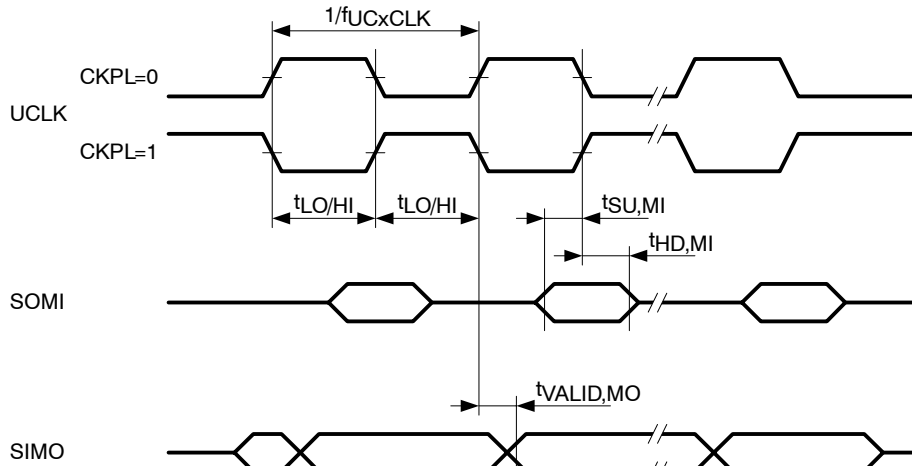


Figure 20. SPI Master Mode, CKPH = 0

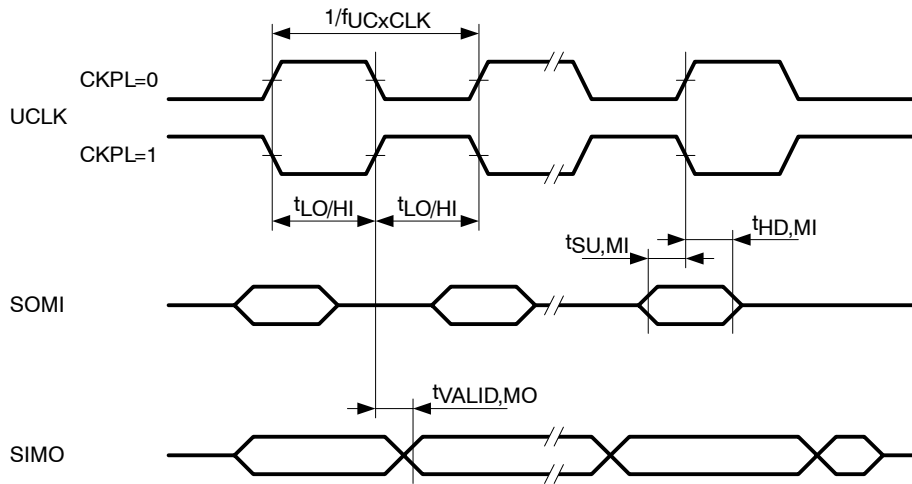


Figure 21. SPI Master Mode, CKPH = 1



electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

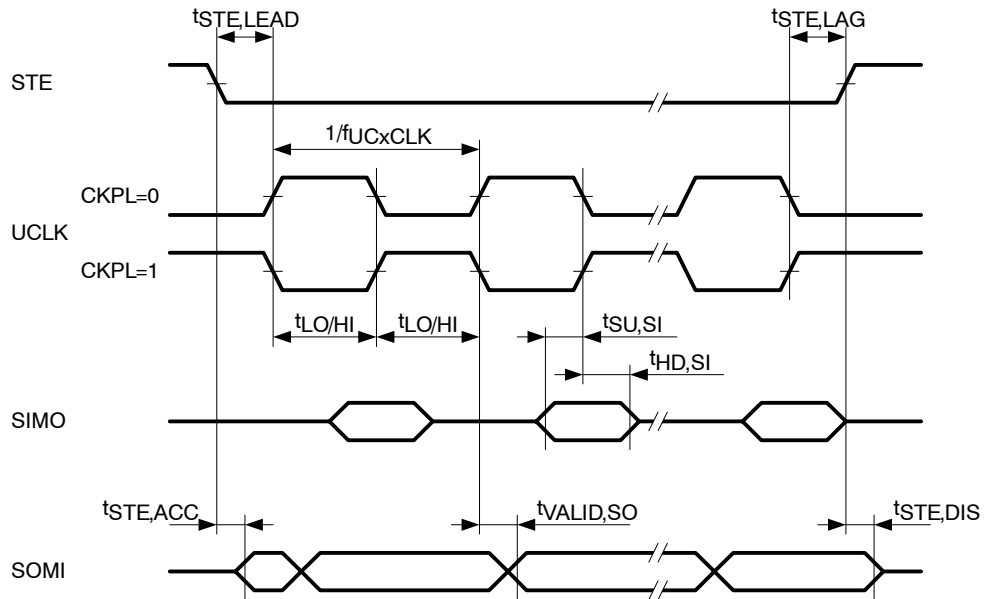


Figure 22. SPI Slave Mode, CKPH = 0

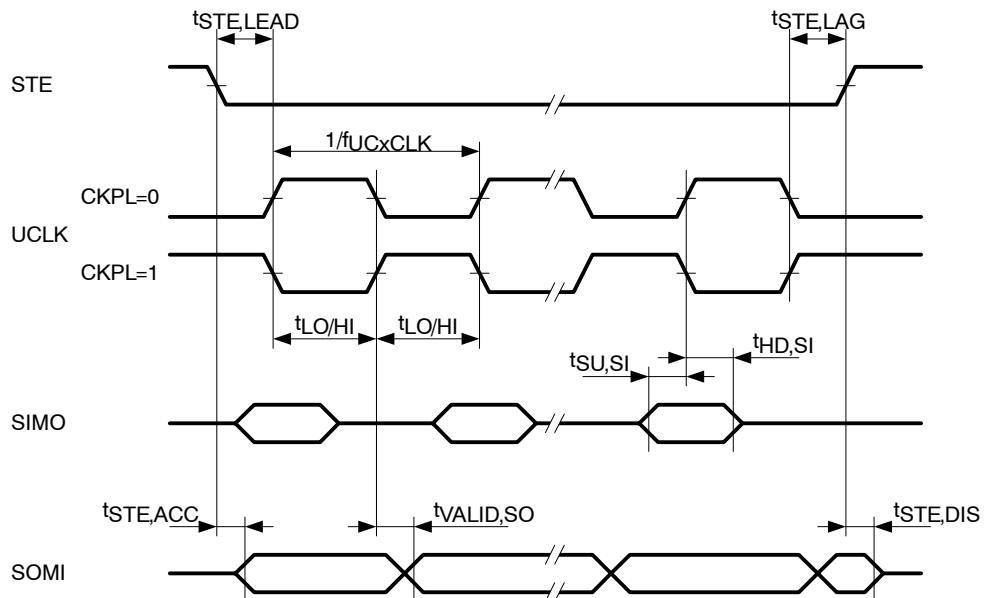


Figure 23. SPI Slave Mode, CKPH = 1

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## USCI (I2C mode) (see Figure 24)

| PARAMETER           | TEST CONDITIONS                                  | V <sub>CC</sub>           | MIN       | TYP                 | MAX | UNIT |
|---------------------|--------------------------------------------------|---------------------------|-----------|---------------------|-----|------|
| f <sub>USCI</sub>   | USCI input clock frequency                       |                           |           | f <sub>SYSTEM</sub> |     | MHz  |
| f <sub>SCL</sub>    | SCL clock frequency                              | 2.2 V/3 V                 | 0         |                     | 400 | kHz  |
| t <sub>HD,STA</sub> | Hold time (repeated) start                       | f <sub>SCL</sub> ≤ 100kHz | 2.2 V/3 V | 4.0                 |     | us   |
|                     |                                                  | f <sub>SCL</sub> > 100kHz | 2.2 V/3 V | 0.6                 |     | us   |
| t <sub>SU,STA</sub> | Setup time for a repeated start                  | f <sub>SCL</sub> ≤ 100kHz | 2.2 V/3 V | 4.7                 |     | us   |
|                     |                                                  | f <sub>SCL</sub> > 100kHz | 2.2 V/3 V | 0.6                 |     | us   |
| t <sub>HD,DAT</sub> | Data hold time                                   | 2.2 V/3 V                 | 0         |                     |     | ns   |
| t <sub>SU,DAT</sub> | Data setup time                                  | 2.2 V/3 V                 | 250       |                     |     | ns   |
| t <sub>SU,STO</sub> | Setup time for stop                              | 2.2 V/3 V                 | 4.0       |                     |     | us   |
| t <sub>SP</sub>     | Pulse width of spikes suppressed by input filter | 2.2 V                     | 50        | 150                 | 600 | ns   |
|                     |                                                  | 3 V                       | 50        | 100                 | 600 | ns   |

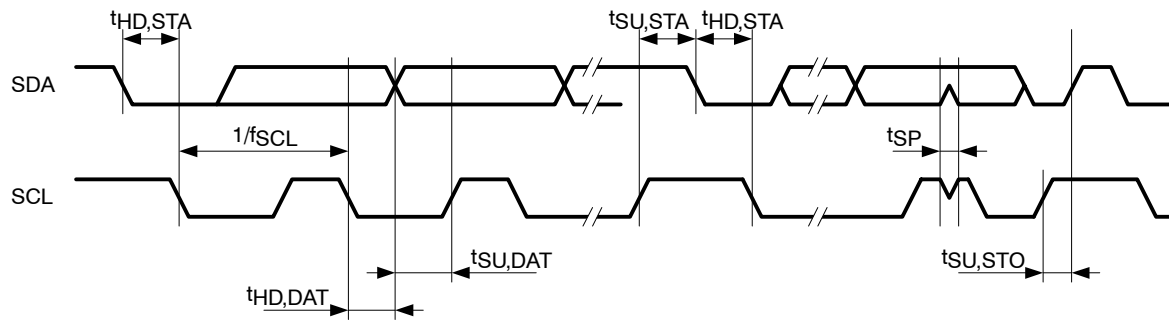


Figure 24. I2C Mode Timing

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**Comparator\_A+ (see Note 1)**

| PARAMETER                         |                                                                | TEST CONDITIONS                                                                                             | V <sub>CC</sub> | MIN  | TYP  | MAX                | UNIT |
|-----------------------------------|----------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|-----------------|------|------|--------------------|------|
| I <sub>(DD)</sub>                 |                                                                | CAON = 1, CARSEL = 0, CAREF = 0                                                                             | 2.2 V           |      | 25   | 40                 | μA   |
|                                   |                                                                |                                                                                                             | 3 V             |      | 45   | 60                 |      |
| I <sub>(RefLadder/RefDiode)</sub> |                                                                | CAON = 1, CARSEL = 0,<br>CAREF = 1/2/3,<br>No load at P1.0/CA0 and P1.1/CA1                                 | 2.2 V           |      | 30   | 50                 | μA   |
|                                   |                                                                |                                                                                                             | 3 V             |      | 45   | 71                 |      |
| V <sub>(IC)</sub>                 | Common-mode input voltage                                      | CAON = 1                                                                                                    | 2.2 V/3 V       | 0    |      | V <sub>CC</sub> -1 | V    |
| V <sub>(Ref025)</sub>             | $\frac{\text{Voltage @ } 0.25 V_{CC} \text{ node}}{V_{CC}}$    | PCA0 = 1, CARSEL = 1, CAREF = 1,<br>No load at P1.0/CA0 and P1.1/CA1                                        | 2.2 V/3 V       | 0.23 | 0.24 | 0.25               |      |
| V <sub>(Ref050)</sub>             | $\frac{\text{Voltage @ } 0.5V_{CC} \text{ node}}{V_{CC}}$      | PCA0 = 1, CARSEL = 1, CAREF = 2,<br>No load at P1.0/CA0 and P1.1/CA1                                        | 2.2 V/3 V       | 0.47 | 0.48 | 0.5                |      |
| V <sub>(RefVT)</sub>              | See Figure 28 and Figure 29                                    | PCA0 = 1, CARSEL = 1, CAREF = 3,<br>No load at P1.0/CA0 and P1.1/CA1,<br>T <sub>A</sub> = 85°C              | 2.2 V           | 390  | 480  | 540                | mV   |
|                                   |                                                                |                                                                                                             | 3 V             | 400  | 490  | 550                |      |
| V <sub>(offset)</sub>             | Offset voltage                                                 | See Note 2                                                                                                  | 2.2 V/3 V       | -30  |      | 30                 | mV   |
| V <sub>(hys)</sub>                | Input hysteresis                                               | CAON = 1                                                                                                    | 2.2 V/3 V       | 0    | 0.7  | 1.4                | mV   |
| t <sub>(response)</sub>           | Response time<br>(low to high and high to low)<br>(see Note 3) | T <sub>A</sub> = 25°C, Overdrive 10 mV,<br>Without filter: CAF = 0<br>(see Note 3, Figure 25 and Figure 26) | 2.2 V           | 80   | 165  | 300                | ns   |
|                                   |                                                                |                                                                                                             | 3 V             | 70   | 120  | 240                |      |
|                                   |                                                                | T <sub>A</sub> = 25°C, Overdrive 10 mV,<br>With filter: CAF = 1<br>(see Note 3, Figure 25 and Figure 26)    | 2.2 V           | 1.4  | 1.9  | 2.8                | μs   |
|                                   |                                                                |                                                                                                             | 3 V             | 0.9  | 1.5  | 2.2                |      |

- NOTES: 1. The leakage current for the Comparator\_A+ terminals is identical to I<sub>lkg(Px.x)</sub> specification.  
 2. The input offset voltage can be cancelled by using the CAEX bit to invert the Comparator\_A+ inputs on successive measurements. The two successive measurements are then summed together.  
 3. Response time measured at P2.2/TA0.0/A2/CA4/CAOUT. If the Comparator\_A+ is enabled a settling time of 60 ns (typical) is added to the response time.

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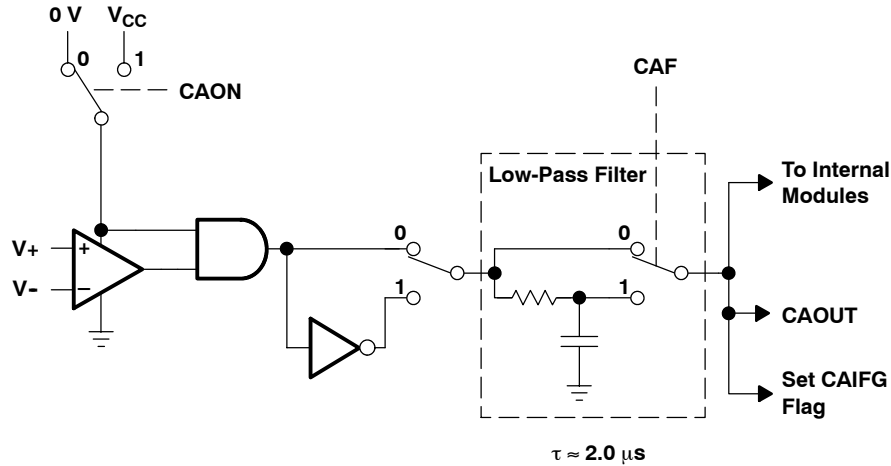


Figure 25. Block Diagram of Comparator\_A+ Module

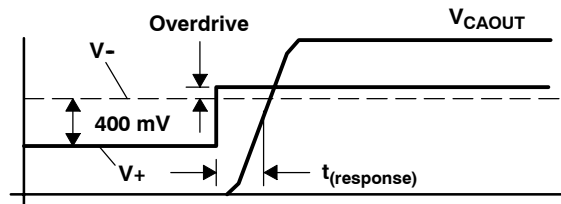


Figure 26. Overdrive Definition

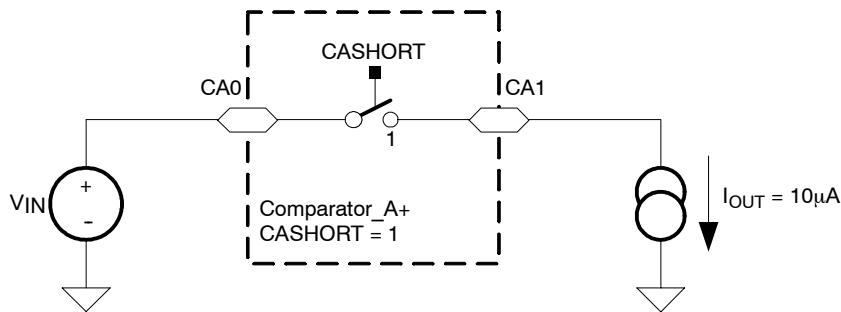


Figure 27. Comparator\_A+ Short Resistance Test Condition

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

typical characteristics - Comparator\_A+

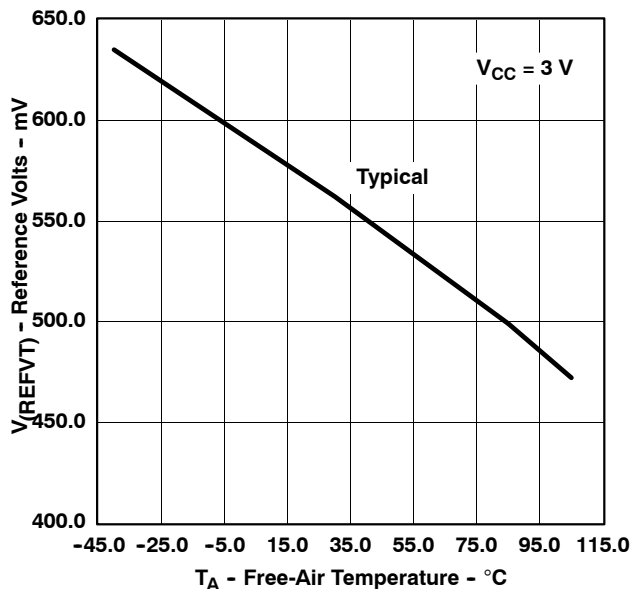


Figure 28.  $V_{(REFVT)}$  vs Temperature,  $V_{CC} = 3\text{ V}$

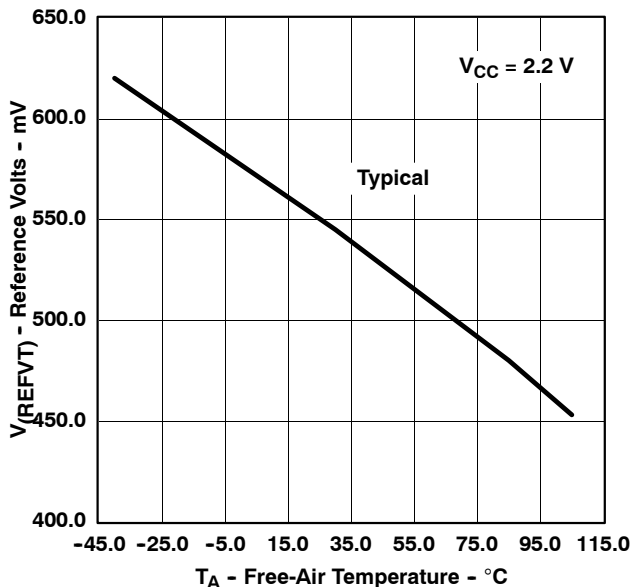


Figure 29.  $V_{(REFVT)}$  vs Temperature,  $V_{CC} = 2.2\text{ V}$

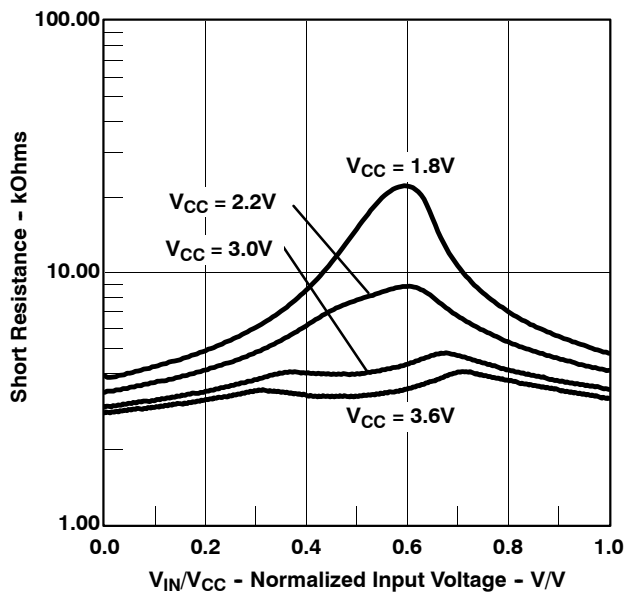


Figure 30. Short Resistance vs  $V_{IN}/V_{CC}$

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

## 10-bit ADC, power supply and input range conditions (see Note 1)

| PARAMETER           | TEST CONDITIONS                                                  | T <sub>A</sub>                                                                                    | V <sub>CC</sub>                       | MIN       | TYP  | MAX             | UNIT |
|---------------------|------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|---------------------------------------|-----------|------|-----------------|------|
| V <sub>CC</sub>     | Analog supply voltage range                                      | V <sub>SS</sub> = 0 V                                                                             |                                       | 2.2       |      | 3.6             | V    |
| V <sub>AX</sub>     | Analog input voltage range (see Note 2)                          | All A <sub>x</sub> terminals, Analog inputs selected in ADC10AE register                          |                                       | 0         |      | V <sub>CC</sub> | V    |
| I <sub>ADC10</sub>  | ADC10 supply current (see Note 3)                                | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, ADC10SHT0 = 1, ADC10SHT1 = 0, ADC10DIV = 0 | I: -40°C to 85°C<br>T: -40°C to 105°C | 2.2 V     | 0.52 | 1.05            | mA   |
|                     |                                                                  |                                                                                                   |                                       | 3 V       | 0.6  | 1.2             |      |
| I <sub>REF+</sub>   | Reference supply current, reference buffer disabled (see Note 4) | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 0, REF2_5V = 0, REFON = 1, REFOUT = 0                    | I: -40°C to 85°C<br>T: -40°C to 105°C | 2.2 V/3 V | 0.25 | 0.4             | mA   |
|                     |                                                                  |                                                                                                   | I: -40°C to 85°C<br>T: -40°C to 105°C | 3 V       |      |                 | mA   |
| I <sub>REFB,0</sub> | Reference buffer supply current with ADC10SR = 0 (see Note 4)    | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 0, REFON = 1, REF2_5V = 0, REFOUT = 1, ADC10SR = 0       | -40°C to 85°C                         | 2.2 V/3 V | 1.1  | 1.4             | mA   |
|                     |                                                                  |                                                                                                   | 105°C                                 | 2.2 V/3 V |      | 1.8             | mA   |
| I <sub>REFB,1</sub> | Reference buffer supply current with ADC10SR = 1 (see Note 4)    | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 0, REFON = 1, REF2_5V = 0, REFOUT = 1, ADC10SR = 1       | -40°C to 85°C                         | 2.2 V/3 V | 0.5  | 0.7             | mA   |
|                     |                                                                  |                                                                                                   | 105°C                                 | 2.2 V/3 V |      | 0.8             | mA   |
| C <sub>I</sub>      | Input capacitance                                                | Only one terminal A <sub>x</sub> selected at a time                                               | I: -40°C to 85°C<br>T: -40°C to 105°C |           |      | 27              | pF   |
| R <sub>I</sub>      | Input MUX ON resistance                                          | 0V ≤ V <sub>AX</sub> ≤ V <sub>CC</sub>                                                            | I: -40°C to 85°C<br>T: -40°C to 105°C | 2.2 V/3 V |      | 2000            | Ω    |

- NOTES: 1. The leakage current is defined in the leakage current table with P<sub>x.x</sub>/A<sub>x</sub> parameter.  
 2. The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results.  
 3. The internal reference supply current is not included in current consumption parameter I<sub>ADC10</sub>.  
 4. The internal reference current is supplied via terminal V<sub>CC</sub>. Consumption is independent of the ADC10ON control bit, unless a conversion is active. The REFON bit enables the built-in reference to settle before starting an A/D conversion.



**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**10-bit ADC, built-in voltage reference**

| PARAMETER                                       | TEST CONDITIONS                                                                                                      | T <sub>A</sub>                                                    | V <sub>CC</sub> | MIN           | TYP  | MAX  | UNIT |        |
|-------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|-----------------|---------------|------|------|------|--------|
| V <sub>CC,REF+</sub>                            | Positive built-in reference analog supply voltage range                                                              |                                                                   |                 | 2.2           |      |      | V    |        |
|                                                 |                                                                                                                      |                                                                   |                 | 2.8           |      |      |      |        |
|                                                 |                                                                                                                      |                                                                   |                 | 2.9           |      |      |      |        |
| V <sub>REF+</sub>                               | Positive built-in reference voltage                                                                                  |                                                                   | 2.2 V/<br>3 V   | 1.41          | 1.5  | 1.59 | V    |        |
|                                                 |                                                                                                                      |                                                                   |                 | 2.35          | 2.5  | 2.65 | V    |        |
| I <sub>LD,VREF+</sub>                           | Maximum V <sub>REF+</sub> load current                                                                               |                                                                   | 2.2 V<br>3 V    | ±0.5          |      |      | mA   |        |
|                                                 |                                                                                                                      |                                                                   |                 | ±1            |      |      |      |        |
| V <sub>REF+</sub> load regulation               |                                                                                                                      |                                                                   | 2.2 V/<br>3 V   | ±2            |      |      | LSB  |        |
|                                                 |                                                                                                                      |                                                                   |                 | ±2            |      |      |      |        |
| V <sub>REF+</sub> load regulation response time | I <sub>VREF+</sub> = 100 μA → 900 μA, V <sub>AX</sub> ≈ 0.5 × V <sub>REF+</sub> , Error of conversion result ≤ 1 LSB | ADC10SR = 0                                                       | 3 V             | 400           |      |      | ns   |        |
|                                                 |                                                                                                                      | ADC10SR = 1                                                       | 3V              | 2000          |      |      |      |        |
| C <sub>VREF+</sub>                              | Max. capacitance at pin V <sub>REF+</sub> (see Note 1)                                                               |                                                                   | 2.2 V/<br>3 V   | 100           |      |      | pF   |        |
| TC <sub>REF+</sub>                              | Temperature coefficient                                                                                              |                                                                   | -40°C to 85°C   | 2.2 V/<br>3 V | ±100 |      |      | ppm/°C |
|                                                 |                                                                                                                      |                                                                   | 85°C to 105°C   | 2.2 V/<br>3 V | ±110 |      |      | ppm/°C |
| t <sub>REFON</sub>                              | Settling time of internal reference voltage (see Note 2)                                                             |                                                                   | 3.6 V           | 30            |      |      | μs   |        |
| t <sub>REFBURST</sub>                           | Settling time of reference buffer (see Note 2)                                                                       | I <sub>VREF+</sub> = 0.5 mA, REF2_5V = 0, REFON = 1, REFBURST = 1 | ADC10SR = 0     | 2.2 V         | 1    |      |      | μs     |
|                                                 |                                                                                                                      |                                                                   | ADC10SR = 1     | 2.2 V         | 2.5  |      |      |        |
|                                                 |                                                                                                                      | I <sub>VREF+</sub> = 0.5 mA, REF2_5V = 1, REFON = 1, REFBURST = 1 | ADC10SR = 0     | 3 V           | 2    |      |      | μs     |
|                                                 |                                                                                                                      |                                                                   | ADC10SR = 1     | 3 V           | 4.5  |      |      |        |

- NOTES: 1. The capacitance applied to the internal buffer operational amplifier, if switched to terminal P2.4/TA2/A4/V<sub>REF+</sub>/V<sub>eREF+</sub> (REFOUT = 1), must be limited; the reference buffer may become unstable, otherwise.  
 2. The condition is that the error in a conversion started after t<sub>REFON</sub> or t<sub>RefBuf</sub> is less than ±0.5 LSB.  
 3. Calculated using the box method: ((MAX(V<sub>REF</sub>(T)) - MIN(V<sub>REF</sub>(T))) / MIN(V<sub>REF</sub>(T))) / (T<sub>MAX</sub> - T<sub>MIN</sub>)

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**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

## 10-bit ADC, external reference (see Note 1)

| PARAMETER           |                                                                                                                     | TEST CONDITIONS                                                                                           | V <sub>CC</sub> | MIN | TYP | MAX             | UNIT |
|---------------------|---------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----------------|------|
| V <sub>eREF+</sub>  | Positive external reference input voltage range (see Note 2)                                                        | V <sub>eREF+</sub> > V <sub>eREF-</sub> ,<br>SREF1 = 1, SREF0 = 0                                         |                 | 1.4 |     | V <sub>CC</sub> | V    |
|                     |                                                                                                                     | V <sub>eREF-</sub> ≤ V <sub>eREF+</sub> ≤ (V <sub>CC</sub> - 0.15 V)<br>SREF1 = 1, SREF0 = 1 (see Note 3) |                 | 1.4 |     | 3.0             |      |
| V <sub>eREF-</sub>  | Negative external reference input voltage range (see Note 4)                                                        | V <sub>eREF+</sub> > V <sub>eREF-</sub>                                                                   |                 | 0   |     | 1.2             | V    |
| ΔV <sub>eREF</sub>  | Differential external reference input voltage range<br>ΔV <sub>eREF</sub> = V <sub>eREF+</sub> - V <sub>eREF-</sub> | V <sub>eREF+</sub> > V <sub>eREF-</sub> (see Note 5)                                                      |                 | 1.4 |     | V <sub>CC</sub> | V    |
| I <sub>VeREF+</sub> | Static input current into V <sub>eREF+</sub>                                                                        | 0V ≤ V <sub>eREF+</sub> ≤ V <sub>CC</sub> ,<br>SREF1 = 1, SREF0 = 0                                       | 2.2 V/3 V       |     |     | ±1              | μA   |
|                     |                                                                                                                     | 0V ≤ V <sub>eREF+</sub> ≤ (V <sub>CC</sub> - 0.15 V) ≤ 3 V,<br>SREF1 = 1, SREF0 = 1 (see Note 3)          | 2.2 V/3 V       |     |     | 0               |      |
| I <sub>VeREF-</sub> | Static input current into V <sub>eREF-</sub>                                                                        | 0V ≤ V <sub>eREF-</sub> ≤ V <sub>CC</sub>                                                                 | 2.2 V/3 V       |     |     | ±1              | μA   |

- NOTES: 1. The external reference is used during conversion to charge and discharge the capacitance array. The input capacitance, C<sub>I</sub>, is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 10-bit accuracy.
2. The accuracy limits the minimum positive external reference voltage. Lower reference voltage levels may be applied with reduced accuracy requirements.
3. Under this condition the external reference is internally buffered. The reference buffer is active and requires the reference buffer supply current I<sub>REFB</sub>. The current consumption can be limited to the sample and conversion period with REBURST = 1.
4. The accuracy limits the maximum negative external reference voltage. Higher reference voltage levels may be applied with reduced accuracy requirements.
5. The accuracy limits the minimum external differential reference voltage. Lower differential reference voltage levels may be applied with reduced accuracy requirements.



**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**10-bit ADC, timing parameters**

| PARAMETER             |                                     | TEST CONDITIONS                                                                            | V <sub>CC</sub> | MIN       | TYP                                         | MAX  | UNIT |
|-----------------------|-------------------------------------|--------------------------------------------------------------------------------------------|-----------------|-----------|---------------------------------------------|------|------|
| f <sub>ADC10CLK</sub> | ADC10 input clock frequency         | For specified performance of ADC10 linearity parameters                                    | ADC10SR = 0     | 2.2 V/3 V | 0.45                                        | 6.3  | MHz  |
|                       |                                     |                                                                                            | ADC10SR = 1     | 2.2 V/3 V | 0.45                                        | 1.5  |      |
| f <sub>ADC10OSC</sub> | ADC10 built-in oscillator frequency | ADC10DIVx = 0, ADC10SSELx = 0<br>f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub>             | 2.2 V/3 V       | 3.7       |                                             | 6.3  | MHz  |
| t <sub>CONVERT</sub>  | Conversion time                     | ADC10 built-in oscillator, ADC10SSELx = 0<br>f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub> | 2.2 V/3 V       | 2.06      |                                             | 3.51 | μs   |
|                       |                                     | f <sub>ADC10CLK</sub> from ACLK, MCLK or SMCLK: ADC10SSELx ≠ 0                             |                 |           | 13×<br>ADC10DIVx<br>1/f <sub>ADC10CLK</sub> |      | μs   |
| t <sub>ADC10ON</sub>  | Turn on settling time of the ADC    | See Note 1                                                                                 |                 |           |                                             | 100  | ns   |

NOTE 1: The condition is that the error in a conversion started after t<sub>ADC10ON</sub> is less than ±0.5 LSB. The reference and input signals are already settled.

**10-bit ADC, linearity parameters**

| PARAMETER      | TEST CONDITIONS              | V <sub>CC</sub>                                                                   | MIN   | TYP | MAX  | UNIT |     |
|----------------|------------------------------|-----------------------------------------------------------------------------------|-------|-----|------|------|-----|
| E <sub>I</sub> | Integral linearity error     | 2.2 V/3 V                                                                         |       |     | ±1   | LSB  |     |
| E <sub>D</sub> | Differential linearity error | 2.2 V/3 V                                                                         |       |     | ±1   | LSB  |     |
| E <sub>O</sub> | Offset error                 | Source impedance R <sub>S</sub> < 100 Ω<br>2.2 V/3 V                              |       |     | ±1   | LSB  |     |
| E <sub>G</sub> | Gain error                   | SREFx = 010, Unbuffered external reference; V <sub>eREF+</sub> = 1.5 V            | 2.2 V |     | ±1.1 | ±2   | LSB |
|                |                              | SREFx = 010, Unbuffered external reference; V <sub>eREF+</sub> = 2.5 V            | 3 V   |     | ±1.1 | ±2   | LSB |
|                |                              | SREFx = 011, Buffered external reference (see Note 2), V <sub>eREF+</sub> = 1.5 V | 2.2 V |     | ±1.1 | ±4   | LSB |
|                |                              | SREFx = 011, Buffered external reference (see Note 2), V <sub>eREF+</sub> = 2.5 V | 3 V   |     | ±1.1 | ±3   | LSB |
| E <sub>T</sub> | Total unadjusted error       | SREFx = 010, Unbuffered external reference; V <sub>eREF+</sub> = 1.5 V            | 2.2 V |     | ±2   | ±5   | LSB |
|                |                              | SREFx = 010, Unbuffered external reference; V <sub>eREF+</sub> = 2.5 V            | 3 V   |     | ±2   | ±5   | LSB |
|                |                              | SREFx = 011, Buffered external reference (see Note 2), V <sub>eREF+</sub> = 1.5 V | 2.2 V |     | ±2   | ±7   | LSB |
|                |                              | SREFx = 011, Buffered external reference (see Note 2), V <sub>eREF+</sub> = 2.5 V | 3 V   |     | ±2   | ±6   | LSB |

NOTE 2: The reference buffer's offset adds to the gain and total unadjusted error.

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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

## 10-bit ADC, temperature sensor and built-in $V_{MID}$

| PARAMETER            |                                                             | TEST CONDITIONS                                                          | $V_{CC}$  | MIN  | TYP  | MAX  | UNIT                       |
|----------------------|-------------------------------------------------------------|--------------------------------------------------------------------------|-----------|------|------|------|----------------------------|
| $I_{SENSOR}$         | Temperature sensor supply current (see Note 1)              | REFON = 0, INCHx = 0Ah, ADC10ON = 1, $T_A = 25^\circ\text{C}$            | 2.2 V     |      | 40   | 120  | $\mu\text{A}$              |
|                      |                                                             |                                                                          | 3 V       |      | 60   | 160  |                            |
| $TC_{SENSOR}$        |                                                             | ADC10ON = 1, INCHx = 0Ah (see Note 2)                                    | 2.2 V/3 V |      | 3.55 |      | $\text{mV}/^\circ\text{C}$ |
| $V_{Offset, Sensor}$ | Sensor offset voltage                                       | ADC10ON = 1, INCHx = 0Ah (see Note 2)                                    |           | -100 |      | 100  | mV                         |
| $V_{Sensor}$         | Sensor output voltage (see Note 3)                          | Temperature sensor voltage at $T_A = 105^\circ\text{C}$ (T version only) | 2.2 V/3 V | 1265 | 1365 | 1465 | mV                         |
|                      |                                                             | Temperature sensor voltage at $T_A = 85^\circ\text{C}$                   | 2.2 V/3 V | 1195 | 1295 | 1395 | mV                         |
|                      |                                                             | Temperature sensor voltage at $T_A = 25^\circ\text{C}$                   | 2.2 V/3 V | 985  | 1085 | 1185 | mV                         |
|                      |                                                             | Temperature sensor voltage at $T_A = 0^\circ\text{C}$                    | 2.2 V/3 V | 895  | 995  | 1095 |                            |
| $t_{Sensor(sample)}$ | Sample time required if channel 10 is selected (see Note 4) | ADC10ON = 1, INCHx = 0Ah, Error of conversion result $\leq 1$ LSB        | 2.2 V/3 V | 30   |      |      | $\mu\text{s}$              |
| $I_{VMID}$           | Current into divider at channel 11 (see Note 5)             | ADC10ON = 1, INCHx = 0Bh,                                                | 2.2 V     |      |      | NA   | $\mu\text{A}$              |
|                      |                                                             |                                                                          | 3 V       |      |      | NA   |                            |
| $V_{MID}$            | $V_{CC}$ divider at channel 11                              | ADC10ON = 1, INCHx = 0Bh, $V_{MID}$ is $\approx 0.5 \times V_{CC}$       | 2.2 V     | 1.06 | 1.1  | 1.14 | V                          |
|                      |                                                             |                                                                          | 3 V       | 1.46 | 1.5  | 1.54 |                            |
| $t_{VMID(sample)}$   | Sample time required if channel 11 is selected (see Note 6) | ADC10ON = 1, INCHx = 0Bh, Error of conversion result $\leq 1$ LSB        | 2.2 V     | 1400 |      |      | ns                         |
|                      |                                                             |                                                                          | 3 V       | 1220 |      |      |                            |

- NOTES: 1. The sensor current  $I_{SENSOR}$  is consumed if (ADC10ON = 1 and REFON = 1), or (ADC10ON = 1 and INCH = 0Ah and sample signal is high). When REFON = 1,  $I_{SENSOR}$  is included in  $I_{REF+}$ . When REFON = 0,  $I_{SENSOR}$  applies during conversion of the temperature sensor input (INCH = 0Ah).
2. The following formula can be used to calculate the temperature sensor output voltage:  
 $V_{Sensor,typ} = TC_{Sensor} (273 + T [^\circ\text{C}]) + V_{Offset,sensor} [\text{mV}]$  or  
 $V_{Sensor,typ} = TC_{Sensor} T [^\circ\text{C}] + V_{Sensor}(T_A = 0^\circ\text{C}) [\text{mV}]$
3. Results based on characterization and/or production test, not  $TC_{Sensor}$  or  $V_{Offset,sensor}$ .
4. The typical equivalent impedance of the sensor is 51 k $\Omega$ . The sample time required includes the sensor-on time  $t_{SENSOR(on)}$ .
5. No additional current is needed. The  $V_{MID}$  is used during sampling.
6. The on-time  $t_{VMID(on)}$  is included in the sampling time  $t_{VMID(sample)}$ ; no additional on time is needed.

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)**

**flash memory**

| PARAMETER                  |                                                     | TEST CONDITIONS       | V <sub>CC</sub> | MIN             | TYP             | MAX | UNIT             |
|----------------------------|-----------------------------------------------------|-----------------------|-----------------|-----------------|-----------------|-----|------------------|
| V <sub>CC(PGM/ERASE)</sub> | Program and erase supply voltage                    |                       |                 | 2.2             |                 | 3.6 | V                |
| f <sub>FTG</sub>           | Flash timing generator frequency                    |                       |                 | 257             |                 | 476 | kHz              |
| I <sub>PGM</sub>           | Supply current from V <sub>CC</sub> during program  |                       | 2.2 V/3.6 V     |                 | 1               | 5   | mA               |
| I <sub>ERASE</sub>         | Supply current from V <sub>CC</sub> during erase    |                       | 2.2 V/3.6 V     |                 | 1               | 7   | mA               |
| t <sub>CPT</sub>           | Cumulative program time (see Note 1)                |                       | 2.2 V/3.6 V     |                 |                 | 10  | ms               |
| t <sub>CMErase</sub>       | Cumulative mass erase time                          |                       | 2.2 V/3.6 V     | 20              |                 |     | ms               |
|                            | Program/erase endurance                             |                       |                 | 10 <sup>4</sup> | 10 <sup>5</sup> |     | cycles           |
| t <sub>Retention</sub>     | Data retention duration                             | T <sub>J</sub> = 25°C |                 | 100             |                 |     | years            |
| t <sub>Word</sub>          | Word or byte program time                           | See Note 2            |                 |                 | 30              |     | t <sub>FTG</sub> |
| t <sub>Block, 0</sub>      | Block program time for first byte or word           |                       |                 |                 | 25              |     | t <sub>FTG</sub> |
| t <sub>Block, 1-63</sub>   | Block program time for each additional byte or word |                       |                 |                 | 18              |     | t <sub>FTG</sub> |
| t <sub>Block, End</sub>    | Block program end-sequence wait time                |                       |                 |                 | 6               |     | t <sub>FTG</sub> |
| t <sub>Mass Erase</sub>    | Mass erase time                                     |                       |                 |                 | 10593           |     | t <sub>FTG</sub> |
| t <sub>Seg Erase</sub>     | Segment erase time                                  |                       |                 |                 | 4819            |     | t <sub>FTG</sub> |
|                            |                                                     |                       |                 |                 |                 |     |                  |

- NOTES: 1. The cumulative program time must not be exceeded when writing to a 64-byte flash block. This parameter applies to all programming methods: individual word/byte write and block write modes.  
2. These values are hardwired into the Flash Controller's state machine (t<sub>FTG</sub> = 1/f<sub>FTG</sub>).

**RAM**

| PARAMETER           |                                         | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|-----------------------------------------|-----------------|-----|-----|-----|------|
| V <sub>(RAMh)</sub> | RAM retention supply voltage (see Note) | CPU halted      | 1.6 |     |     | V    |

NOTE: This parameter defines the minimum supply voltage V<sub>CC</sub> when the data in RAM remains unchanged. No program execution should happen during this supply voltage condition.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## JTAG and Spy-Bi-Wire interface

| PARAMETER             |                                                                                   | TEST CONDITIONS | V <sub>CC</sub> | MIN   | TYP | MAX | UNIT |
|-----------------------|-----------------------------------------------------------------------------------|-----------------|-----------------|-------|-----|-----|------|
| f <sub>SBW</sub>      | Spy-Bi-Wire input frequency                                                       |                 | 2.2 V/3 V       | 0     |     | 20  | MHz  |
| t <sub>SBW,Low</sub>  | Spy-Bi-Wire low clock pulse length                                                |                 | 2.2 V/3 V       | 0.025 |     | 15  | us   |
| t <sub>SBW,En</sub>   | Spy-Bi-Wire enable time, TEST high to acceptance of first clock edge (see Note 1) |                 | 2.2 V/3 V       |       |     | 1   | us   |
| t <sub>SBW,Ret</sub>  | Spy-Bi-Wire return to normal operation time                                       |                 | 2.2 V/3 V       | 15    |     | 100 | us   |
| f <sub>TCK</sub>      | TCK input frequency (see Note 2)                                                  |                 | 2.2 V           | 0     |     | 5   | MHz  |
|                       |                                                                                   |                 | 3 V             | 0     |     | 10  | MHz  |
| R <sub>Internal</sub> | Internal pulldown resistance on TEST                                              |                 | 2.2 V/3 V       | 25    | 60  | 90  | kΩ   |

- NOTES: 1. Tools accessing the Spy-Bi-Wire interface need to wait for the maximum t<sub>SBW,En</sub> time after pulling the TEST/SBWCLK pin high before applying the first SBWCLK clock edge.  
2. f<sub>TCK</sub> may be restricted to meet the timing requirements of the module selected.

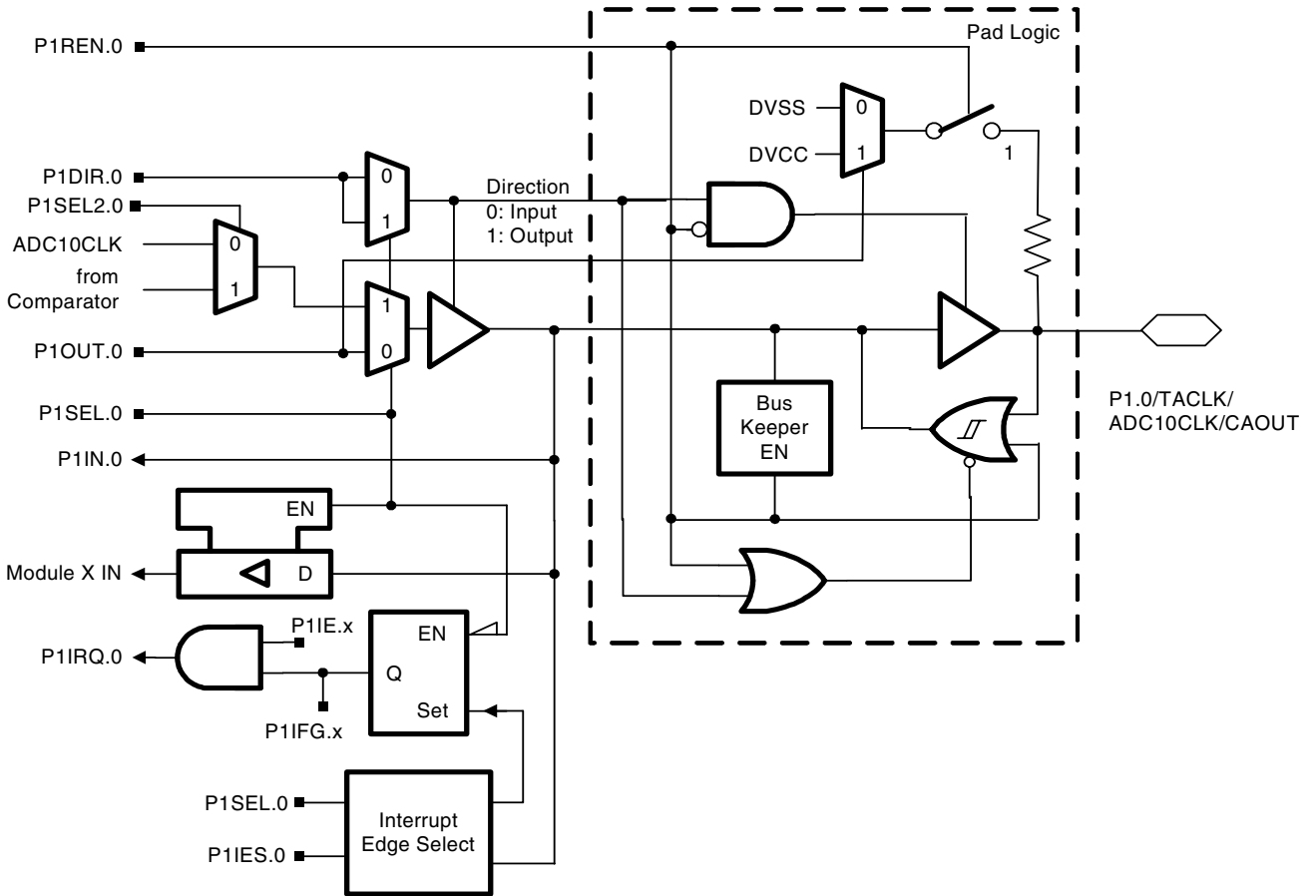
## JTAG fuse (see Note)

| PARAMETER           |                                                  | TEST CONDITIONS       | V <sub>CC</sub> | MIN | NOM | MAX | UNIT |
|---------------------|--------------------------------------------------|-----------------------|-----------------|-----|-----|-----|------|
| V <sub>CC(FB)</sub> | Supply voltage during fuse-blow condition        | T <sub>A</sub> = 25°C |                 | 2.5 |     |     | V    |
| V <sub>FB</sub>     | Voltage level on TEST for fuse-blow (F versions) |                       |                 | 6   |     | 7   | V    |
| I <sub>FB</sub>     | Supply current into TDI/TCLK during fuse blow    |                       |                 |     |     | 100 | mA   |
| t <sub>FB</sub>     | Time to blow fuse                                |                       |                 |     |     | 1   | ms   |

NOTE: Once the fuse is blown, no further access to the MSP430 JTAG/Test and emulation features is possible. The JTAG block is switched to bypass mode.

APPLICATION INFORMATION

Port P1 pin schematic: P1.0, input/output with Schmitt trigger



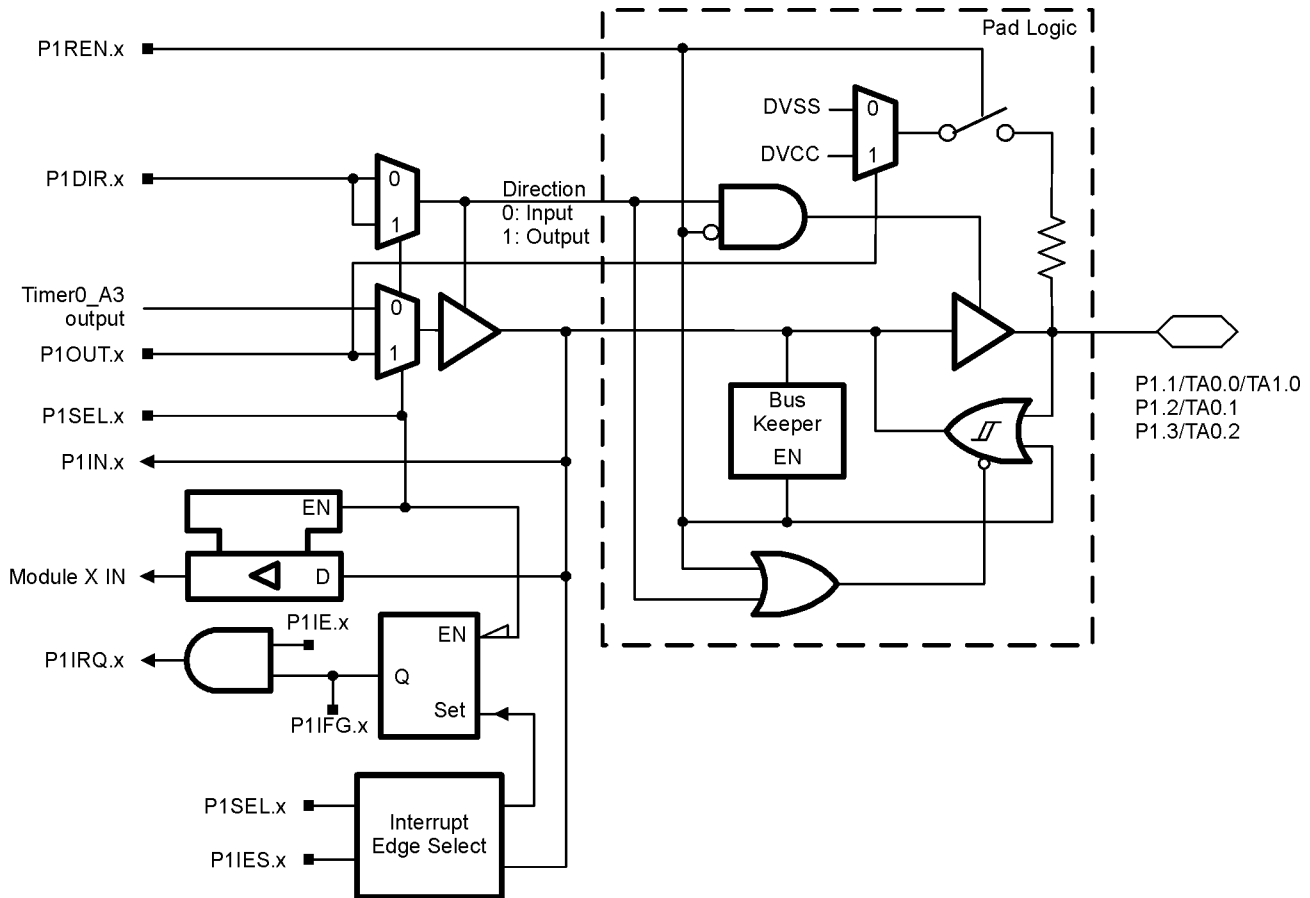
Port P1 (P1.0) pin functions

| PIN NAME (P1.x)               | x | FUNCTION                         | CONTROL BITS / SIGNALS |         |          |
|-------------------------------|---|----------------------------------|------------------------|---------|----------|
|                               |   |                                  | P1DIR.x                | P1SEL.x | P1SEL2.x |
| P1.0/TACLK/<br>ADC10CLK/CAOUT | 0 | P1.0 (I/O)                       | I: 0, O: 1             | 0       | 0        |
|                               |   | Timer0_A3.TACLK, Timer1_A2.TACLK | 0                      | 1       | 0        |
|                               |   | ADC10CLK                         | 1                      | 1       | 0        |
|                               |   | CAOUT                            | 1                      | 1       | 1        |

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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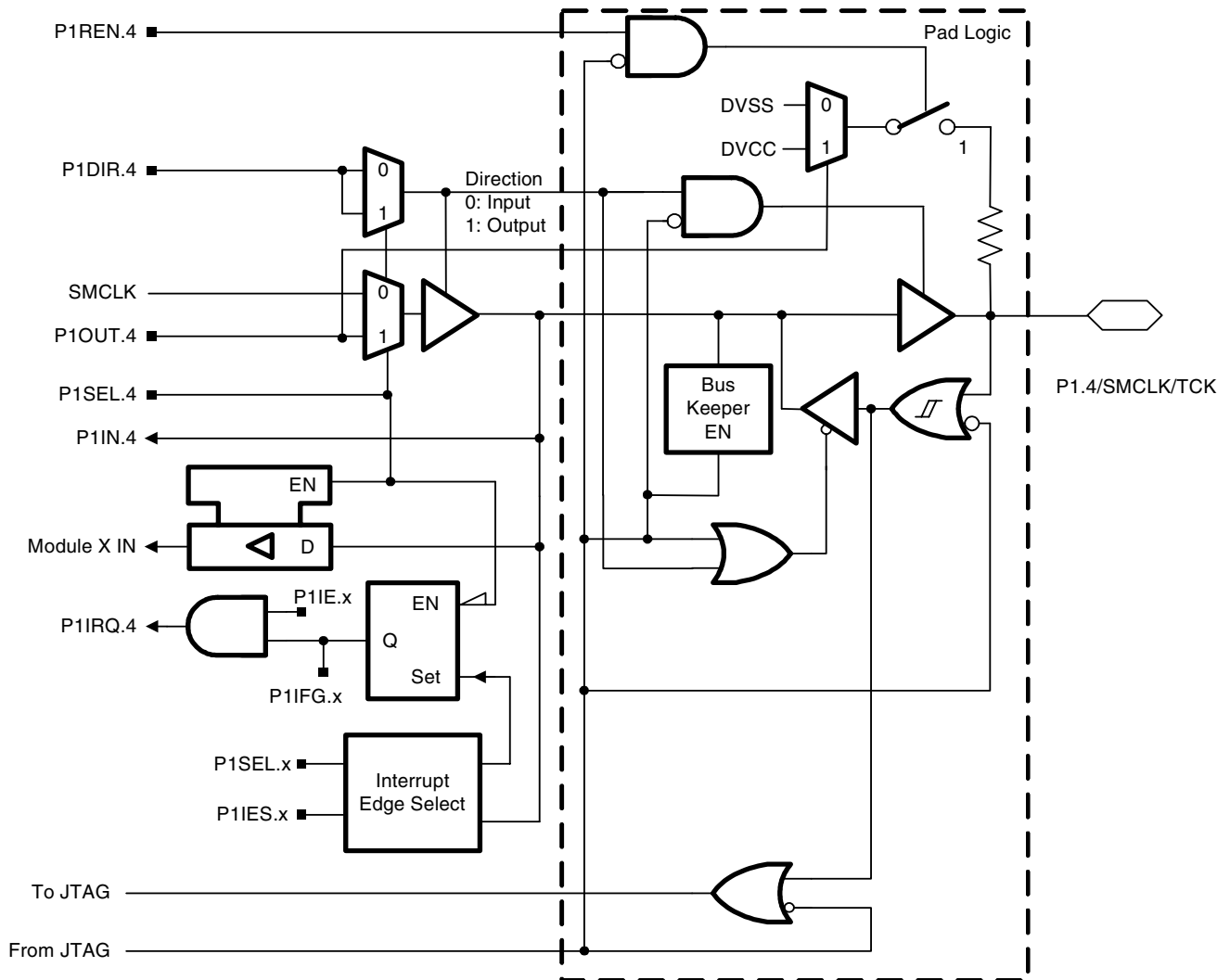
## Port P1 pin schematic: P1.1 to P1.3, input/output with Schmitt trigger



## Port P1 (P1.1 to P1.3) pin functions

| PIN NAME (P1.x)  | x | FUNCTION                         | CONTROL BITS / SIGNALS |         |          |
|------------------|---|----------------------------------|------------------------|---------|----------|
|                  |   |                                  | P1DIR.x                | P1SEL.x | P1SEL2.x |
| P1.1/TA0.0/TA1.0 | 1 | P1.1 (I/O)                       | I: 0; O: 1             | 0       | 0        |
|                  |   | Timer0_A3.CCI0A, Timer1_A2.CCI0A | 0                      | 1       | 0        |
|                  |   | Timer0_A3.TA0                    | 1                      | 1       | 0        |
| P1.2/TA0.1       | 2 | P1.2 (I/O)                       | I: 0; O: 1             | 0       | 0        |
|                  |   | Timer0_A3.CCI0A                  | 0                      | 1       | 0        |
|                  |   | Timer0_A3.TA0                    | 1                      | 1       | 0        |
| P1.3/TA0.2       | 3 | P1.3 (I/O)                       | I: 0; O: 1             | 0       | 0        |
|                  |   | Timer0_A3.CCI0A                  | 0                      | 1       | 0        |
|                  |   | Timer0_A3.TA0                    | 1                      | 1       | 0        |

Port P1 pin schematic: P1.4



Port P1 (P1.4) pin functions

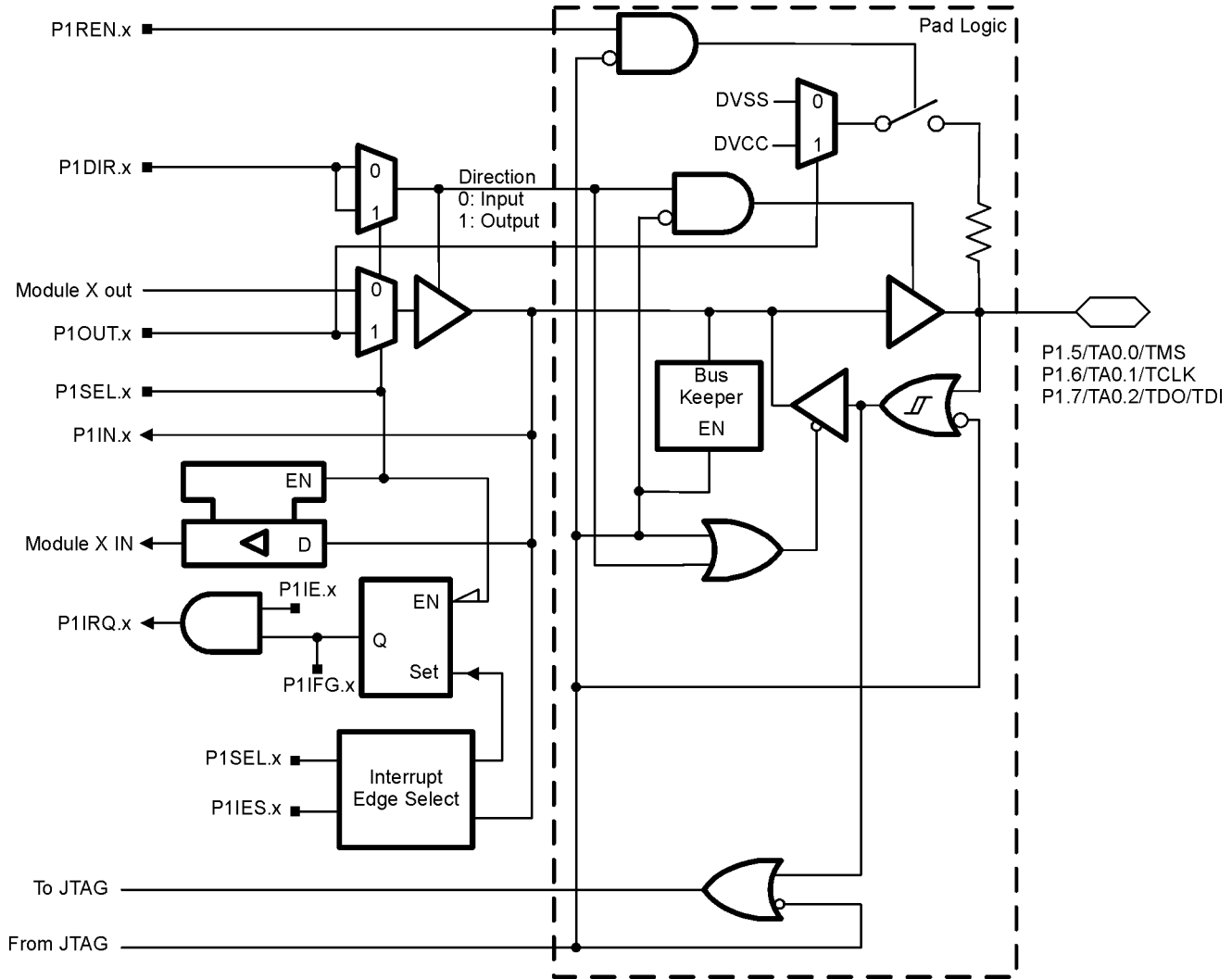
| PIN NAME (P1.x) | x | FUNCTION         | CONTROL BITS / SIGNALS |                         |           |
|-----------------|---|------------------|------------------------|-------------------------|-----------|
|                 |   |                  | P1DIR.x                | P1SEL.x<br>P1SEL2.x = 0 | JTAG Mode |
| P1.4/SMCLK/TCK  | 4 | P1.4 (I/O)       | I: 0; O: 1             | 0                       | 0         |
|                 |   | SMCLK            | 1                      | 1                       | 0         |
|                 |   | TCK (see Note 1) | X                      | X                       | 1         |

NOTES: 1. In JTAG Mode the internal pullup/pulldown resistors are disabled.  
2. X: Don't care.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Port P1 pin schematic: P1.5 to P1.7





**Port P1 (P1.5 to P1.7) pin functions**

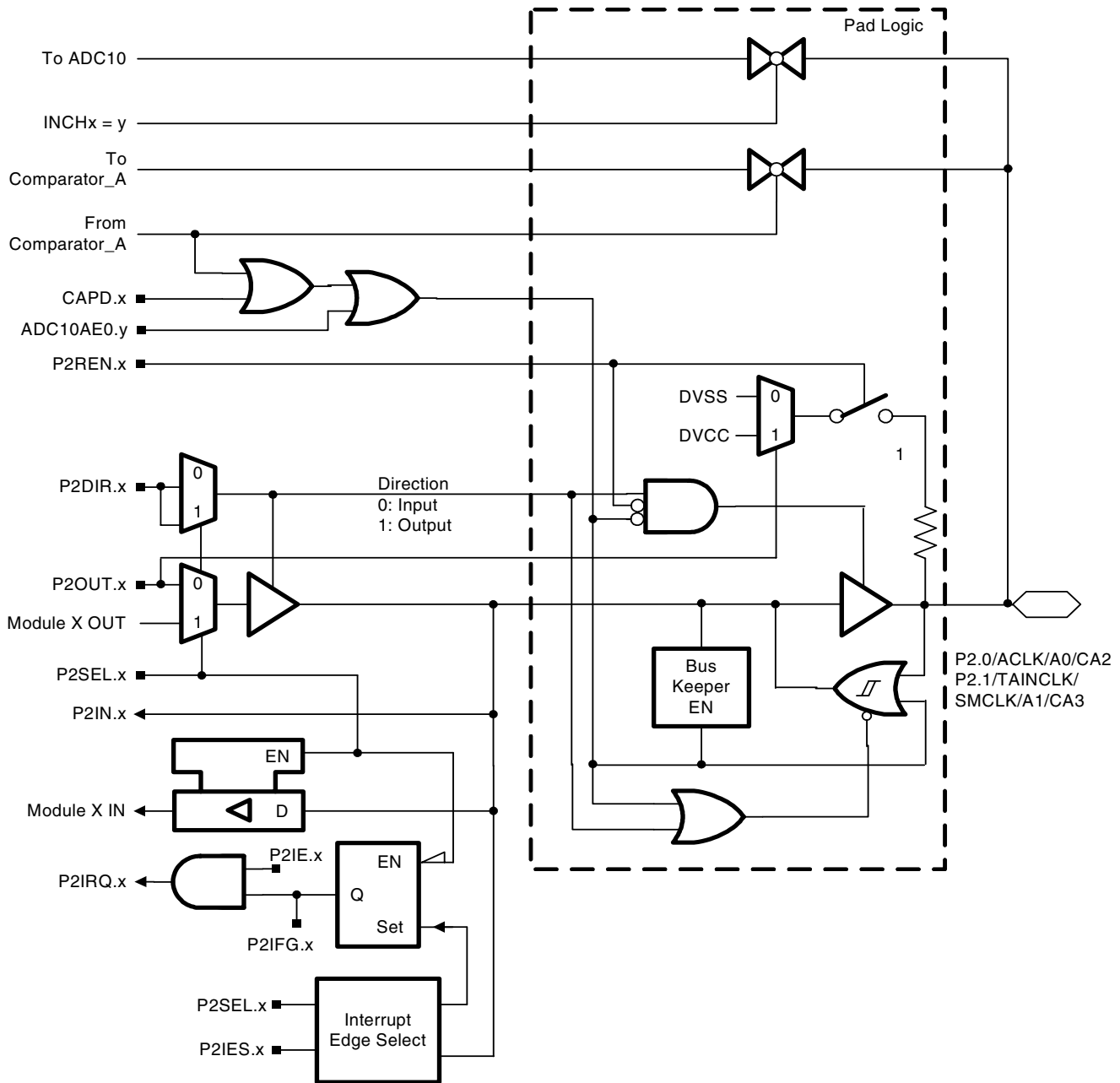
| PIN NAME (P1.x)         | x | FUNCTION              | CONTROL BITS / SIGNALS |                         |           |
|-------------------------|---|-----------------------|------------------------|-------------------------|-----------|
|                         |   |                       | P1DIR.x                | P1SEL.x<br>P1SEL2.x = 0 | JTAG Mode |
| P1.5/TA0.0/TMS          | 5 | P1.5 (I/O)            | I: 0; O: 1             | 0                       | 0         |
|                         |   | Timer0_A3.TA0         | 1                      | 1                       | 0         |
|                         |   | TMS (see Note 1)      | X                      | X                       | 1         |
| P1.6/TA0.1/<br>TDI/TCLK | 6 | P1.6 (I/O)            | I: 0; O: 1             | 0                       | 0         |
|                         |   | Timer0_A3.TA1         | 1                      | 1                       | 0         |
|                         |   | Timer0_A3.CCI0B       | 0                      | 1                       | 0         |
|                         |   | TDI/TCLK (see Note 1) | X                      | X                       | 1         |
| P1.7/TA0.2/TDO/TDI      | 7 | P1.6 (I/O)            | I: 0; O: 1             | 0                       | 0         |
|                         |   | Timer0_A3.TA2         | 1                      | 1                       | 0         |
|                         |   | TDO/TDI (see Note 1)  | X                      | X                       | 1         |

NOTES: 1. In JTAG Mode the internal pullup/pulldown resistors are disabled.  
2. X: Don't care.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Port P2 pin schematic: P2.0 and P2.1, input/output with Schmitt trigger



**Port P2 (P2.0 and P2.1) pin functions**

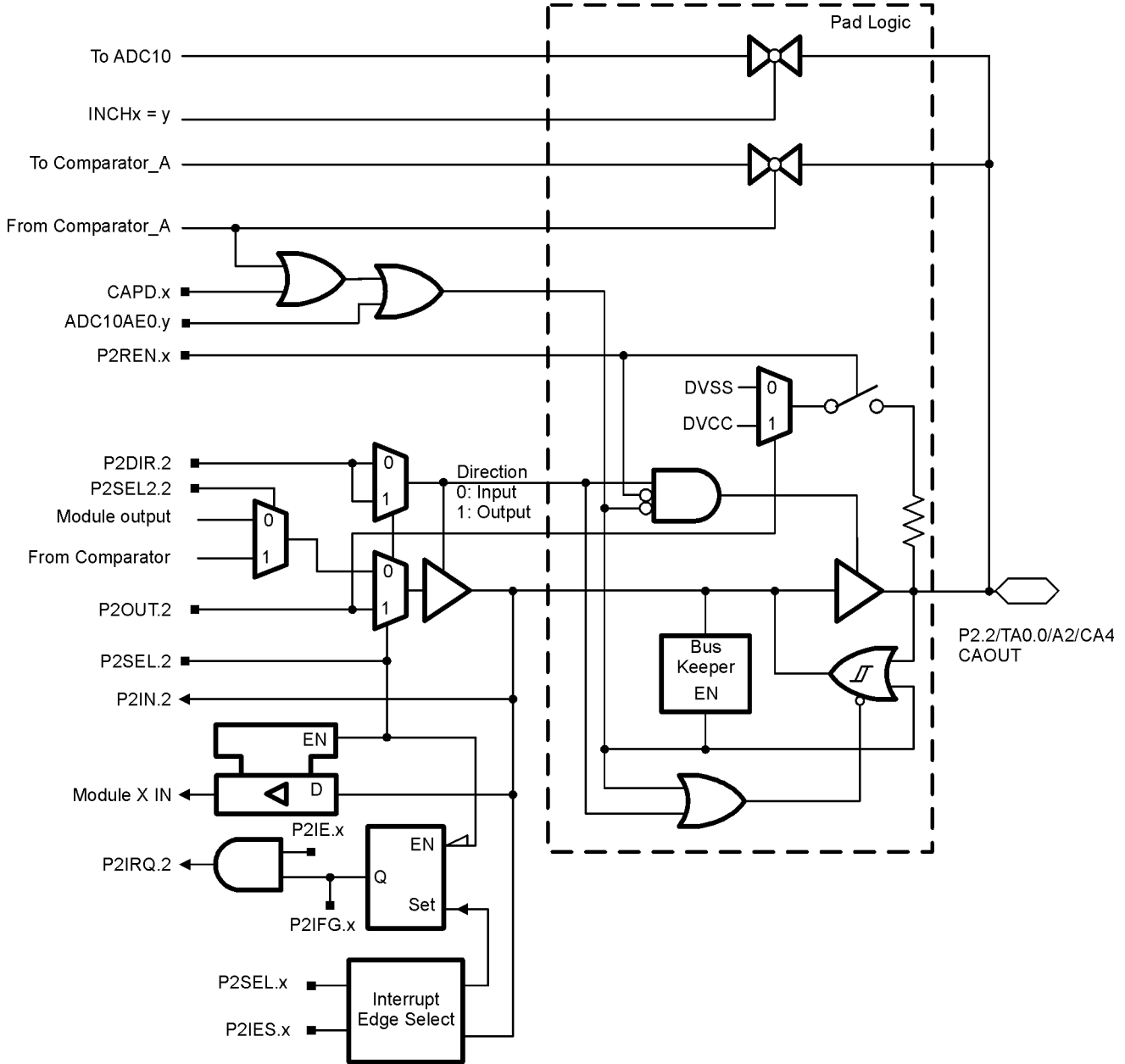
| PIN NAME (P2.x)               | x | FUNCTION                             | CONTROL BITS / SIGNALS |        |            |                         |
|-------------------------------|---|--------------------------------------|------------------------|--------|------------|-------------------------|
|                               |   |                                      | ADC10AE0.y             | CAPD.x | P2DIR.x    | P2SEL.x<br>P2SEL2.x = 0 |
| P2.0/ACLK/A0/CA2              | 0 | P2.0 (I/O)                           | 0                      | 0      | I: 0; O: 1 | 0                       |
|                               |   | ACLK                                 | 0                      | 0      | 1          | 1                       |
|                               |   | A0                                   | 1                      | 0      | X          | X                       |
|                               |   | CA2                                  | 0                      | 1      | X          | X                       |
| P2.1/TAINCLK/<br>SMCLK/A1/CA3 | 1 | P2.1 (I/O)                           | 0                      | 0      | I: 0; O: 1 | 0                       |
|                               |   | Timer0_A3.TAINCLK, Timer1_A2.TAINCLK | 0                      | 0      | 0          | 1                       |
|                               |   | SMCLK                                | 0                      | 0      | 1          | 1                       |
|                               |   | A1                                   | 1                      | 0      | X          | X                       |
|                               |   | CA3                                  | 0                      | 1      | X          | X                       |

NOTE: X: Don't care.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Port P2 pin schematic: P2.2, input/output with Schmitt trigger



**Port P2 (P2.2) pin functions**

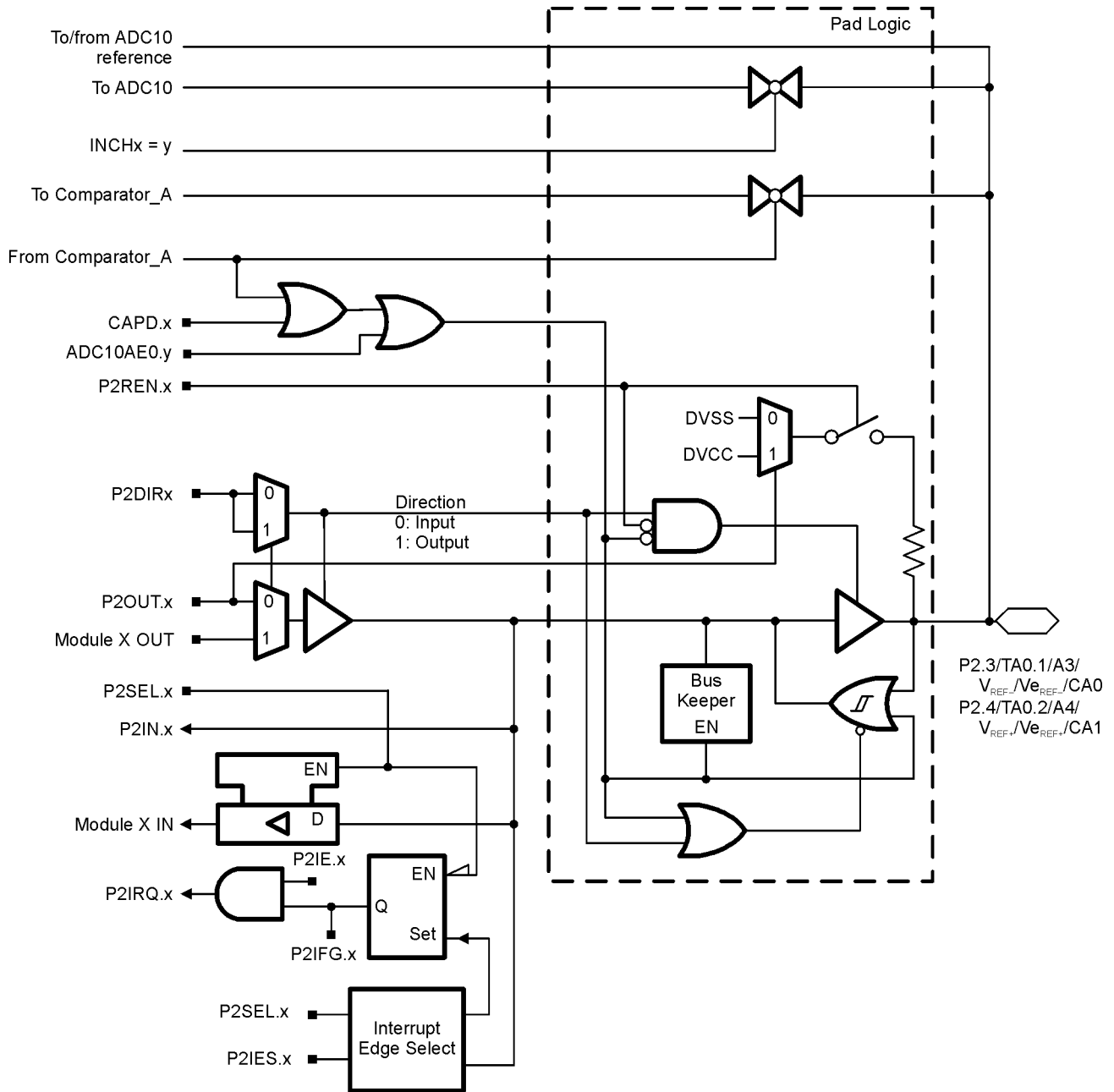
| PIN NAME (P2.x)             | x | FUNCTION        | CONTROL BITS / SIGNALS |        |            |         |          |
|-----------------------------|---|-----------------|------------------------|--------|------------|---------|----------|
|                             |   |                 | ADC10AE0.x             | CAPD.x | P2DIR.x    | P2SEL.x | P2SEL2.x |
| P2.2/TA0.0/A2/CA4/<br>CAOUT | 2 | P2.0 (I/O)      | 0                      | 0      | I: 0; O: 1 | 0       | 0        |
|                             |   | Timer0_A3.TA0   | 0                      | 0      | 1          | 1       | 0        |
|                             |   | Timer0_A3.CCI0B | 0                      | 0      | 0          | 1       | 0        |
|                             |   | A2              | 1                      | 0      | X          | X       | X        |
|                             |   | CA4             | 0                      | 1      | X          | X       | X        |
|                             |   | CAOUT           | 0                      | 0      | 1          | 1       | 1        |

NOTE: X: Don't care.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Port P2 pin schematic: P2.3 and P2.4, input/output with Schmitt trigger



**Port P2 (P2.3 and P2.4) pin functions**

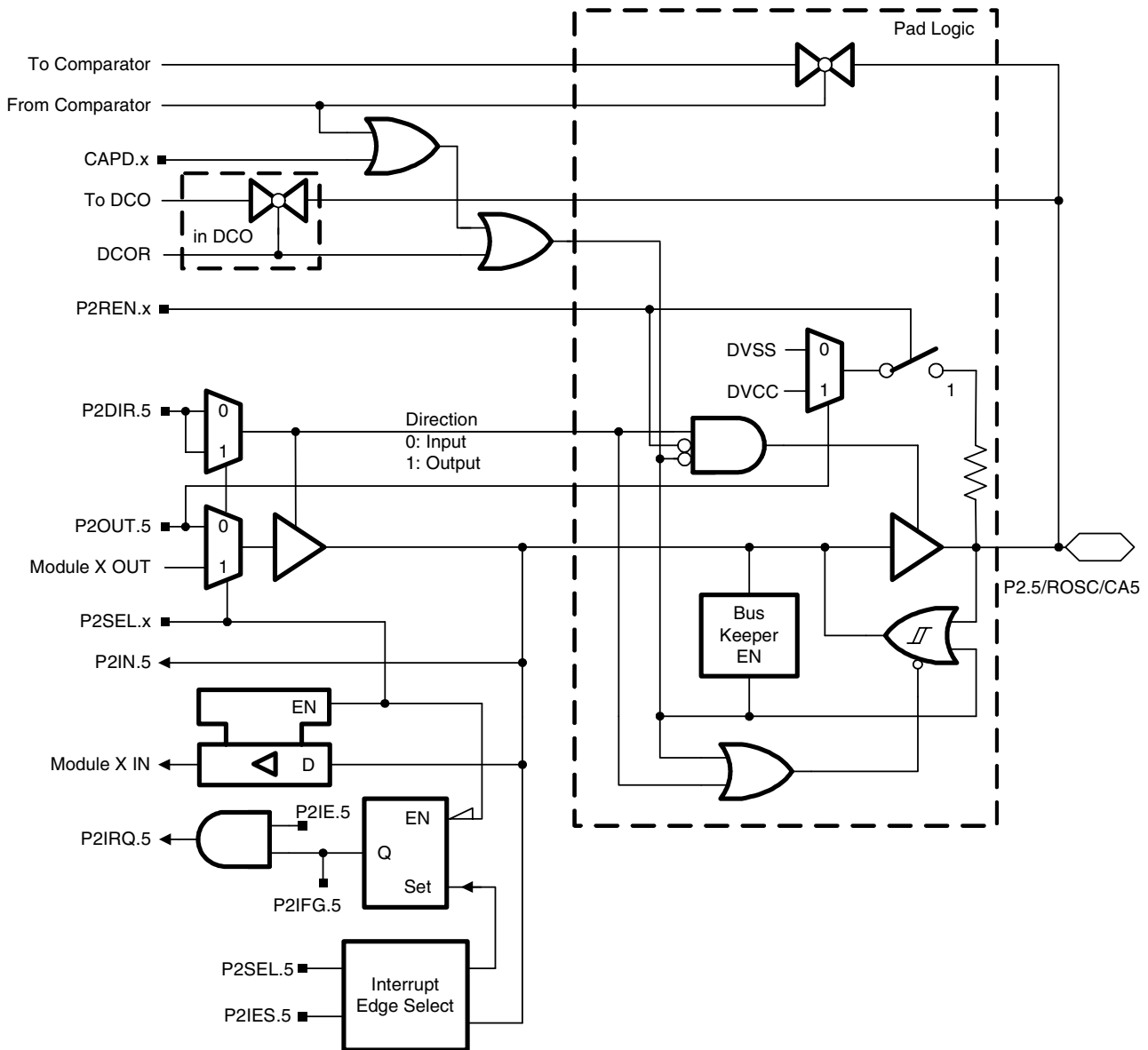
| PIN NAME (P2.x)                                              | x | FUNCTION                                 | CONTROL BITS / SIGNALS |        |            |                         |
|--------------------------------------------------------------|---|------------------------------------------|------------------------|--------|------------|-------------------------|
|                                                              |   |                                          | ADC10AE0.y             | CAPD.x | P2DIR.x    | P2SEL.x<br>P2SEL2.x = 0 |
| P2.3/TA0.1/A3/<br>V <sub>Ref-</sub> /V <sub>eRef-</sub> /CA0 | 3 | P2.3 (I/O)                               | 0                      | 0      | I: 0; O: 1 | 0                       |
|                                                              |   | Timer0_A3.TA1                            | 0                      | 0      | 1          | 1                       |
|                                                              |   | A3/V <sub>Ref-</sub> /V <sub>eRef-</sub> | 1                      | 0      | X          | X                       |
|                                                              |   | CA0                                      | 0                      | 1      | X          | X                       |
| P2.4/TA0.2/A4/<br>V <sub>Ref+</sub> /V <sub>eRef+</sub> /CA1 | 4 | P2.4 (I/O)                               | 0                      | 0      | I: 0; O: 1 | 0                       |
|                                                              |   | Timer0_A3.TA2                            | 0                      | 0      | 1          | 1                       |
|                                                              |   | A4/V <sub>Ref+</sub> /V <sub>eRef+</sub> | 1                      | 0      | X          | X                       |
|                                                              |   | CA1                                      | 0                      | 1      | X          | X                       |

NOTE: X: Don't care.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Port P2 pin schematic: P2.5, input/output with Schmitt trigger



### Port P2 (P2.5) pin functions

| PIN NAME (P2.x)            | x | FUNCTION         | CONTROL BITS / SIGNALS |      |            |                         |
|----------------------------|---|------------------|------------------------|------|------------|-------------------------|
|                            |   |                  | CAPD.5                 | DCOR | P2DIR.5    | P2SEL.5<br>P2SEL2.x = 0 |
| P2.5/R <sub>OSC</sub> /CA5 | 5 | P2.5 (I/O)       | 0                      | 0    | I: 0, O: 1 | 0                       |
|                            |   | R <sub>OSC</sub> | 0                      | 1    | X          | X                       |
|                            |   | DV <sub>SS</sub> | 0                      | 0    | 1          | 1                       |
|                            |   | CA5 (see Note 2) | 1                      | 0    | X          | X                       |

NOTES: 1. X: Don't care.

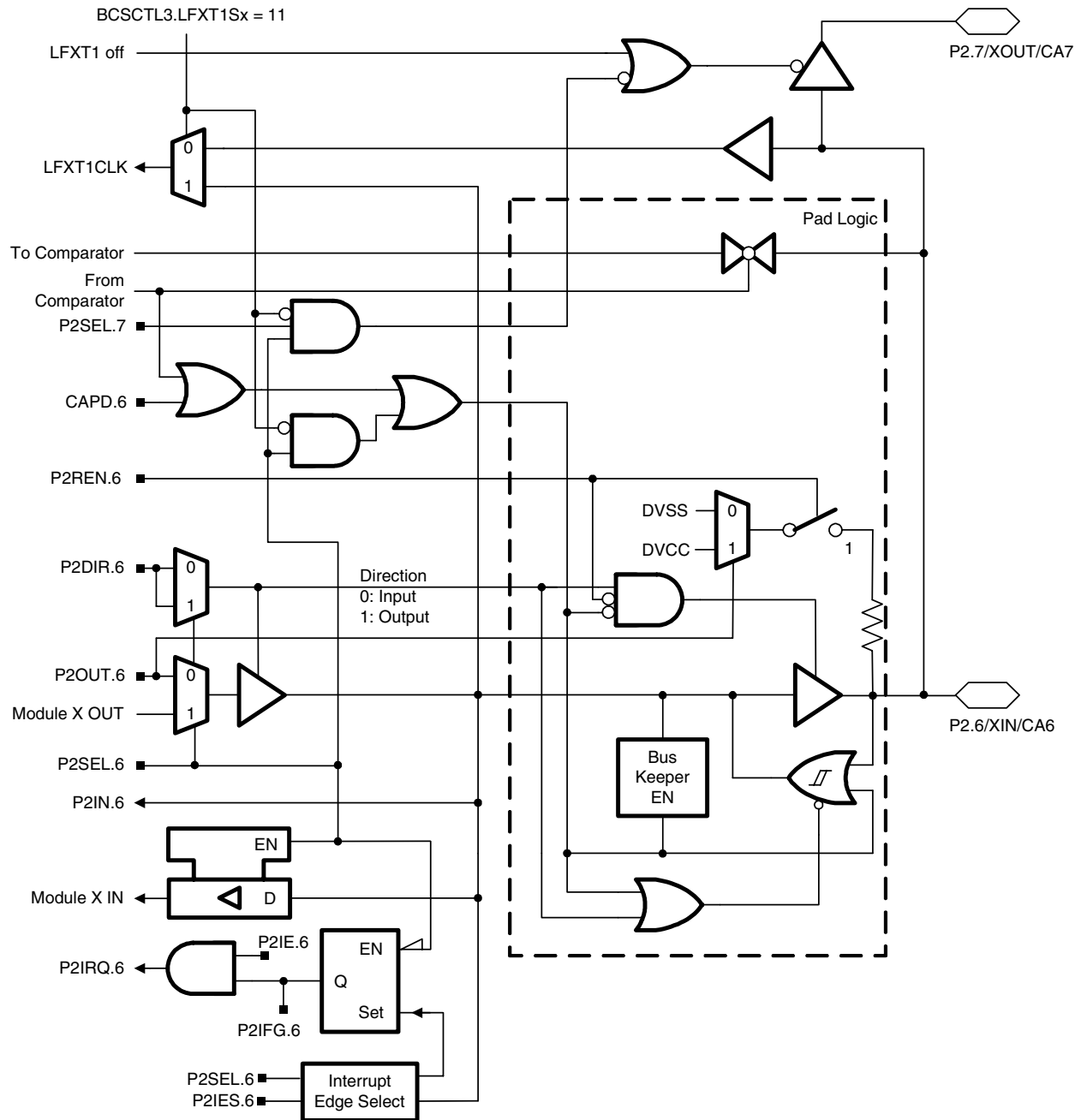
2. Setting the CAPD.x bit disables the output driver as well as the input to prevent parasitic cross currents when applying analog signals. Selecting the CAx input to the comparator multiplexer with the P2CAx bits automatically disables the input buffer for that pin, regardless of the state of the associated CAPD.x bit.



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Port P2 pin schematic: P2.6, input/output with Schmitt trigger



# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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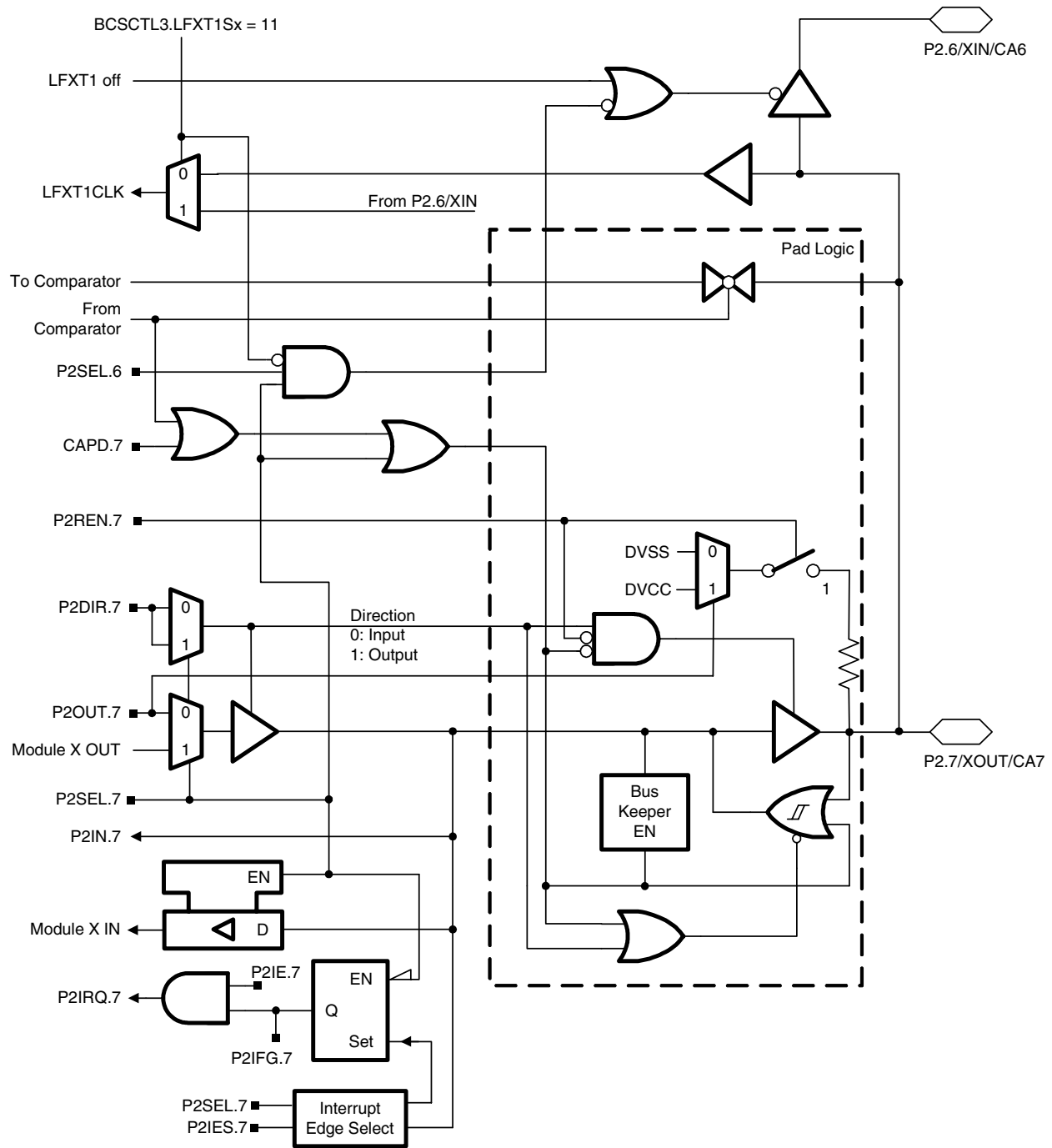
## Port P2.6 pin functions

| Pin Name (P2.x) | x | FUNCTION         | CONTROL BITS / SIGNALS |            |                         |
|-----------------|---|------------------|------------------------|------------|-------------------------|
|                 |   |                  | CAPD.6                 | P2DIR.6    | P2SEL.6<br>P2SEL2.x = 0 |
| P2.6/XIN/CA6    | 6 | P2.6 (I/O)       | 0                      | I: 0; O: 1 | 0                       |
|                 |   | XIN (default)    | X                      | 1          | 1                       |
|                 |   | CA6 (see Note 2) | 1                      | X          | 0                       |

- NOTES: 1. X: Don't care.  
 2. Setting the CAPD.x bit disables the output driver as well as the input to prevent parasitic cross currents when applying analog signals. Selecting the CAx input to the comparator multiplexer with the P2CAx bits automatically disables the input buffer for that pin, regardless of the state of the associated CAPD.x bit.



Port P2 pin schematic: P2.7, input/output with Schmitt trigger



# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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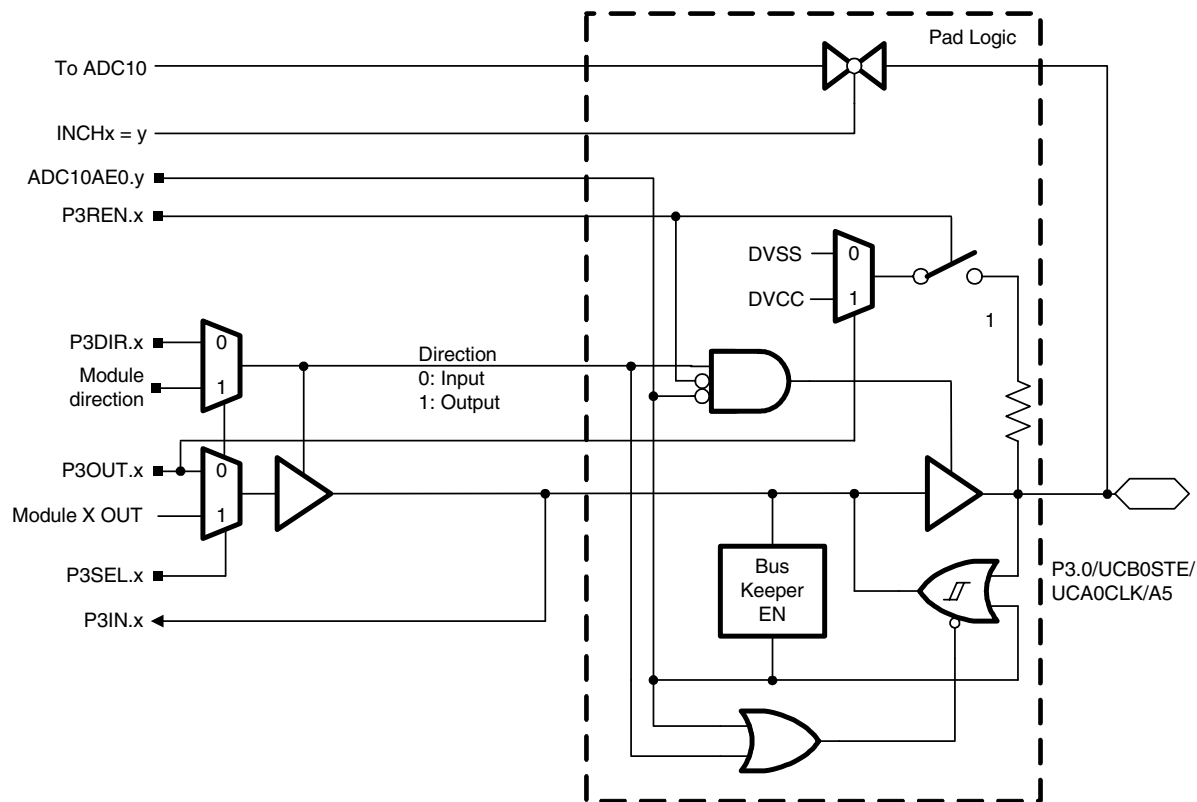
## Port P2.7 pin functions

| PIN NAME (P2.x) | x | FUNCTION         | CONTROL BITS / SIGNALS |            |                         |
|-----------------|---|------------------|------------------------|------------|-------------------------|
|                 |   |                  | CAPD.7                 | P2DIR.7    | P2SEL.7<br>P2SEL2.x = 0 |
| P2.7/XOUT/CA7   | 7 | P2.7 (I/O)       | 0                      | I: 0, O: 1 | 0                       |
|                 |   | XOUT (default)   | X                      | 1          | 1                       |
|                 |   | CA7 (see Note 2) | 1                      | X          | 0                       |

- NOTES: 1. X: Don't care.  
2. Setting the CAPD.x bit disables the output driver as well as the input to prevent parasitic cross currents when applying analog signals. Selecting the CAx input to the comparator multiplexer with the P2CAx bits automatically disables the input buffer for that pin, regardless of the state of the associated CAPD.x bit.



Port P3 pin schematic: P3.0, input/output with Schmitt trigger



Port P3.0 pin functions

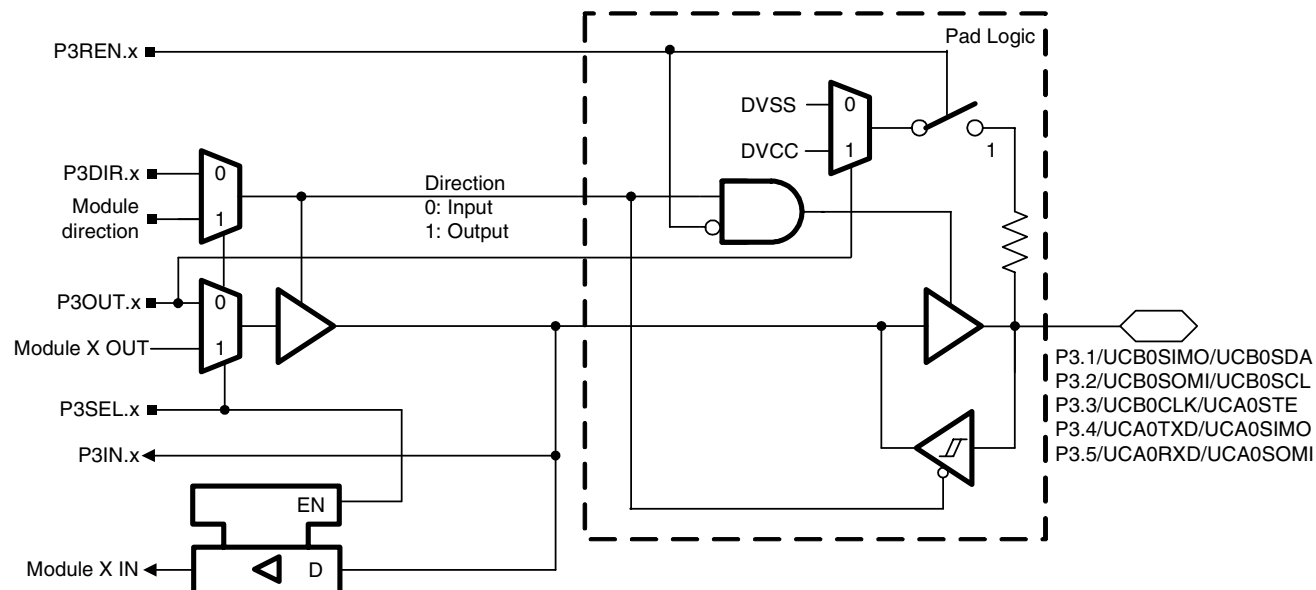
| PIN NAME (P3.x)             | x | FUNCTION                            | CONTROL BITS / SIGNALS |            |                         |
|-----------------------------|---|-------------------------------------|------------------------|------------|-------------------------|
|                             |   |                                     | ADC10AE0.y             | P3DIR.x    | P3SEL.x<br>P3SEL2.x = 0 |
| P3.0/UCB0STE/<br>UCA0CLK/A5 | 0 | P3.0 (I/O)                          | 0                      | I: 0; O: 1 | 0                       |
|                             |   | UCB0STE/UCA0CLK (see Notes 1 and 2) | 0                      | X          | 1                       |
|                             |   | A5 (see Notes 1 and 2)              | 1                      | X          | X                       |

- NOTES: 1. X: Don't care.  
2. The pin direction is controlled by the USCI module.  
3. If the I2C functionality is selected, the output drives only the logical 0 to V<sub>SS</sub> level.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Port P3 pin schematic: P3.1 to P3.5, input/output with Schmitt trigger

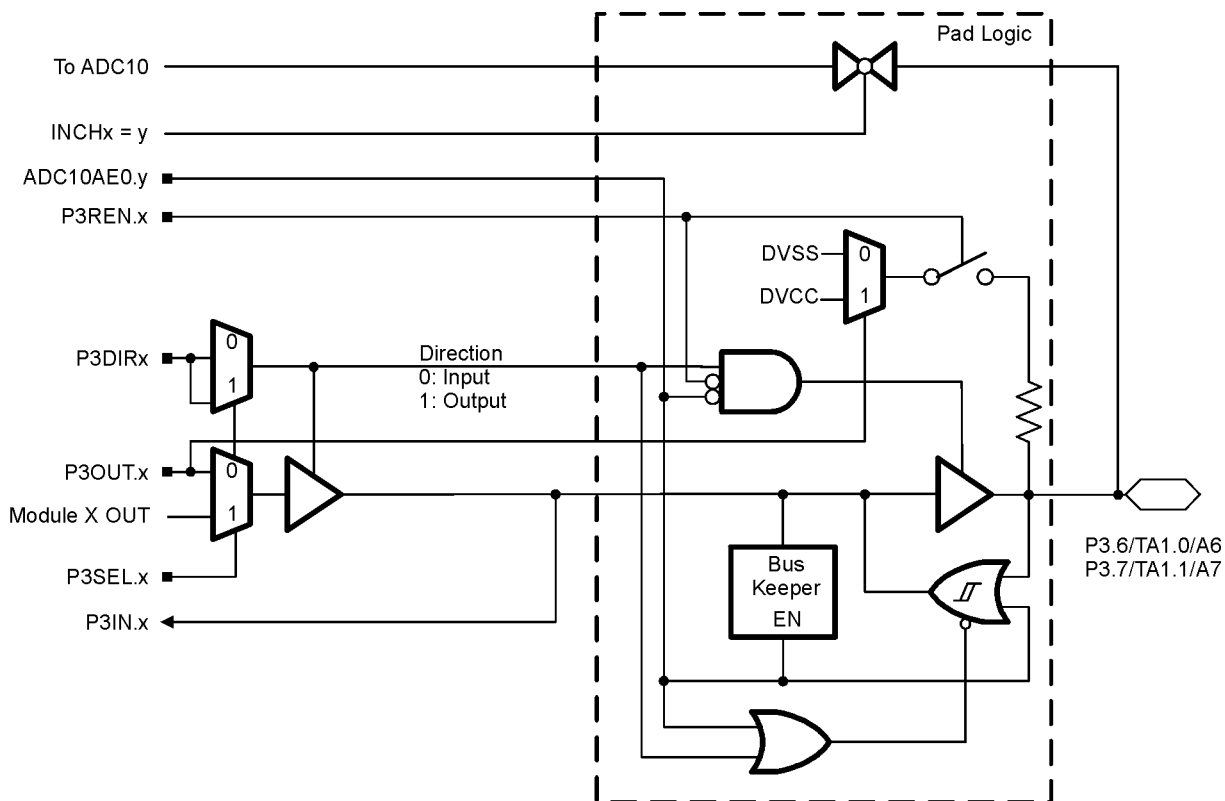


## Port P3 (P3.1 to P3.5) pin functions

| PIN NAME (P3.x)           | x | FUNCTION                                | CONTROL BITS / SIGNALS |                         |
|---------------------------|---|-----------------------------------------|------------------------|-------------------------|
|                           |   |                                         | P3DIR.x                | P3SEL.x<br>P3SEL2.x = 0 |
| P3.1/UCB0SIMO/<br>UCB0SDA | 1 | P3.1 (I/O)                              | I: 0; O: 1             | 0                       |
|                           |   | UCB0SIMO/UCB0SDA (see Notes 1, 2 and 3) | X                      | 1                       |
| P3.2/UCB0SOMI/<br>UCB0SCL | 2 | P3.2 (I/O)                              | I: 0; O: 1             | 0                       |
|                           |   | UCB0SOMI/UCB0SCL (see Notes 1, 2 and 3) | X                      | 1                       |
| P3.3/UCB0CLK/<br>UCA0STE  | 3 | P3.3 (I/O)                              | I: 0; O: 1             | 0                       |
|                           |   | UCB0CLK/UCA0STE (see Notes 1 and 2)     | X                      | 1                       |
| P3.4/UCA0TXD/<br>UCA0SIMO | 4 | P3.4 (I/O)                              | I: 0; O: 1             | 0                       |
|                           |   | UCA0TXD/UCA0SIMO (see Notes 1 and 2)    | X                      | 1                       |
| P3.5/UCA0RXD/<br>UCA0SOMI | 5 | P3.5 (I/O)                              | I: 0; O: 1             | 0                       |
|                           |   | UCA0RXD/UCA0SOMI (see Notes 1 and 2)    | X                      | 1                       |

- NOTES: 1. X: Don't care.  
 2. The pin direction is controlled by the USCI module.  
 3. In case the I2C functionality is selected the output drives only the logical 0 to  $V_{SS}$  level.

Port P3 pin schematic: P3.6 to P3.7, input/output with Schmitt trigger



Port P3 (P3.6 and P3.7) pin functions

| PIN NAME (P3.x) | x | FUNCTION        | ADC10AE0.y | P3DIR.x    | P3SEL.x<br>P3SEL2 = 0 |
|-----------------|---|-----------------|------------|------------|-----------------------|
| P3.6/TA1.0/A6   | 6 | P3.6 (I/O)      | 0          | I: 0; O: 1 | 0                     |
|                 |   | Timer1_A2.TA0   | 0          | 1          | 1                     |
|                 |   | Timer1_A2.CCI0B | 0          | 0          | 1                     |
|                 |   | A6              | 1          | X          | X                     |
| P3.7/TA1.1/A7   | 7 | P3.7 (I/O)      | 0          | I: 0; O: 1 | 0                     |
|                 |   | Timer1_A2.TA1   | 0          | 1          | 1                     |
|                 |   | Timer1_A2.CCI1A | 0          | 0          | 1                     |
|                 |   | A7              | 1          | X          | X                     |

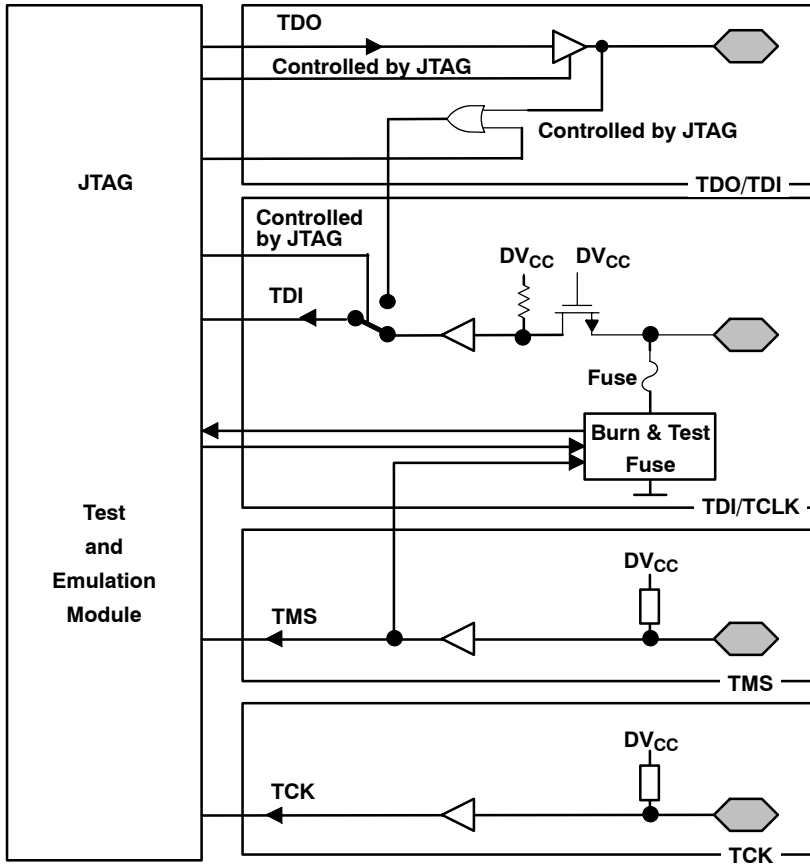
NOTES: 1. X: Don't care.

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## APPLICATION INFORMATION

JTAG pins: TMS, TCK, TDI/TCLK, TDO/TDI, input/output with Schmitt trigger



During Programming Activity and During Blowing of the Fuse, Pin TDO/TDI is Used to Apply the Test Input Data for JTAG Circuitry



APPLICATION INFORMATION

JTAG fuse check mode

MSP430F21x2 devices that have the fuse on the TDI/TCLK terminal have a fuse-check mode that tests the continuity of the fuse the first time the JTAG port is accessed after a power-on reset (POR). When activated, a fuse-check current,  $I_{TF}$ , of 1 mA at 3 V or 2.5 mA at 5 V can flow from the TDI/TCLK pin to ground if the fuse is not burned. Care must be taken to avoid accidentally activating the fuse-check mode and increasing overall system power consumption.

Activation of the fuse-check mode occurs with the first negative edge on the TMS pin after power up or if the TMS is being held low during power up. The second positive edge on the TMS pin deactivates the fuse check mode. After deactivation, the fuse check mode remains inactive until another POR occurs. After each POR the fuse check mode has the potential to be activated.

The fuse-check current flows only when the fuse-check mode is active and the TMS pin is in a low state (see Figure 31). Therefore, the additional current flow can be prevented by holding the TMS pin high (default condition).

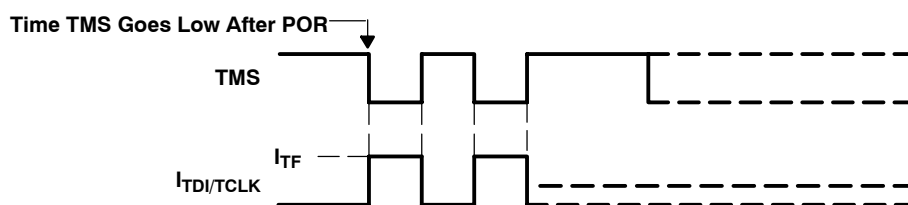


Figure 31. Fuse Check Mode Current

# MSP430F21x2 MIXED SIGNAL MICROCONTROLLER

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## Data Sheet Revision History

| LITERATURE NUMBER | SUMMARY                                                                                                                                                      |
|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SLAS578           | PRODUCT PREVIEW data sheet release                                                                                                                           |
| SLAS578A          | PRODUCTION DATA data sheet release                                                                                                                           |
| SLAS578B          | Corrected timer pin names throughout: TA0_0 changed to TA0.0, TA0_1 changed to TA1.0, TA1_0 changed to TA0.1, TA2_0 changed to TA0.2, TA1_1 changed to TA1.1 |



**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| MSP430F2112IPW   | ACTIVE                | TSSOP        | PW              | 28   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2112IPWR  | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2112IRHBR | ACTIVE                | QFN          | RHB             | 32   | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2112IRHBT | ACTIVE                | QFN          | RHB             | 32   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2112TPW   | ACTIVE                | TSSOP        | PW              | 28   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2112TPWR  | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2112TRHB  | PREVIEW               | QFN          | RHB             | 32   |             | TBD                     | Call TI          | Call TI                      |
| MSP430F2112TRHBR | ACTIVE                | QFN          | RHB             | 32   | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2112TRHBT | ACTIVE                | QFN          | RHB             | 32   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2122IPW   | ACTIVE                | TSSOP        | PW              | 28   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2122IPWR  | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2122IRHB  | PREVIEW               | QFN          | RHB             | 32   |             | TBD                     | Call TI          | Call TI                      |
| MSP430F2122IRHBR | ACTIVE                | QFN          | RHB             | 32   | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2122IRHBT | ACTIVE                | QFN          | RHB             | 32   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2122TPW   | ACTIVE                | TSSOP        | PW              | 28   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2122TPWR  | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2122TRHB  | PREVIEW               | QFN          | RHB             | 32   |             | TBD                     | Call TI          | Call TI                      |
| MSP430F2122TRHBR | ACTIVE                | QFN          | RHB             | 32   | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2122TRHBT | ACTIVE                | QFN          | RHB             | 32   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2132IPW   | ACTIVE                | TSSOP        | PW              | 28   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2132IPWR  | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2132IRHBR | ACTIVE                | QFN          | RHB             | 32   | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2132IRHBT | ACTIVE                | QFN          | RHB             | 32   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| MSP430F2132TPW   | ACTIVE                | TSSOP        | PW              | 28   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2132TPWR  | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| MSP430F2132TRHBR | ACTIVE                | QFN          | RHB             | 32   | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| MSP430F2132TRHBT | ACTIVE                | QFN          | RHB             | 32   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN

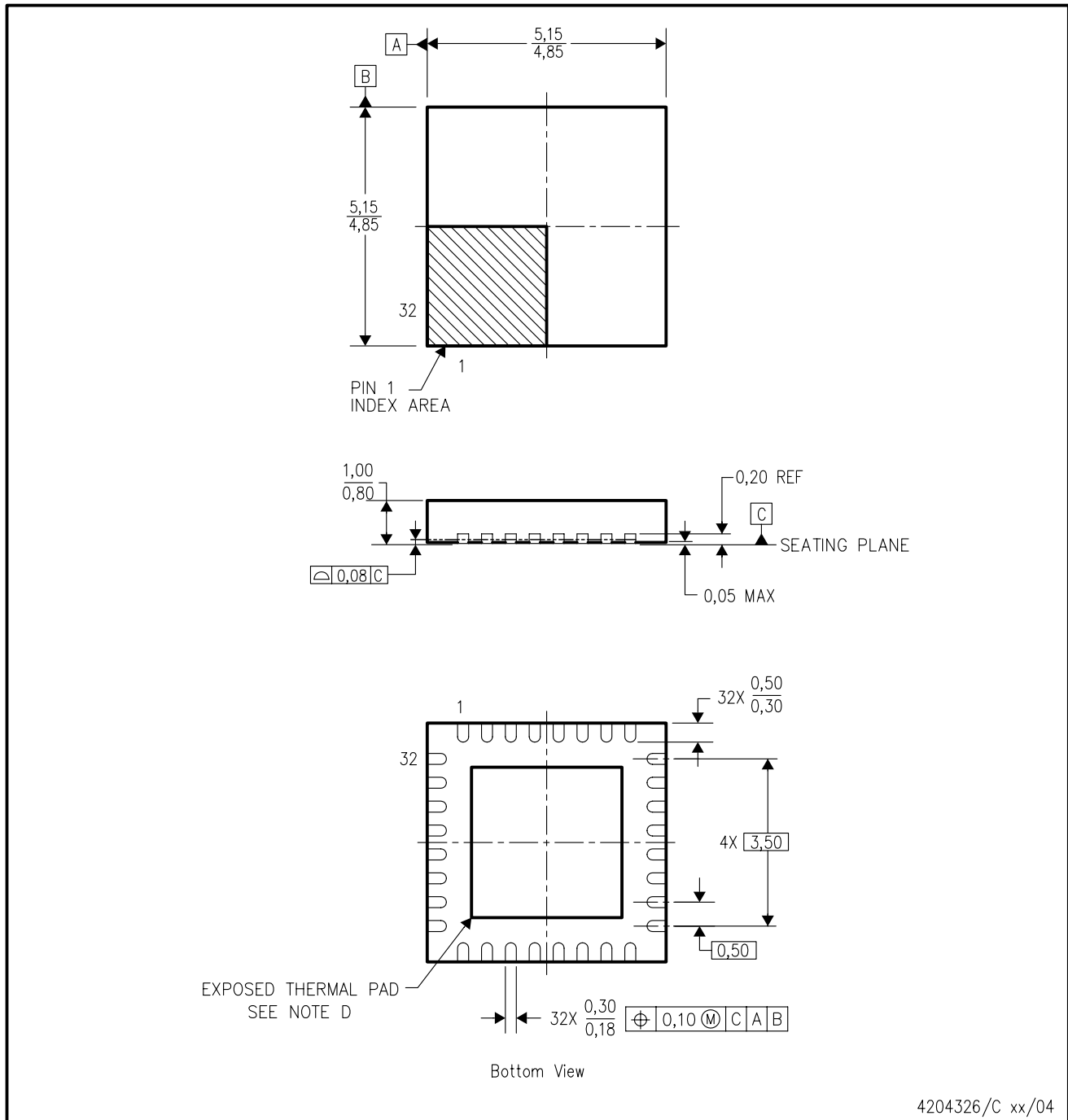


4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

RHB (S-PQFP-N32)

PLASTIC QUAD FLATPACK



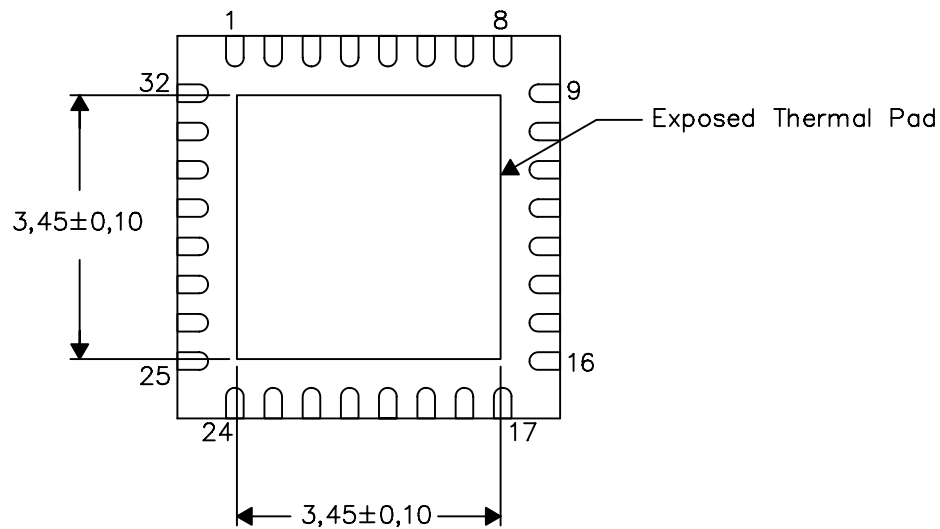
- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - QFN (Quad Flatpack No-Lead) Package configuration.
  - The Package thermal pad must be soldered to the board for thermal and mechanical performance. See product data sheet for details regarding the exposed thermal pad dimensions.
  - Falls within JEDEC MO-220.

THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions





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| Clocks and Timers           | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>           |
| Interface                   | <a href="http://interface.ti.com">interface.ti.com</a>             |
| Logic                       | <a href="http://logic.ti.com">logic.ti.com</a>                     |
| Power Mgmt                  | <a href="http://power.ti.com">power.ti.com</a>                     |
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| RF/IF and ZigBee® Solutions | <a href="http://www.ti.com/lprf">www.ti.com/lprf</a>               |

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|                    |                                                                          |
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| Automotive         | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>         |
| Broadband          | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
| Digital Control    | <a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a> |
| Medical            | <a href="http://www.ti.com/medical">www.ti.com/medical</a>               |
| Military           | <a href="http://www.ti.com/military">www.ti.com/military</a>             |
| Optical Networking | <a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a> |
| Security           | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
| Telephony          | <a href="http://www.ti.com/telephony">www.ti.com/telephony</a>           |
| Video & Imaging    | <a href="http://www.ti.com/video">www.ti.com/video</a>                   |
| Wireless           | <a href="http://www.ti.com/wireless">www.ti.com/wireless</a>             |

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